





FINAL REPORT

FOR

ORIENTED SCINTILLATION SPECTROMETER EXPERIMENT (OSSE) DTIC FILE COPY

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Prepared for

Naval Research Laboratory

Washington, D.C.

Prepared by

Ball Aerospace Systems Division (BASD)

P.O. Box 1062

Boulder, Colorado 80306

PREPARED BY:

APPROVED BY:

S. Varlese

OSSE Program Manager

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INTRODUCTION

The Final Report on the Oriented Scintillating Spectrometer Experiment (OSSE) is a reference document formatted in four parts to provide a concise summary of data covering the building and the testing of this Instrument. The main purpose of this document is to provide useful data for spacecraft integration activity. Most of the material is not original – it is pulled together from the more pertinent contents of the following categories: 1) description of OSSE, as specified, 2) construction data, and 3) test and measurement data, all drawn from design and test documentation. A fourth section, however, is drawn from original thinking on the subject of how OSSE might have been built and tested differently in order to achieve better results – the "lessons learned" section. This final section will be more directed toward contributing to the improvement of future such programs, rather than contributing to spacecraft integration as significantly as the first three sections are intended to do.

PART 1 OSSE INSTRUMENT AND SUBSYSTEM DESCRIPTION

TABLE 1-1. OSSE EXPERIMENT SUMMARY (table 2-1 of EXO56-007A)

A. Detectors

1. Type

2. Aperture Area (total) Effective Area

3. Field-of-View

4. Energy Range

5. Energy Resolution

6. Time Resolution

7. Stability

B. Experiment Objectives

1. 0.1-10 MeV line gamma-rays (10^-6 sec)

2. 0.1-1 MeV continuum

gamma-rays

1-10 MeV continuum

gamma-rays

3. Gamma-Ray Burst

4. Solar Flare Line

gamma-rays (10⁻³ sec flare)

5. Solar Flare Neutrons

(>10 MeV)

Four identical NaI-Csi phoswiches, actively-shielded

 2685 cm^2

2310 cm² 0 0.54 MeV

867 cm² 0 4.43 MeV

 $+/-3.8 \times +/-11.4 \text{ degrees FWHM } 0.51 \text{ MeV}$

(rectangular collimator holes)

0.05-10 MeV gamma rays (primary objective)

10-150 MeV gamma-rays (secondary objective)

>10 MeV solar neutrons (secondary objective)

<=8.0% **0** 0.661 MeV

<=3.2% **0** 6.13 MeV

1,2,4,8,16,32 sec in normal mode

0.125 msec in pulsar mode

4,8,16,32 msec in burst mode

<=0.1% over 10 min

<=1% over 24 hours

approx 2x10^-5 gamma/cm^2-sec

0.005X Crab

0.02X Crab

10^-7 ergs/cm^2

 $5 \times 10^{-4} \text{ photons/cm}^2 - \text{s}$

 $5 \times 10^{-3} \text{ n/cm}^2 - \text{s}$

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Availability Ecoes

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A-1

TABLE 1-1 OSSE EXPERIMENT SUMMARY (table 2.1 of EXO56-007A, cont)

C. Pointing System

1. Type: Independent Single Axis per Detector

2. Drive System Redundant Stepper Motor

3. Maximum Drive Speed 2 degrees/sec

4. Accuracy Absolute <= 0.25 degree Calibrated to <= 0.1 degree

D. GRO-Experiment Interface Data

1. Telemetry PCM Serial Data Line: 6492 BPS

2. Command 8 PCM serial commands +62 discrete commands

3. Weight 4193 lbs maximum lbs actual

4. Moment of Inertia 11.5 slug-ft²

The following text is excepted from the BASD document EX056-007A, Rev _, which provides overviews of the OSSE Instrument in two aspects, electronic and mechanical.

1.1 ELECTRONICS OVERVIEW

Figure 1-1 is a block diagram of OSSE subsystems and Assemblies.
Figure 1-2 is a block diagram of the complete OSSE instrument. The electronics complement for OSSE includes four sets of Detector Electronics Assemblies, Central Electronics Subsystem, Drive Electronics Assembly, and Charged Particle Monitor Electronics Assembly. The Central Electronics Subsystem includes redundant Processor Electronics Assemblies, Power Control Unit Assembly, and redundant Central Electronics Low Voltage Power Supply Subassemblies. The Drive Electronics Assembly includes four redundant sets of motor drive circuits and support circuits. The Charged Particle Monitor Electronics Assembly includes redundant electronics and high voltage power supplies.

The Detector Electronics Assembly contains all the circuitry to completely support the Detector Subsystem including Phoswich, Annular Shields, Charged Particle Detector, and the Co60 Assembly. This encompasses low level frontend circuitry, event processing circuits, interface circuitry, command circuits, high voltage power supplies, heater control circuit, housekeeping/status circuitry, an AGC system, and low voltage power supply (LVPS).

The Central Electronics Subsystem forms the complete interface between the observatory Remote Interface Unit (RIU) and the four Detector Subsystems. It performs all control functions for collection, formatting, and readout of data, both scientific and housekeeping/status. The Processor Electronics (part of CE) contains the microprocessor/support electronics and is completely redundant. The Power Control Unit (part of CE) contains power switching, monitoring, and interface for all primary power to the instrument. It also contains secondary

power switching and monitoring for the drive electronics as well as thermostats and monitors for the make-up and shuttle operations heater circuits. The CE LVPS contains redundant low voltage power supplies and redundant motor drive regulators. Each CE LVPS powers a dedicated PE and CPM electronics. The motor drive refulators power the Drive Electronics. The Drive Electronics Assembly contains drive circuits for all motors in each Gearbox Assembly. In addition, interface circuits, sequence control, and power conditioning are contained in this assembly.

The Charged Particle Monitor Electronics Assembly includes two redundant sets of circuits for the two CPM's in the CPM subsystem. Each CPM Photomultiplier Tube (PMT) is biased by a dedicated electronics to a particular processor electronics. The Charged Particle Monitor Subsystem is inclusive in a single assembly.

FIGURE 1-1. INSTRUMENT SUBSYSTEMS AND ASSEMBLIES (Fig. 2-1 of EX-056-007A)

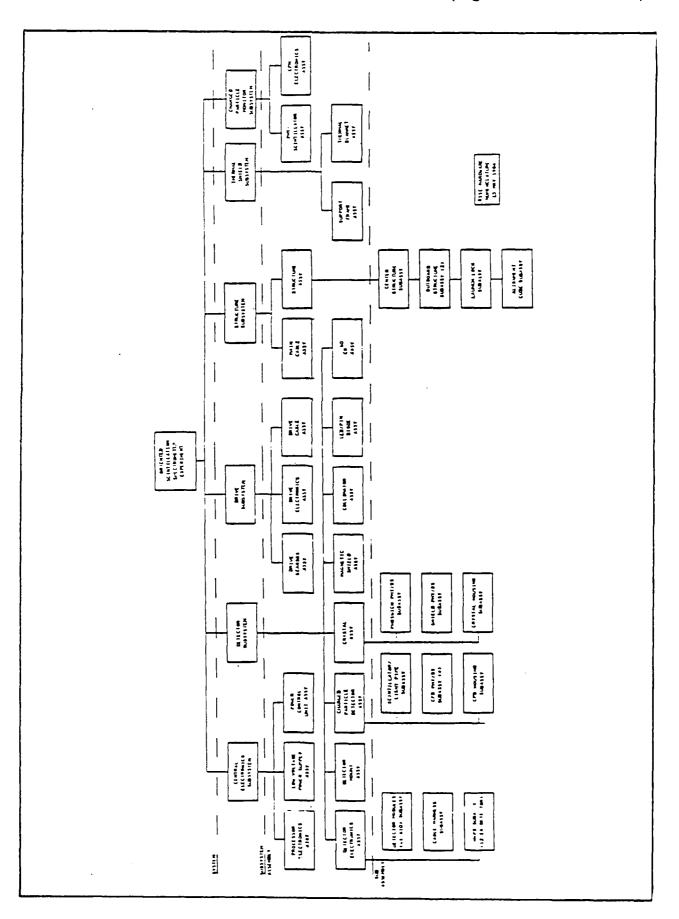
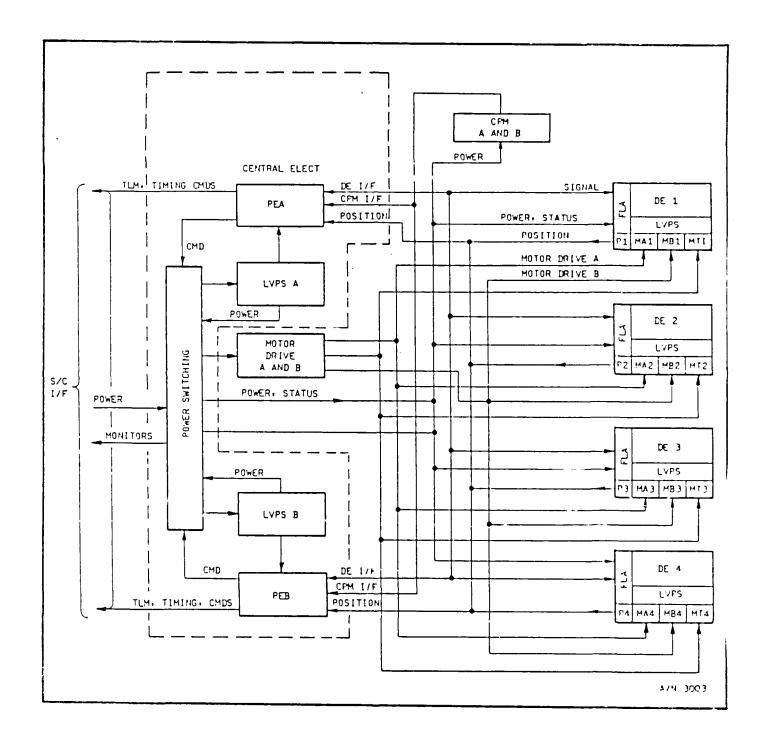


FIGURE 1-2. OSSE BLOCK DIAGRAM (Fig 2-2 of EXO56-007A)



1.2 MECHANICAL OVERVIEW

The instrument consists of four large Detector Subsystems mounted on a swing-set like structure assembly. Covering or blanketing the instrument is a Thermal Shield Subsystem. The instrument arrangement is shown in Figure 1-3. Each Detector Subsystem can be rotated about its axis of rotation over a range of 192 degrees. The Detector Subsystem consists of a large crystal assembly containing a phoswich and four annulus shield scintillation crystals. In addition, there is a Charged Particle Detector (CPD) Assembly, Collimator (lead-tungsten) Assembly, Detector Electronics Assembly, Detector Mount Assembly, Magnetic Shield Assembly, and LED/PIN Diode Assembly (2). This arrangement is shown in Figure 1-3. Each scintillation element is viewed by photomultiplier tube subassemblies consisting of the phoswich (7 tubes), annular shield (4x3 tubes), charged particle detector (4 tubes), and Co60 (1 tube). This Co60 assembly is a calibration source and is part of the Collimator Assembly. The Collimator Assembly is placed forward of the phoswich in the Crystal Assembly and defines a total field of view of +/-3.8 degrees x +/-11.4 degrees. The Charged Particle Detector Assembly closely covers the forward end of the Crystal Assembly including the Collimator Assembly.

The Structure Subsystem includes the Structure Assembly and Main Cable Assembly. Mounted to the Structure Assembly are the large Central Electronics Subsystem, Drive Subsystem, and Charged Particle Monitor Subsystem as shown in Figure 1-3 (2-3). The Drive Subsystem includes four Drive Gearbox Assemblies, Drive Electronics Assembly, and Drive Cable Assembly. Each Drive Gearbox Assembly contains a 1620 to 1 gear reduction subassembly, stepper motors (2), and transfer subassembly. The transfer subassembly includes a linear actuator mechanism motor.

The Charged Particle Monitor Subsystem includes two PMT-Scintillator Assemblies, and the CPM Electronics Assembly.

The Thermal Shield Subsystem includes a Support Frame Assembly and a Thermal Blanket Assembly.

FIGURE 1-3. INSTRUMENT GENERAL ARRANGEMENT (Fig 2-3 of EXO56-007A)

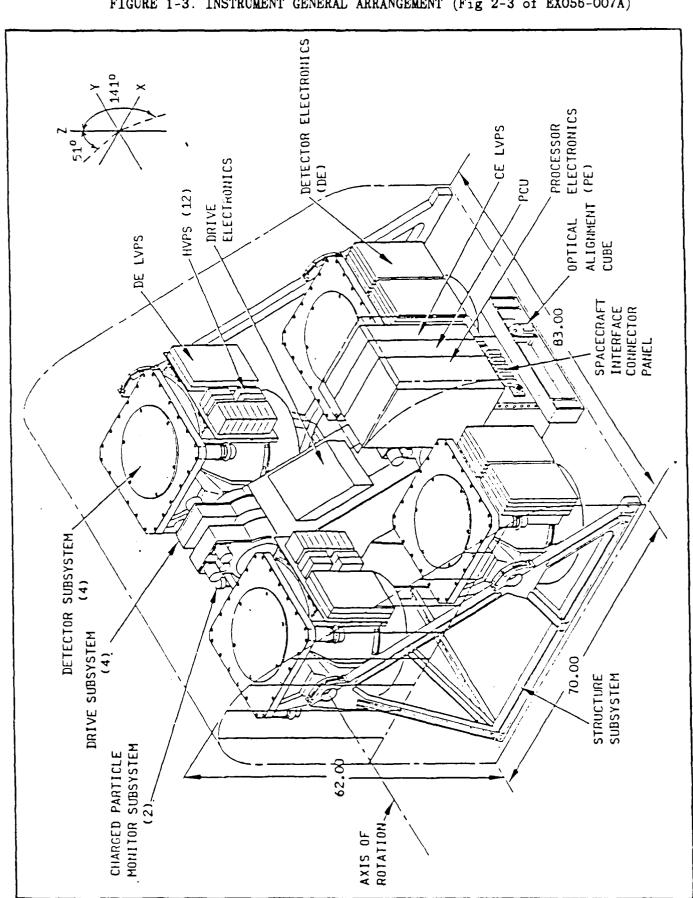
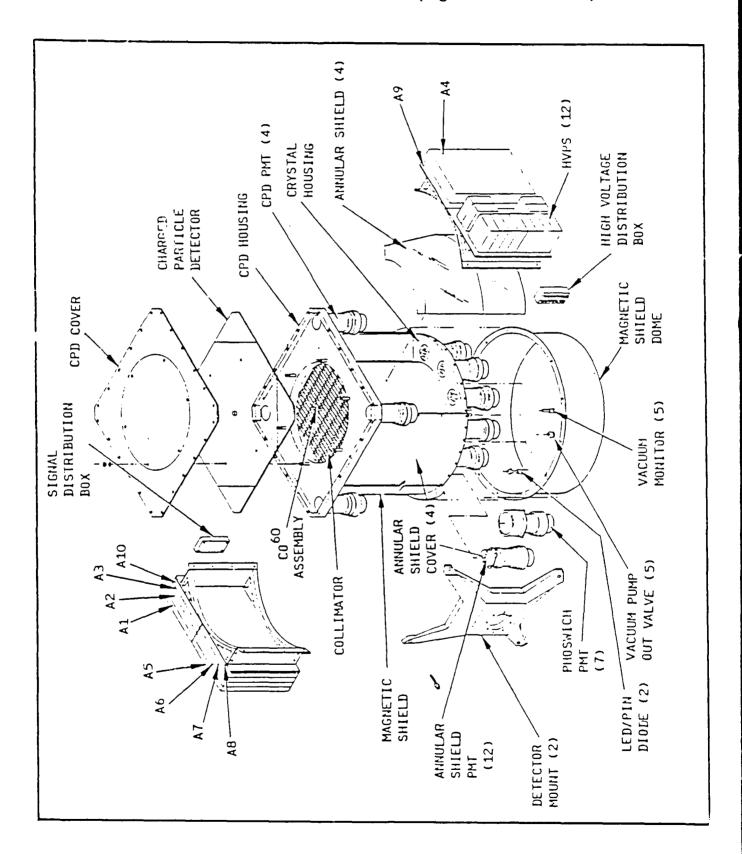


FIGURE 1-4. DETECTOR SUBSYSTEM (Fig 2-4 of EXO56-OO7A)



1.3 SUBSYSTEMS

The subsystems described in this report are some of those systems that are pertinent to the activity of those who will work with OSSE during GRO integration. A description of a wider set of subsystems, not all of which directly affects OSSE/TRW Spacecraft integration, may be found in EX O56-007, BASD OSSE DESIGN DESCRIPTION DOCUMENT, which is included in its entirety as an appendix to this report (Appendix 1). Excerpts from that document provide the majority of material for Part 1 of this report.

1.3.1 CPM ELECTRONICS ASSEMBLY

The CPM subsystem is remotely located high on the structure providing approximately a 180 degree field of view. This subsystem includes two high voltage power supplies, two photomultiplier tubes and bleeder strings, and redundant signal processing electronics. One set of electronics is controlled by PE-A and the other by PE-B. Figures 1-5 (5-41) illustrates the CPM electronics, and Figure 1-6 (5-46)illustrates the CPM mechanical package.

1.3.2 CENTRAL ELECTRONICS CABLING

Two cabling systems are involved with the electronics and mount to the main structure. These are the main cable assembly (which is part of the structure subsystem) and the drive cable assembly (which is part of the drive subsystem). The cables are identified as W20 thru W54. Table 1-2 (5-11) is a listing of the functional use of each cable, and Figure 1-7 (5-42) is the CE cabling diagram.

FIGURE 1-5. CPM ELECTRONICS BLOCK DIAGRAM (Fig 5-41 of EXO56-007A)

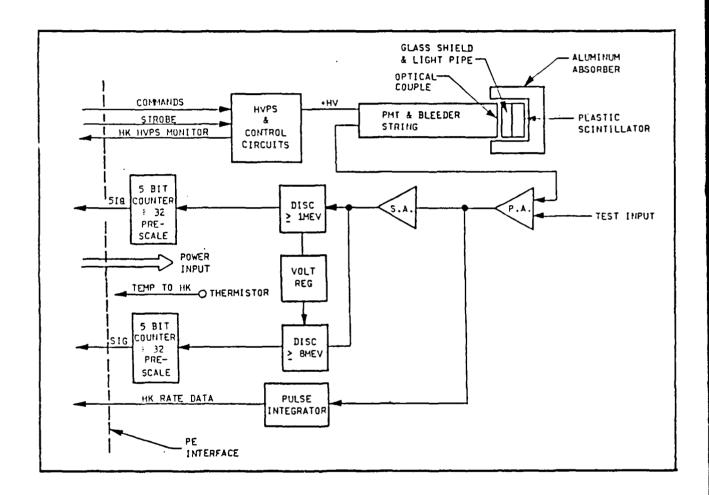


FIGURE 1-6. CPM ELECTRONICS ASSEMBLY PACKAGING (Fig 5-46 of EXO56-007A)

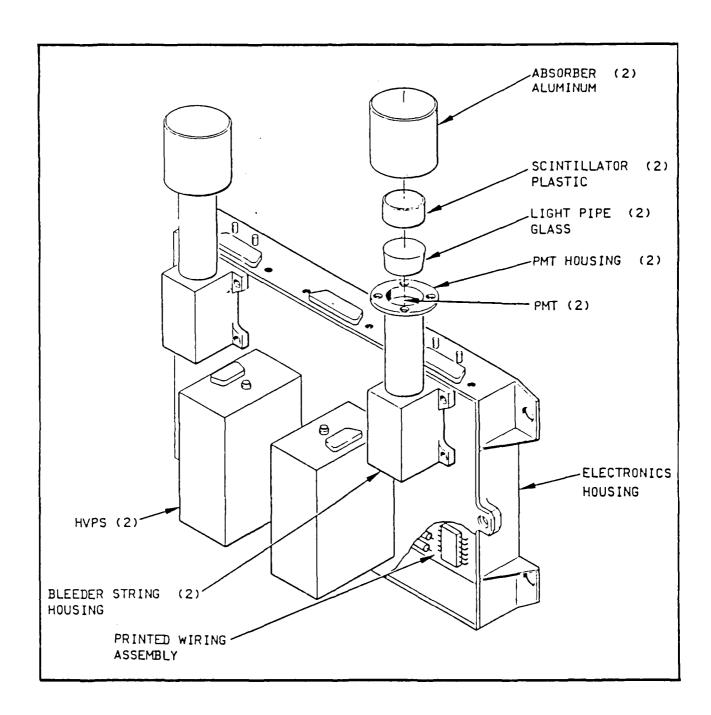
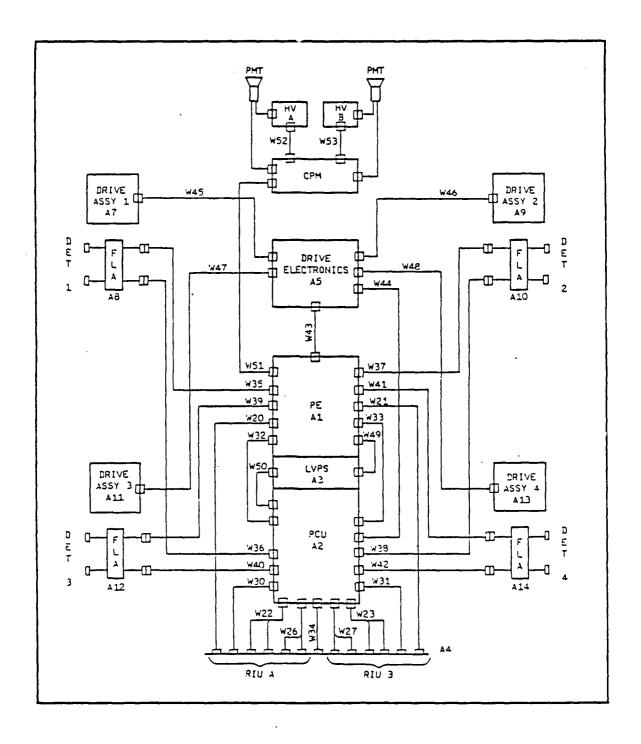


TABLE 1-2. CABLE IDENTIFICATION (Fig 5-11 of EXO56-007A)

	Number	<u>Function</u>
	W20	SERIAL A
	W21	SERIAL B
	W22	TELEMETERY A
	W23	TELEMETERY B
	W24	TLM AND CLOCK A
	W25	TLM AND CLOCK B
	W26	DISCRETES II A
	W27	DISCRETES II B
	W28	DISCRETES II A
	W29	DISCRETES I A
	W30	MAIN POWER
	W31	REDUNDANT POWER
	W32	ANALOG S16 A
	W33	ANALOG S16 B
	W34	HEATER JUMPERS
	W35	DET 1 DATA
•	W36	DET 1 POWER
	W37	DET 2 DATA
	W38	DET 2 POWER
	W39	DET 3 DATA
	W40	DET 3 POWER
	W41	DET 4 DATA
	W42	DET 4 POWER
	W43	MOTOR DRIVE, SENSORS
	W44	MOTOR DRIVE, TRANSFER
	W45	MOTOR, LIMIT SWITCHES DET 1
	W46	MOTOR, LIMIT SWITCHES DET 2
	W47	MOTOR, LIMIT SWITCHES DET 3
	W48	MOTOR, LIMIT SWITCHES DET 4
	W49	CE POWER
	W50	PE POWER
	W51	CPM I/F
	W52	CPM HWPS A
	W53	CPM I/F
	W54	HEATERS/THERMISTORS

FIGURE 1-7. CE CABLING (Fig 5-42 of EXO56-007A)



1.3.3 HIGH VOLTAGE DISTRIBUTION CABLING

The High Voltage distribution is illustrated in Figure 1-8 (3-53).

1.3.4 RIU INTERFACE

The two primary RIU interfaces are both serial; one is the Command Interface and the other is the Telemetry Interface. The RIU Command Interface Block Diagram is shown in Figure 1-8, and the RIU Telemetry Interface Block Diagram is shown in Figure 1-9.

The two independent RIU Command Interfaces are supported by each processor electronics. The RIU Telemetry Interface provides the serial telemetry data inteface between the spacecraft and the OSSE instrument.

1.3.5 THERMAL BUS POWER CONTROL DESCRIPTION

Figure 1-10 is a block diagram of the Thermal Bus. Both Thermal Buses, main and redundant, pass through a bus filter consisting of a two section LC filter with a balun transformer. Following the filter, each bus (power and return) is routed to four bus select relays where main or redundant power is selected by command for use by the system. The selected bus from each of the four relays had redundant 4-amp fuses with 0.25 ohm resistor in series with one of them. Voltage is monitored at this point by on/off relays which respond to discrete commands. Current from each detector active heater return is sensed by a resistor and amplifier. Status of each on/off relay position is monitored by a bilevel monitor.

1.3.6 MAKE-UP BUS POWER CONTROL DESCRIPTION

Figure 1-11 is a block diagram of the make-up bus power switching and temperature control. The main and redundant unfiltered make-up buses are routed to a single bus relay. The selected bus is then divided into five power lines. Each line is then used by the following circuits:

DE1 Temp Control

DE2 Temp Control

DE3 Temp Control

DE4 Temp Control

CE Temp Control

Each temperature control circuit consists of redundant 3A fuses with a 0.25 ohm resistor in series with one of the fuses. A voltage monitor, a power on/off relay which responds to discrete on and off commands, and a bilevel monitor for relay on/off status are part of each circuit. Following the relay, the power line routes to a discrete temperature control circuit (thermostat) which uses a power FET for switching power to heaters located in the detector. Redundant thermistors located by the heaters provide feedback. Temperature is controlled between 10 degrees and 13.5 degrees C.

Current from each control circuit is monitored on the return line with a sense resistor and amplifier. On, off and open heater status is monitored for each circuit. The temperature control circuit has an overide circuit which responds to logic level serial commands from the PE. The overide command can switch the heater on at any time.

FIGURE 1-8. RIU COMMAND INTERFACE BLOCK DIAGRAM (Fig 5-14 of EXO56-007A)

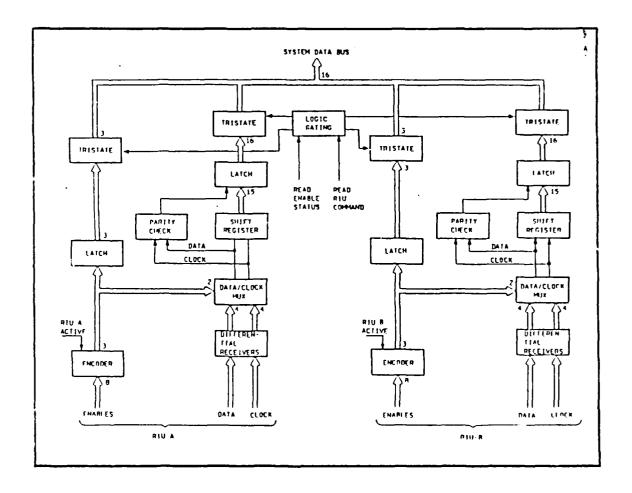


FIGURE 1-9. RIU TELEMETRY INTERFACE BLOCK DIAGRAM (Fig 5-16 of EXO56-007A)

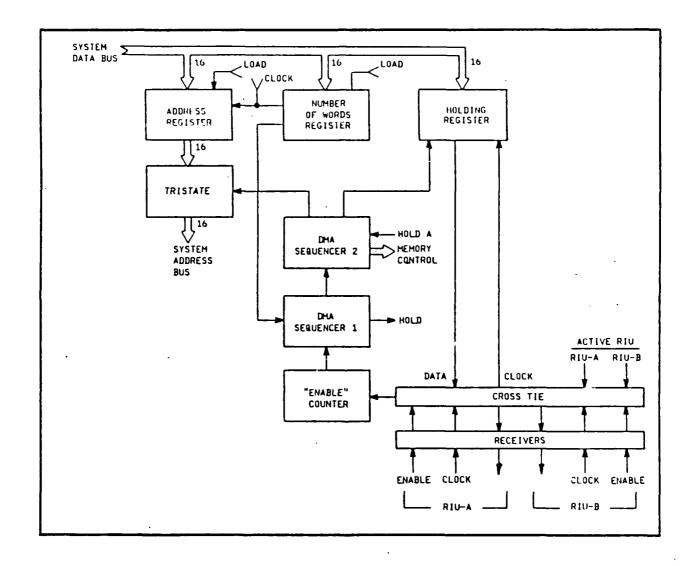


FIGURE 1-10. PCU-THERMAL BUS DETECTOR ACTIVE HEATER POWER SWITCHING (Fig 5-33 of EXO56-007A)

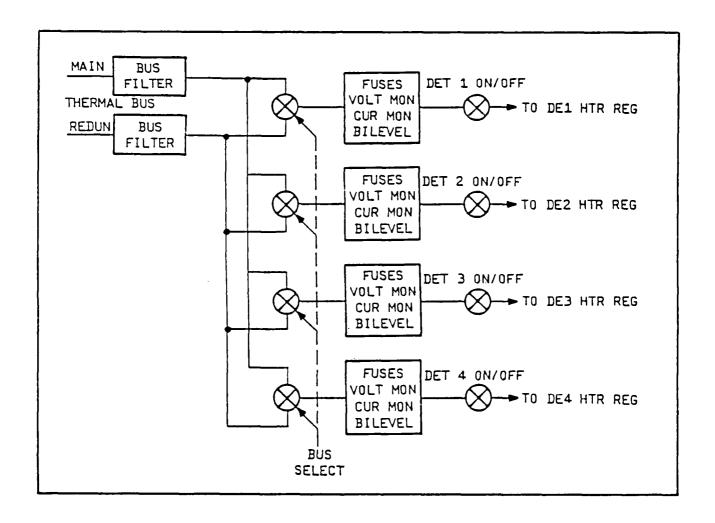
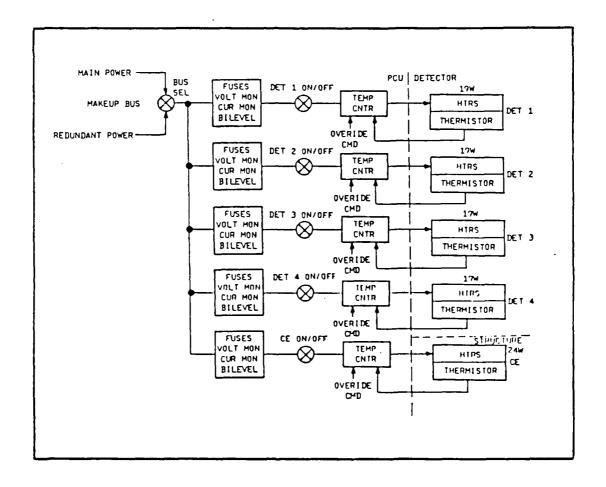


FIGURE 1-11. MAKE-UP BUS POWER SWITCHING AND TEMPERATURE CONTROL (Fig 5-34 of EXO56-007A)



PART 2. OSSE 'AS BUILT' DATA

2.1 OSSE CONNECTOR ASSIGNMENT

2.1.1 IDENTIFICATION MARKING

Each connector is identified with a unique reference designator number which was assigned by the GRO integrating contractor. Each wiring harness is identified with the manufacturer's part number, a 'w' number assigned by the integrating contractor, a serial number, and the manufacturer's name.

The TRW Document IF3-1135F, GRO SPACECRAFT/OSSE INTERFACE CONTROL DOCUMENT is referenced concerning connector pin assignments. These are described in Table 2-1, and Tables 2-2-1 through 2-2-17.

TABLE 2-1. OSSE CONNECTOR ASSIGNMENT (Table 3.2.7-1 of TRW-ICD)

INSTRUMENT SUBSYSTEM	INSTRUMENT CONNECTOR BO.	PUNCTION .	TRW PART NO.

ICP*	J1	COMMANDS I, RIU-A	2A014-035V-001
ICP	J2	COMMANDS II, RIU-A	2A014-035V-001
ICP	J3	TELEMETRY, RIU-A	2A014-040V-001
ICP	J4	COMMANDS(S), RIU-A	2A014-040V-001
ICP	J5	TELEMETRY CLOCKS, RIU-A	2A014-040V-001
ICP	J6	POWER, HAIN	2A012-555V-001
ICP	J7	COMMANDS I.RIU-B	2A014-035V-001
ICP	JØ	COMMANDS II.RIU-B	28014-035V-001
ICP	J9	TELEMPTRY, RIU-B	28014-040V-001
ICP	J10	COMMANDS(S), RIU-B	28014-0404-001
ICP	J11	TELEMETRY, CLOCKS, RIU-B	28014-0404-001
ICP	J12	POWER, REDUNDANT	2A012-555V-001
ICA	J13 -	SHUTTLE IFJ	2A014-037V-001

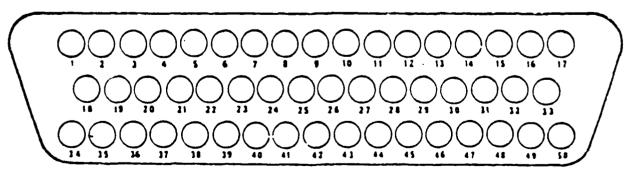
^{*}INTERFACE CONNECTOR PANEL (511)

TABLE 2-2-1. OSSE CONNECTOR PIN ASSIGNMENT (Table 3.2.7.2 of TRW-ICD)

OSSE/GRO INSTRUMENT INTERFACE PIN CONNECTOR ASSIGNMENTS

ICP (511) | RIU-A (620)

IN	OSSE FUNCTION OSSE FUNCTION DISC CMD +28V PULSE I DET 2 ACTIVE HTR ON DET 4 ACTIVE HTR ON DET 2 MU HTR ON DET 2 MU HTR ON DET 4 MU HTR ON XFER DET 2 PWR SEL A XFER DET 4 PWR SEL A MTR DRIVE LAUNCH LOCK OFF PROC ELECT A ON B OFF SIGNAL GND CHASSIS GND MOTOR DRIVE REG A ON B OFF DET 1 HOTOR A SEL B DESEL DET 3 MOTOR A SEL B DESEL SPARE SPARE SPARE SPARE SYC MU PWR PRIM SEL SEL RIUB PROC ELECT B RESET CHASSIS GND SIGNAL GND SIGNAL GND S/C HTR PWR PRIM DESEL DET 4 MOTOR B SEL A DESEL DET 2 MOTOR B SEL A DESEL MOTOR DRIVE REG B OFF PROC ELECT B OFF SPARE CENT ELECT HU HTR OFF XFER DET 3 PWR DSEL A XFER DET 1 PWR DSEL A XFER DET 1 PWR DSEL A DET 3 MU HTR OFF DET 1 ACTIVE HTR OFF	GRO DESCRIPTION	PIN NO.	GRO CONN.	MODULE
	DISC CMD +28V PULSE I	+28 VOLT PULSE I	54	J 7	
	DET 2 ACTIVE HTR ON	DISCRETE COMMAND 2	12	J7	
	DET 4 ACTIVE HTR ON	DISCRETE COMMAND 4	10	J7	
	DET 2 MU HTR ON	DISCRETE COMMAND 6	8	J7	
	DET 4 MU RTR ON	DISCRETE COMMAND 8	6	J7	
	XPER DET 2 PWR SEL A	DISCRETE COMMAND 10	34	37	
	XFER DET 4 PWR SEL A	DISCRETE COMMAND 12	32	J7	
	MTR DRIVE LAUNCH LOCK OFF	DISCRETE COMMAND 14	30	37	
	PROC ELECT A ON B OFF	DISCRETE COMMAND 16	28	37	
7	SIGNAL GND	SIGNAL GND	14	J7	
8	CHASSIS GND	NC			
2	HOTOR DRIVE REG A ON B OFF	DISCRETE COMMAND 18	26	J7	
3	DET 1 MOTOR A SEL B DESEL	DISCRETE COMMAND 20	53	J 7	
4	DET 3 MOTOR A SEL B DESEL .	DISCRETE COMMAND 22	51	J7	
5	SPARE	DISCRETE COMMAND 24	49	J7	
6	SPARE	DISCRETE COMMAND 26	47	J7	
9	S/C MU PWR PRIM SEL	DISCRETE COMMAND 28	45	J 7	
1	SEL RIUB	DISCRETE COMMAND 32	71	J7	
2	PROC ELECT B RESET	DISCRETE COMMAND 34	69	J7	
3	CHASSIS GND	NC			
14	SIGNAL GND	SIGNAL GND	12	J8	
5	S/C HTR PWR PRIM DESEL	DISCRETE COMMAND 36	67	J7	
16	S/C PRIME PWR PRIM DESEL	DISCRETE COMMAND 38	65.	37	
7	DET 4 MOTOR B SEL A DESEL	DISCRETE COMMAND 40	10	J8	
38	DET 2 MOTOR B SEL A DESEL	DISCRETE COMMAND 42	8	J8	
9	MOTOR DRIVE REG B OFF	DISCRETE COMMAND 44	6	JB	
10	PROC ELECT B CFF	DISCRETE COMMAND 46	4	J8	
11	SPARZ	DISCRETE COMMAND 48	26	J8	
12	CENT ELECT HU STR OFF	. DISCRETE COMMAND 50	24	J8	
43	XPER DET 3 PWR DSPL A	DISCRETE COMMAND 52	22	J8	
44	XPER DET 1 PHR DSEL A	DISCRETE COMMAND 54	20	J8	
15	DET 3 MU RTR OFF	DISCRETE COMMAND 56	40	J8	
16	DET 1 MU STR OFF	DISCRETE COMMAND 58	38	JA	
17	DET 3 ACTIVE HTR OFF	DISCRETE COMMAND 60	36	J8	
i A	DET 1 ACTIVE STR OFF	DISCRETE COMMAND 62	34	J8	
60	DISC CMD +28V PULSE I	+28V PULSE I	28	J8	



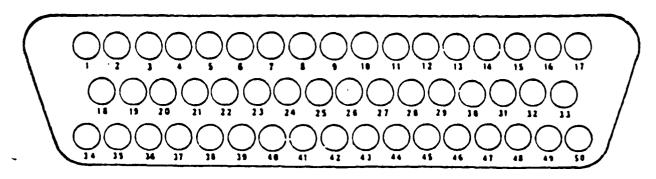
THE BOX/CHASSIS MATING/ENGAGING FACE IS SHOWN

TABLE 2-2-2. OSSE CONNECTOR PIN ASSIGNMENT (Table 3.2.7.2 of TRW-ICD, cont'd)

OSSE/GRO
INSTRUMENT INTERFACE PIB CONNECTOR ASSIGNMENTS

| ICP (511) | RIU-A (620)

CONTA	OSSE FUNCTION OSSE FUNCTION DISC CMD +28V PULSE II DET 1 ACTIVE HTR ON DET 3 ACTIVE HTR ON DET 3 MU HTR ON DET 1 MU HTR ON DET 3 MU HTR ON XPER DET 1 PWR SEL A XFER DET 3 PWR SEL A CENT ELECT HU HTR ON SPARE SIGNAL GND CHASSIS GND PROC ELECT B ON A OFF HOTOR DRIVE REG B ON A OFF DET 2 MOTOR A SEL B DESEL DET 4 MOTOR A SEL B DESEL DISC CMD +28V PULSE II S/C PRIME PWR PRIM SEL S/C HTR PWR PRIM SEL S/C HTR PWR PRIM SEL SPARE S/C MU PWR PRIM DESEL SPARE DET 3 MOTOR B SEL A DESEL DET 1 MOTOR B SEL A DESEL DET 1 MOTOR B SEL A DESEL MOTOR DRIVE REG A OFF CHASSIS GND DISC CMD +28V PULSE III HTR DRIVE LAUNCH LOOK ON XFER DET 2 PWR DSEL A DET 4 MU HTR OFF DET 4 ACTIVE HTR OFF DET 2 ACTIVE HTR OFF DET CALLED ACTIVE	1			
PIN	OSSE	GRO	PIN	GRO	
NO.	FUNCTION	DESCRIPTION	NO.	CONN.	MODILL P
					HODOLE
1	DISC CMD +28V PULSE II	ADRU DITT CP 11			
2	DET 1 ACTIVE HTR ON	DISCORTE COMMAND 1	35	37	
3	DET 3 ACTIVE HTR ON	DISCRETE COMMAND 3	13	37	
4	DET 1 MU RTR ON	DISCRETE COMMAND 5	٠,	77	
5	DET 3 MU HTR ON	DISCRETE COMMAND 7	ź		
6	XPER DET 1 PWR SEL A	DISCRETE COMMAND 9	έ	.17	
7	XFER DET 3 PWR SEL A	DISCRETE COMMAND 11	าา์	.77	
8	CENT ELECT HU HTR ON	DISCRETE COMMAND 11	31	.17	
9_	SPARE	DISCRETE COMMAND 15	29	37	
17	SIGNAL GND	SIGNAL GND	63	37	
18	CHASSIS GND	NC		•	
22	PROC ELECT B ON A OFF	DISCRETE COMMAND 17	27	J7	
23	HOTOR DRIVE REG B ON A OFF	DISCRETE COMMAND 19	25	.17	
24	DET 2 MOTOR A SEL B DESEL	DISCRETE COMMAND 21	52	37	
25	DET 4 MOTOR A SEL B DESEL	DISCRETE COMMAND 23	50	37	
26	DISC CMD +28V PULSE II	+28V PULSE II	11	JA	
28	S/C PRIME PWR PRIM SEL	DISCRETE COMMAND 25	48	.17	
29	S/C ATR PWR PRIM SEL	DISCRETE COMMAND 27	46	.17	
30	PROC ELECT A RESET	DISCRETE COMMAND 29	44	17	
31	SEL RIUA	DISCRETE COMMAND 11	72	37	
32	SPARE	DISCRETE COMMAND 33	70	.17	
33	S/C MU PWR PRIM DESEL	DISCRETE COMMAND 35	68	37	
34	SPARZ	DISCRETE COMMAND 37	66.	.17	
35	SPARE	DISCRETE COMMAND 19	64	.17	
36	DET 3 HOTOR B SEL A DESEL	DISCRETE COMMAND 41	à	18	
37	DET 1 MOTOR B SEL A DESEL	DISCRETE COMMAND 43	ź	.78	
38	MOTOR DRIVE REG A OFF	DISCRETE COMMAND 45	5	JR	
39	PROC ELECT A OFF	DISCRETE COMMAND 47	ž	JA	
40	CHASSIS GND	. NC			
41	DISC CMD +28V PULSE III	+28V PULSE 111	74	J7	
42	HTR DRIVE LAUNCH LOCK ON	DISCRETE COMMAND 49	25	JB	
43	XFER DET 4 PWR DSEL A	DISCRETE COMMAND 51	23	JR	
44	XFER DET 2 PWR DSEL A	DISCRETE COMMAND 53	21	JA	
45	DET 4 MU HTR OFF	DISCRETE COMMAND 55	19	JB	
46	DET 2 MU RTR OPP	DISCRETE COMMAND 57	39	์ วัล	
47	DET 4 ACTIVE HTR OFF	DISCRETE COMMAND 59	37	J8	
48	DET ? ACTIVE RTR OFP	DISCRETE COMMAND 61	35	JB	
50	DISC CHD +28V PULSE III	+28V PULSE 111	27	J8	

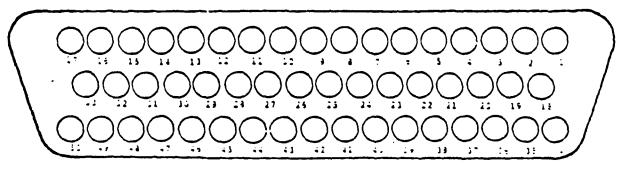


THE BOX/CHASSIS MATING/ENGAGING FACE IS SHOWN

TABLE 2-2-3. OSSE CONNECTOR PIN ASSIGNMENT (Table 3.2.7.2 of TRW-ICD, cont'd)

OSSE/GRO - INSTRUMENT INTERFACE PIN CONNECTOR ASSIGNMENTS ICP (511) | RIU-A (620)

CONN NO. J3 (2A014-040V-001) PIN GRO GRO OSSZ PIN CONN. MODULE DESCRIPTION NO. PUNCTION NO. TLM REP INPUT 1 TLM ACT ALG RIN J6 TLM DATA INPUT 8 PEA +5V CURRENT TLM DATA INPUT 9
TLM DATA INPUT 10 PEA +10V CURRENT PEA -10V CURRENT TLM DATA INPUT 11 PEA +20V CURRENT TLM DATA INPUT 12 J6 PEA MICRO CURRENT 6 J6 J5 J5 J5 J5 J5 TEM REP INPUT 1 TLM ACT ALG RTN PASS TRANS CURR RTN
TLM PASS ALG RTN
DET 1 XTAL HOUS CRY 1 TEMP
DET 2 XTAL HOUS CRY 1 TEMP
DET 3 XTAL HOUS CRY 1 TEMP PASS TRANSDUCER RTM TLM REP INPUT 2 TLM DATA INPUT 16 12 TLM DATA INPUT 17 35 TIM DATA INPUT 18
TIM DATA INPUT 19
TIM DATA INPUT 20
TIM DATA INPUT 21 DET 4 XTAL HOUS CRY 1 TEMP J5 J5 J5 SPARE 17 18 SPARE TLM DATA INPUT 22 40 SPARE J5 J5 TLM DATA INPUT 23 SPARE TLM REP INPUT 2 TLM REP INPUT 3 TLM DATA INPUT 24 TLM PASS ALG RTH TLM PASS ALG RTN 68 J6 J6 J6 OUTER SHELL TEMP TLM DATA INPUT 25 61 62 STRUCTURE TEMP 1 TEM DATA INPUT 26 STRUCTURE TEMP 2 TLM REF INPUT 4 TLM DATA INPUT 32 10-TLM ACT ALG RTN PEB +5V CURRENT PEB +10V CURRENT J6 28 J6 J6 TLM DATA INPUT 33 TLM DATA INPUT 34 PEB -10V CURRENT J6 J6 TLM DATA INPUT 35 TLM DATA INPUT 36 PEB +20V CURRENT PEB HICRO CURRENT 32 CHASSIS GND NC J6 TLM REP INPUT 4 TLM REP INPUT 5 TLM ACT ALG RTN 30 TLM ACT ALG RIN TLM DATA INPUT 40
TLM DATA INPUT 41
TLM DATA INPUT 42 J6 PEA FUSE MONITOR PEB PUSE MONITOR J6 J6 39 33 PEA LUPS CURRENT 40 **J**6 TLM DATA INPUT 43 PEB LVPS CURRENT TLM REF INPUT 5 TLM ACT ALG RTN SIGNAL GND SIGNAL GND



CRASSIS GND

THE BOX/CHASSIS MATING/ENGAGING FACE IS SHOWN

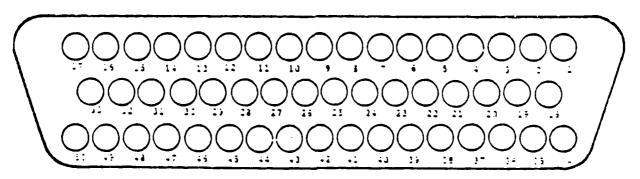
TABLE 2-2-4. OSSE CONNECTOR PIN ASSIGNMENT (Table 3.2.7.2 of TRW-ICD, cont'd)

CONN NO. J4 (2A014-040V-001) 1 PIN OSSE GRO PIN GRO GRO DESCRIPTION FUNCTION NO. NO. CONN. MODULE --------SER CHO CLK 1 TRUE SER CMD CLK 1 TRUE SER CHD CLK 1 COMP SER CHD CLK 1 COMP SER CHD CLK 2 TRUE SER CHO CLK 2 TRUE SER CHD CLK 2 COMP SER CHD CLK 2 COMP J7 57 SER CHD CLK 3 TRUE SER CHD CLK 3 TRUE 37 37 SER CHD CLK 3 COMP SER CHD CLK 3 COMP SER CMD CLK 4 TRUE SER CHD CLK 4 TRUE Jθ SER CHD CLK 4 COMP SER CHD CLK 4 COMP SER DATA CLK 1 TRUE SER DATA CLK 1 TRUE SER DATA CLK 1 COMP 10 SER DATA CLK 1 COMP 11 CHASSIS GND NC SIGNAL GND SIGNAL GND HAJOR FRAME RATE 3 1.024 MHZ CLK 2 TRUE HAJOR FRAME RATE SIG 3 13 60 1.024 MHZ CLK 2 TRUE ĴΒ 1.024 MHZ CLK 2 COMP 1.024 MRZ CLK 2 COMP +5.3V STBY 11-3 RIU-8(621) CONDITIONED +5.3 STBY II-3 17 BATSE TRIG SIG-MAIN BTS-A, PRIME J39 CEU-A(551) SER CHO DATA 1 TRUE SER CHO DATA 1 TRUE J7 SER CHD DATA 1 COMP SER CHD DATA 1 COMP **J**7 SER CHD DATA 2 TRUE SER CHO DATA 2 TRUE 56 J7 SER CHD DATA 2 COMP SER CHD DATA 3 TRUE SER CHD DATA 2 COMP SER CHD DATA 3 TRUE 55 76 J7 SER CMD DATA 3 COMP SER CHD DATA 3 COMP **J**7 SER CMD DATA 4 TRUE SER CHD DATA 4 TRUE SER CHD DATA 4 COMP SER DATA CLK 3 TRUE SER DATA CLK 3 COMP SER CHD DATA 4 COMP SER DATA CLK 3 TRUE SER DATA CLK 3 COMP **J**6 J6 CHASSIS GND . SIGNAL GND SIGNAL GND MAJOR FRAME RATE 4 HAJOR FRAME RATE 4 32

TABLE 2-2-5. OSSE CONNECTOR PIN ASSIGNMENT (Table 3.2.7.2 of TRW-ICD, cont'd)

OSSE/GRO INSTRUMENT INTERPACE PIN CONNECTOR ASSIGNMENTS

		 RIU-A (620)			
CONN	NO. J4 (2A014-040V-001)	 			
PIN	ossz	GRO	PIN	GRO	
NO.	PUNCTION	DESCRIPTION	NO.	CONN.	HODULE
	*******	**********			
31	1.024 MHZ CLK 1 TRUE	1.024 MRZ CLK 1 TRUE	3	J7	
32	1.024 HHZ CLK 1 COMP	1.024 MHZ CLK 1 COMP		J7	
33	CONDITIONED +5.3V STBY II-2	+5.3V STBY 11-2	43	J5	
34	BATSE TRIG SIG RTN-MAIN	BTS-A RTN, PRIME	23	J39	CEU-A(551)
35	SER CHD EN 0 (UTC) SER CHD EN 1 SER CHD EN 2 SER CHD EN 3	SER CMD ENABLE 0 (UTC) SER CMD ENABLE 1	20	J7	,
36	SER CMD EN 1	SER CHD ENABLE 1	19	37	
37	SER CHD EN 2	SER CHD ENABLE 2	18	J7	
38	SER CHD EN 3	SER CHD ENABLE 3	17	J 7	
39	SER CHU EN 4	SER CHD ENABLE 4	16	J7	
40	SER CMD EN 5	SER CMD ENABLE 5	15	J7	
41	SER CHD EN 6	SER CHD ENABLE 6	14	J8	
42	SER CHD EN 7	SER CMD ENABLE 7	13	J8	
43	SIGNAL GND	SIGNAL GND	43	J7	
44	TLM DATA I/P O	TLM DATA INPUT O	20	JS	
45	TLM REF I/P O	TLM REP INPUT O	19	J5	
46	SER/AUX TLM EN O	SER/AUX ENABLE O	4	JS	
47	CONDITIONED +5.3V STBY II-1		32	JS	
48	1 HZ TIMING SIG TRUE, MAIN	TTU 1.0 HZ, TRUE, HAIN		J105	CADH(601)
49	1 HZ TIMING SIG COMP, MAIN		20	J105	CADRIGOT)
50	BATSE TRIG SIG SHLD, MAIN	BTS SHLD, MAIN	NC	G Z G J	CZU-A(551)



THE BOX/CHASSIS MATING/ENGAGING FACE IS SHOWN

TABLE 2-2-6. OSSE CONNECTOR PIN ASSIGNMENT (Table 3.2.7.2 of TRW-ICD, cont'd)

OSSE/GRO INSTRUMENT INTERPACE PIN CONNECTOR ASSIGNMENTS

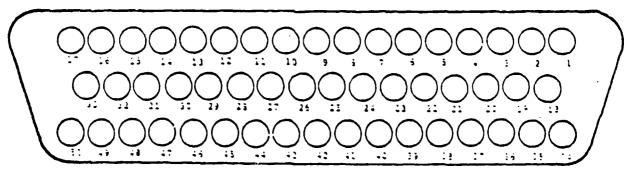
ICP (511) | RIU-A (620)

COM	NO. J5 (2A014-040V-001)	1			
PIN	OSSE	GRO	PIN	GRO	
NO.	FUNCTION	DESCRIPTION	NO.	CONN.	MODULE
	TYM ACT ALG RTN DET 1 ACTIVE HTR CURRENT DET 2 ACTIVE HTR CURRENT DET 3 ACTIVE HTR CURRENT DET 4 ACTIVE HTR CURRENT TLM ACT ALG RTN TLM ACT ALG RTN DET 1 MAKEUP MONITOR DET 2 MAKEUP HONITOR DET 3 HAKEUP HONITOR DET 4 MAREUP HONITOR DET 4 MAREUP HONITOR TLM ACT ALG RTN TLM BILEVEL RTN DET 1 ACTIVE HTR ON/OFF DET 2 ACTIVE HTR ON/OFF DET 3 ACTIVE HTR ON/OFF DET 3 ACTIVE HTR ON/OFF TLM BILEVEL RTN TLM ACT ALG RTN STS HTR TEST PT DET 1 STS HTR TEST PT DET 2 STS HTR TEST PT DET 3 STS HTR TEST PT DET 4 STS HTR TEST PT DET 4 STS HTR TEST PT DET 5 STS HTR TEST PT DET 7 TLM ACT ALG RTN TLM BILEVEL RTN RIU-B SELECTED S/C PRIME PWR-PRIM SELECT S/C HTR PWR-PRIM SELECT				
1	T'H ACT ALG RTN	TLM REF INPUT 6	50	J6	
2	DET 1 ACTIVE HTR CURRENT	TLM DATA INPUT 52	55	J6	
3	DET 2 ACTIVE BTR CURRENT	TLM DATA INPUT 53	56	J6	
4	DET 3 ACTIVE HTR CURRENT	TLM DATA INPUT 54	57	J6	
5	DET 4 ACTIVE HTR CURRENT	TLM DATA INPUT 55	58	J6	
6	TLM ACT ALG RTN	TLM REF INPUT 6	59	J6	
7	TLM ACT ALG RTN	TLM REF INPUT 7	69	J6	
8	DET 1 MAKEUP MONITOR	TLM DATA INPUT 56	70	J6	
9	DET 2 MAKEUP MONITOR	TLM DATA INPUT 57	71	J6	
10	DET 3 HAKEUP MONITOR	TLM DATA INPUT 58	72	J6	
11	DET 4 MAKEUP MONITOR	TLM DATA INPUT 59	73	J6	
12	CZ MAKEUP HTR MONITOR	TLM DATA INPUT 60	74	J6	
13	TLM ACT ALG RTN	TLM REF INPUT 7	78	J6	
14	TLM BILEVEL RTN	TLM REP INPUT O	19	J2	EU (622)
15	DET 1 ACTIVE HTR ON/OFF	TLM DATA INPUT O	20	J2	EU (622)
16	DET 2 ACTIVE HTR ON/OFF	TLM DATA INPUT 1	21	J2	EU (622)
17	DET 3 ACTIVE HTR ON/OFF	TLM DATA INPUT 2	22	J2	EU (622)
18	DET 4 ACTIVE HTR ON/OFF	TLM DATA INPUT 3	23	J2	EU (622)
23	TLM BILEVEL RTN	TLM REF INPUT O	28	J2	EU (622)
24	TLM ACT ALG RTN	TLM REF INPUT 4	10	J3	EU (622)
25	STS HTR TEST PT DET 1	TLM DATA INPUT 32	11	J3	EU (622)
26	STS HTR TEST PT DET 2	TLM DATA INPUT 33	12	J3	EU (622)
27	STS HTR TEST PT DET 3	TLM DATA INPUT 34	13	J3	EU (622)
28	STS HTR TEST PT DET 4	TLM DATA INPUT 35	14	J3	EU (622)
29	STS HTR TEST PT DFT PE	TLM DATA INPUT 16	15	J3	EU (622)
30-	TLH ACT ALG RTN	TLM REF INPUT 4	19	ĴĴ	EU (622)
31	TLM BILEVEL RTN	TLM REF INPUT 5	30	J3	EU (622)
32	RIU-B SELECTED	TEM DATA INPUT AO	31	J	EU (622)
33	S/C PRIME PWR-PRIM SELECT	TIM DATA INPUT 41	32	J3	EU (627)
35	S/C HTR PWR-PRIM SELECT	TLM DATA INPUT 43	34	J3	EU (622)

TABLE 2-2-7. OSSE CONNECTOR PIN ASSIGNMENT (Table 3.2.7.2 of TRW-ICD, cont'd)

OBSE/GRO
INSTRUMENT INTERFACE PIN CONNECTOR ASSIGNMENTS

	10	P (511) RIU-A (620)				
CONN	NO. J5 (2A014-040V-001)					
PIS	OSSE	GRO	PIN	GRO		
NO.	FUNCTION	DESCRIPTION	NO.	CONN.	HODE	ULE
36	S/C HAKEUP PWR-PRIM SELECT	TLM DATA INPUT 44	35	J3	EU (622	7 1
37	TEM BILEVEL RTN	TLM REF INPUT 5	39	JJ	EU (622	- •
38	TLM BILEVEL RTN	TLM REP INPUT 1	21 .	J3	EU (622	
39	PEA ON/OFF	TLM DATA INPUT 8	41	Ji	ਦੂਹ (622	
40	PEB ON/OFF	TLH DATA INPUT 9	42	J3	EU (622	
41	CZ MAKEUP ON/OPP	TLM DATA INPUT 10	43	33	EU (622	
42	DET 1 MAKEUP ON/OFF	TLM DATA INPUT 11	44	J3	EU (622	
43	DET 2 HAKEUP ON/OPP	TLH DATA INPUT 12	45	J3	EU (622	
44	DET 3 MAKEUP ON/OFF	TLM DATA INPUT 13	46	J3	EU (622	
45	DET 4 MAKEUP ON/OFF	TLM DATA INPUT 14	47	33	EU (622	
46	RIU-A SELECTED	TLM DATA INPUT 15	48	J3	EU (622	
47	TLM BILEVEL RTM	TLM REP INPUT 1	49	J3	EU (622	
50	CHASSIS GND	NC			(



THE BOX/CHASSIS MATING/ENGAGING FACE IS SHOWN

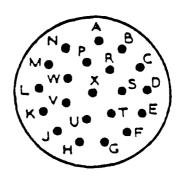
TABLE 2-2-8. OSSE CONNECTOR PIN ASSIGNMENT (Table 3.2.7.2 of TRW-ICD, cont'd)

OSSE/GRO INSTRUMENT INTERFACE PIN CONNECTOR ASSIGNMENTS

ICP (511) | ISU (402)

CONT NO. J6 (2A012-555V-001) OSSE FUNCTION NO. DESCRIPTION NO. CONT. HODULE INSTR PWR (PRIM) INSTR PWR (PRIM) INSTR PWR (PRIM) INSTR PWR (PRIM) +28V QUIET, MAIN +28V QUIET, MAIN +28V QUIET, MAIN +28V QUIET, MAIN +28V QUIET RTN, MAIN INSTR PWR RTM (PRIM) +28V THER, MAIN T/C HTR PWR (PRIM) +28V THER, MAIN T/C HTR PWR (PRIM) +28V THER RTN, MAIN T/C HTR PWR RTN(PRIM) T/C HTR PWR RTN(PRIM) M/U HTR PWR (PRIM) M/U HTR PWR (PRIM) +28V THER RTN, MAIN +28V MAKEUP, MAIN +28V MAKEUP, MAIN +28V MAKEUP RTN, MAIN H/U HTR PWR RTN(PRIM) +28V MAKEUP RTN, MAIN M/U HTR PWR RTN(PRIM) UICB*(102) +28V SHUTTLE OPS STS HTR PWR J02 STS HTR PWR UICB (102) +28V SHUTTLE OPS J02 INSTR PWR (PRIM)
INSTR PWR RTN(PRIM) +28V QUIET, MAIN +28V QUIET, MAIN RTM +28V SHUTTLE OPS RTN STS HTR PWR RTN J02 UICB (102) UICB (102) UICB (102) +28V SHUTTLE OPS RTN STS HTR PHR RTN J02 +28V SHUTTLE OPS RTN STS HTR PWR RTN J02 +28V SHUTTLE OPS STS HTR PWR UICB (102)

NC



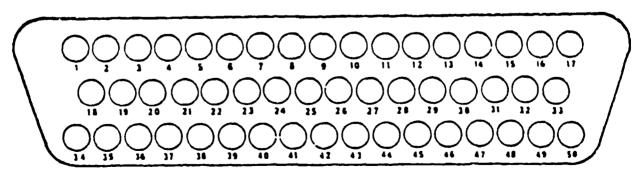
X CHASSIS GND
• UMBILICAL INTERFACE CONNECTOR BRACKET

CHASSIS GND

THE BOX/CHASSIS MATING/ENGAGING FACE IS SHOWN

TABLE 2-2-9. OSSE CONNECTOR PIN ASSIGNMENT (Table 3.2.7.2 of TRW-ICD, cont'd)

CONN NO. J7 (2A014-035V-001) PIN OSSE GRO PIN GRO NO. FUNCTION DESCRIPTION CONN. MODULE. NO. DISC CMD +28V PULSE I +28V PULSE I DET 2 ACTIVE HTR ON DET 4 ACTIVE HTR ON DISCRETE COMMAND 2 J7 DISCRETE COMMAND 4 J7 DET 2 MU HTR ON DET 4 MU HTR ON DISCRETE COMMAND 6 DISCRETE COMMAND 8 J7 J7 8 XPER DET 2 PWR SEL A XPER DET 4 PWR SEL A DISCRETE COMMAND 10 DISCRETE COMMAND 12 34 J7 32 **J**7 MTR DRIVE LAUNCH LOCK OFF DISCRETE COMMAND 14 30 PROC ELECT A ON B OFF DISCRETE COMMAND 16 SIGNAL GND SIGNAL GND CHASSIS GND MOTOR DRIVE REG A ON B OFF DISCRETE COMMAND 18 **J7** DISCRETE COMMAND 20 DISCRETE COMMAND 22 DET 1 MOTOR A SEL B DESEL J7 J7 DET 3 MOTOR A SEL B DESEL DISCRETE COMMAND 24 DISCRETE COMMAND 26 SPARE 49 47 J7 J7 SPARE S/C HU PWR PRIM SEL DISCRETE COMMAND 28 45 **J7** SEL RIUB DISCRETE COMMAND 32 37 PROC ELECT B RESET DISCRETE COMMAND 34 CHASSIS GND NC SIGNAL GND SIGNAL GND J8 DISCRETE COMMAND 36 S/C HTR PWR PRIM DESEL S/C PRI PWR PRIM DESEL J7 DISCRETE COMMAND 38 65 **J7** DET 4 MOTOR B SEL A DESEL DET 2 MOTOR B SEL A DESEL MOTOR DRIVE REG B OFF DISCRETE COMMAND 40 10 JB DISCRETE COMMAND 42 DISCRETE COMMAND 44 JR J8 PROC ELECT B OFF DISCRETE COMMAND 46 DISCRETE COMMAND 48 SPARE JB JA CENT ELECT MU HTR OFF DISCRETE COMMAND 50 43 XFER DET 3 PWR DSEL A DISCRETE COMMAND 52 22 J8 XPER DET 1 PWR DSEL A DET 3 HU RTR OFF DISCRETE COMMAND 54 DISCRETE COMMAND 56 DISCRETE COMMAND 58 JB 45 40 DET 1 HU RTR OFF 46 DISCRETE COMMAND 60 36 JB DET 3 ACTIVE HTR OFF DISCRETE COMMAND 62 J8 DET 1 ACTIVE HTR OFF 49 +28V PULSE I DISC CHD +28V PULSE I



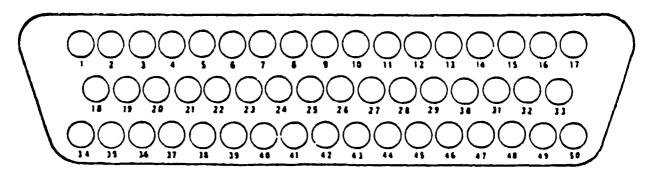
THE BOX/CHASSIS MATING/ENGAGING FACE IS SHOWN

TABLE 2-2-10. OSSE CONNECTOR PIN ASSIGNMENT (Table 3.2.7.2 of TRW-ICD, cont'd)

OSSE/GRO
INSTRUMENT INTERFACE PIN CONNECTOR ASSIGNMENTS

ICP (511) | RIU-B (621)

IN	OSSE	GRO	PIN	GRO	
o.	FUNCTION	DESCRIPTION	NO.	CONN.	MODULI
	OSSE FUNCTION OSSE FUNCTION DISC CMD +28V PULSE II DET 1 ACTIVE HTR CN DET 3 ACTIVE HTR CN DET 3 MU HTR ON DET 3 MU HTR ON XPER DET 1 PWR SEL A XPER DET 1 PWR SEL A CENT ELECT MU HTR ON SPARE SIGNAL GND CHASSIS GND PROC ELECT B ON A OFF MOTOR DRIVE REG B ON A OFF DET 2 MOTOR A SEL B DESEL DET 4 MOTOR A SEL B DESEL DISC CMD +28V PULSE II S/C PRIME PWR PRIM SEL T S/C HTR PWR PRIM SEL PROC ELECT A RESET SEL RIUA SPARE S/C MU PWR PRIM DESEL SPARE DET 3 MOTOR B SEL A DESEL DET 1 MOTOR B SEL A DESEL MOTOR DRIVE REG A OFF PROC ELECT A OFF CHASSIS GND DISC CMD +28V PULSE III MTR DRIVE LAUNCH LOCK ON XPER DET 4 PWR DSEL A XPER DET 2 PWR DSEL A DET 4 MU HTR OFF DET 4 ACTIVE HTR OFF DET 2 ACTIVE HTR OFF DISC CMD +28V PULSE III	+3011 MH CB ++	3.5	••	
,	DESCRIPTION FOR ST	DISCRETE COMMIND I	13	J /	
	DET I ACTIVE HIR ON	DISCRETE COMMAND I	13	37	
	DET 3 ACTIVE BIR ON	DISCRETE COMMAND 5	11	J /	
	DET 1 MU DEB ON	DISCRETE COMMAND 3	-	37	
	ALLO ULK ON	DISCRETE COMMAND /	<i>'</i>	37	
	ALED DEG 3 DPD CEL 7	DISCRETE COMMAND 9	, ,	3 /	
	CERT BITCH HII DED ON	DISCRETE COMMAND II	3.3	37	
	CDADE	DISCRETE COMMAND 13	31	37	
7	SIGNAL CUD	SICUAL CUD	29	J /	
à	CHRESIS CAD	SIGNAL GRO	63	• '	
7	PROC PLECT R ON A OPP	DISCRETE COMMAND 17	27	17	
ī	MOTOR DRIVE REG B ON A OFF	DISCRETE COMMAND 17	2,5	37	
4	DET 2 HOTOR A SPI. B DESET.	DISCRETE COMMAND 11	43	17	
Š	DET A MOTOR A SPI B DESEI	DISCRETE COMMAND 21	52	37	
6	DISC CMD +28V PUT.SE II	478U PITSP 11	11	70	
8	S/C PRIME PWR PRIM SET.	DISCRETE COMMAND 25	40	17	
9	S/C RTR PAR DRIM SFT.	DISCRETE COMMAND 27	46	77	
ń	PROC PIPCT A SPERT	DISCRETE COMMAND 27	44	77	
1	SPI. BILL	DISCRETE COMMAND 11	77	37	
,	CDADE	DISCRETE COMMAND 31	72	37	
i	S/C MII DWR DRIM DPCPT.	DISCRETE COMMAND 35	40	37	
Ā	CDADS	DISCRETE COMMAND 33	66	37	
3	CDADF	DISCRETE COMMAND 37	66	3.7	
6	DPT 3 MOTOR B CPT & DPGPT	DISCRETE COMMAND AT	94	3 /	
Ť	DET 1 MOTOR & SEL A DESEL	DISCRETE COMMAND 41	;	70	
Ŕ	MOTOR DRIVE REG A OFF	DISCRETE COMMAND 45	<u>,</u>	70	
9	PROC FIFCT A OFF	DISCRETE COMMAND 43	3	70	
ó	CHASSIS GND	MC	•	0 0	
1	DISC CAD +28V PUTSP TIT	* ************************************	74	17	
•	WTB DRIVE TAIRCE LOCK ON	DISCRETT COMMAND 49	25	.78	
•	ABAB DEL Y DEB UCAL TOCK ON	DISCRETE COMMAND 51	22	.18	
4	YPPD DFT 7 DWD DCFL 1	DISCRETE COMMAND \$1	21	.18	
~	NEW A MILETE OFF	DISCRETE COMMAND ES	10	.18	
	DET 3 MU DTS ASS	DISCRETE COMMAND 53	10	.19	
7	DEL 4 HU HIR UFF	DISCRETE COMMAND 50	17	.78	
á	DEL 4 ACTIVE BIR OFF	DISCRETE COMMAND 61	37	.19	
0	DICC CMD ADDU DUICE III	ADOM DUTCH TIT	77	.TA	

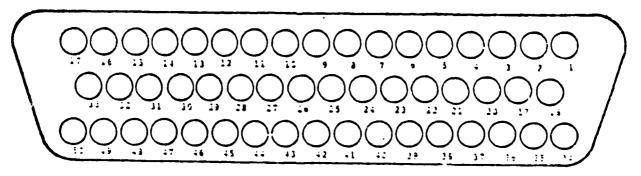


THE BOX/CHASSIS MATING/ENGAGING FACE IS SHOWN

TABLE 2-2-11. OSSE CONNECTOR PIN ASSIGNMENT (Table 3.2.7.2 of TRW-ICD, cont'd)

OSSE/GRO
INSTRUMENT INTERFACE PIN CONNECTOR ASSIGNMENTS

		ICP (511)	RIU-B (621)			
CONN	OSSE FUNCTION TLM ACT ALG RTM PEA +5V CURRENT PEA +10V CURRENT PEA +10V CURRENT PEA +20V CURRENT PEA HICRO CURRENT THE ACT ALG RTM PASS TRANS CURR RTM THE PASS ALG RTM DET 1 XTAL HOUS CRY 2 TE DET 2 XTAL HOUS CRY 2 TE DET 3 XTAL HOUS CRY 2 TE DET 4 XTAL HOUS CRY 2 TE SPARE SPARE SPARE SPARE SPARE TLM PASS ALG RTM THM ACT ALG RTM THE LVPS CURRENT THE ACT ALG RTM SIGNAL GND CRASSIS GND		1		****	
PIN	OSSE		GRO	PIN	GRO	
NO.	FUNCTION		DESCRIPTION	ю.	CONN.	MODULE
1	TLM ACT ALG RTN		TLM REF INPUT 1	49	J6	
2	PEA +5V CURRENT		TLM DATA INPUT 8	41	J6	
3	PEA +10V CURRENT		TLM DATA 9	42	JĢ	
4	PEA -10V CURRENT		TLM DATA INPUT 10	43	J6	
5	PEA +20V CURRENT		TLM DATA INPUT 11	44	J6	
6	PEA HICRO CURRENT		TLM DATA INPUT 12	45	J6	
9	TLM ACT ALG RTN		TLM REF INPUT 1	21	J6	
10	PASS TRANS CURR RTN	_	PASS TRANSDUCER RTN	12	J5	
11	TLM PASS ALG RTN	_	TLM REP INPUT 2	33	J5	
12	DET 1 XTAL HOUS CRY 2 TE	(P	TLM DATA INPUT 16	34	J5	
13	DET 2 XTAL HOUS CRY 2 TE	(P	TLM DATA INPUT 17	35	J5	
14	DET 3 XTAL HOUS CRY 2 TE	(P	TLM DATA INPUT 18	36	J5	
15	DET 4 XTAL HOUS CRY 2 TE	1P	TLM DATA INPUT 19	37	J5	
16	SPARE		TLM DATA INPUT 20	38	J5	
17	SPARE		TLM DATA INPUT 21	39	J5	
18	SPARE		TLM DATA INPUT 22	40	J5	
19	SPARE		TLM DATA INPUT 23	41	J5	
20	TLM PASS ALG RTN		TLM REF INPUT 2	42	J5	
21	TLM PASS ALG RTN		TLM REF INPUT 3	68	J6	
22	OUTER SHELL TEMP		TLM DATA INPUT 24	60	J6	
23	STRUCTURE TEMP 1		TLM DATA INPUT 25	61	J6	
74	STRUCTURE TEMP 2		TLM DATA INPUT 26	62	J6	
27	TLM ACT ALG RTN		TLM REP INPUT 4	10	J6	
28	PEB +5V CURRENT		TLM DATA INPUT 32	11	J6	
29	PEB +10V CURRENT		TLM DATA INPUT 33	12	J6	
30-	PEB -10V CURRENT		TLM DATA INPUT 34	13	J6	
31	PEB +20V CURRENT		TLM DATA INPUT 35	14	J6	
32	PEB HICRO CURRENT		TLM DATA INPUT 36	15	J6	
35	CRASSIS GND		NC			
36	TEM ACT ALG RIN		TLM REP INPUT 4	19	Jί	
37	TLM ACT ALG RTH		TLM REF INPUT 5	30	J6	
36	PEA FUSE MONITOR		TLM DATA INPUT 40	31	J6	
39	PEB FUSE MONITOR		TLM DATA INPUT 41	32	J6	
40	PEA LVPS CURRENT		TLM DATA INPUT 42	33	J6	
41	PEB LVPS CURRENT		TLM DATA INPUT 43	34	J6	
45	TLM ACT ALG RTN		TLM REP INPUT 5	39	J6	
49	SIGNAL GND		SIGNAL GND	3	J5	
50	CRASSIS GND		ИС			
		-				



THE BOX/CHASSIS MATING/ENGAGING FACE IS SHOWN

TABLE 2-2-12. OSSE CONNECTOR PIN ASSIGNMENT (Table 3.2.7.2 of TRW-ICD, cont'd)

OSSE/GRO INSTRUMENT INTERFACE PIN CONNECTOR ASSIGNMENTS

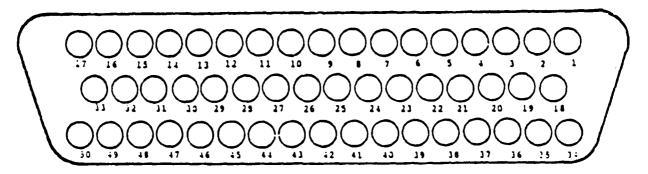
ICP (511) | RIU-B (621)

PIM	OSSE	GRO DESCRIPTION	PIN NO.	GRO CONN.	MODULE
	OSSE PUNCTION SER CMD CLK 1 TRUE SER CMD CLK 2 TRUE SER CMD CLK 2 TRUE SER CMD CLK 3 TRUE SER CMD CLK 3 TRUE SER CMD CLK 3 TRUE SER CMD CLK 4 TRUE SER CMD CLK 4 TRUE SER CMD CLK 4 TRUE SER DATA CLK 1 TRUE SER DATA CLK 1 TRUE SER DATA CLK 1 COMP CHASSIS GND SIGNAL GND HAJOR FRAME RATE SIG 3 1.024 MHZ CLK 2 TRUE 1.024 MHZ CLK 2 TRUE 1.024 MHZ CLK 2 COMP CONDITIONED +5.3V STBY II-3 BATSE TRIG SIG-REDUN SER CMD DATA 1 TRUE SER CMD DATA 2 TRUE SER CMD DATA 2 TRUE SER CMD DATA 3 TRUE SER CMD DATA 3 TRUE SER CMD DATA 4 TRUE SER CMD DATA 4 TRUE SER CMD DATA 4 COMP SER DATA CLK 3 TRUE SER DATA CLK 3 TRUE SER DATA CLK 3 TRUE SER DATA CLK 3 COMP CHASSIS GND SIGNAL GND MAJOR PRAME RATE 4				
1	SER CMD CLK 1 TRUE	SER CMD CLK 1 TRUE	39	J7	
2	SER CHD CLK 1 COMP	SER CHD CLK 1 COMP	38	J7	
3	SER CMD CLK 2 TRUE	SER CHD CLK 2 TRUE	58	J7	
4	SER CHD CLK 2 COMP	SER CHD CLK 2 COMP	57	J7	
5	SER CMD CLK 3 TRUE	SER CMD CLK 3 TRUE	78	J7	
6	SER CMD CLK 3 COMP	SER CHD CLK 3 COMP	77	J7	
7	SER CMD CLK 4 TRUE	SER CHD CLK 4 TRUE	44	J8	
8	SER CMD CLK 4 COMP	SER CHO CLK 4 COMP	43	JB	
9	SER DATA CLK 1 TRUE	SER DATA CLK 1 TRUE	1	J5	
10	SER DATA CLK 1 COMP	SER DATA CLR 1 COMP	2	J5	
11	CRASSIS GND	ис			
12	SIGNAL GND	SIGNAL GND	3	J5 '	
13	MAJOR FRAME RATE SIG 3	HAJOR PRAME RATE 3	60	J7	
14	1.024 MHZ CLK 2 TRUE	1.024 MHZ CLK 2 TRUE	1	JB	
15	1.024 MHZ CLK 2 COMP	1.024 HHZ CLK 2 COMP	17	J8	
16	CONDITIONED +5.3V STBY II-3	+5.3V STBY II-3	44	J5	RIU-A(620)
17	BATSE TRIG SIG-REDUN	BTS-B, RED	22	J45	CEU-B(551)
18	SER CHD DATA 1 TRUE	SER CHD DATA 1 TRUE	37	J7	
19	SER CHO DATA 1 COMP	SER CHD DATA 1 COMP	36	J7	
20	SER CHD DATA 2 TRUE	SER CHD DATA 2 TRUE	56	J7	
21	SER CHD DATA 2 COMP	SER CHD DATA 2 COMP	5.5	J7	
22	SER CHD DATA 3 TRUE	SER CHO DATA 3 TRUE	76	J7	
23	SER CHD DATA 3 COMP	SER CHD DATA 3 COMP	75	J7	
24	SER CHD DATA 4 TRUE	SER CMD DATA 4 TRUE	30	JB	
25	SER CMD DATA 4 COMP	SER CHD DATA 4 COMP	29	J8	
26.	SER DATA CLK 1 TRUE	SER DATA CLK 1 TRUE	3	J6	
27	SER DATA CLE 3 COMP	SER DATA CLK 1 COMP	4	J6	
28	CHASSIS OND	NC	-	- 3	
29	SIGNAL GND	SIGNAL GND	2	J6	
20	MATAR BRANC SAFE A	MAJOR PRIME BATE A	32	JA .	

TABLE 2-2-13. OSSE CONNECTOR PIN ASSIGNMENT (Table 3.2.7.2 of TRW-ICD, cont'd)

OSSE/GRO
INSTRUMENT INTERPACE PIN CONNECTOR ASSIGNMENTS

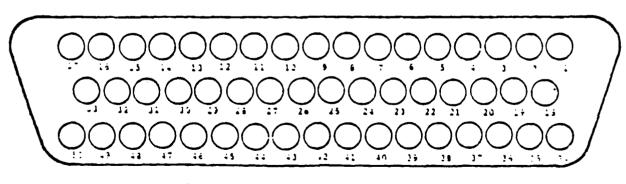
		ICP (511)	 RIU-8 (621)			
CONN	NO. J10 (2A014-040V-001)					
PIN	OSSE		GRO	PIN	GRO	
NO.	FUNCTION		DESCRIPTION	NO.	CONN.	MODULE
31	1.024 MHZ CLK 1 TRUE		1.024 HMZ CLK 1 TRUE	3	J 7	
32	1.024 HRZ CLK 1 COMP		1.024 FMZ CLK 1 COMP		J7	
33	CONDITIONED +5.3V STBY II-2		+5.3V STBY 11-2	43	J\$	
34	BATSE TRIG SIG RTN-REDUN		BTS-B RTN.RED	23	J45	CEU-B(551)
35	SER CHD EN 0 (UTC)		SER CHD ENABLE O (UTC)	20	J7	
36	SER CMD EN 1		SER CMD ENABLE 1	19	J7	
37	SER CHD EN 2		SER CHD ENABLE 2	18	37	
38	SER CMD EN 3		SER CHD ENABLE 3	17	J7	
39	SER CMD EN 4		SER CHO ENABLE 4	16	J7	
40	SER CHD EN S		SER CHD ENABLE 5	15	J7	
41	SER CHD EN 6		SER CHD ENABLE 6	14	JB	
42	SER CHD EN 7		SER CMD ENABLE 7	13	JA	
43	SIGNAL GND		SIGNAL GND	43	J7	
44	TLM DATA I/P 0		TLM DATA INPUT O	20	J5	
45	TLM REP I/P O		TLM REF INPUT O	19	J5	
46	SER/AUX TLM EN O		SER/AUX ENABLE O	4	J5	
47	CONDITIONED +5.3V STBY II-1		+5.3V STBY II-1	32	J5	
48	1 HZ TIMING SIG TRUE, RED		TTU 1.0 HZ, TRUE, RED	63	J105	CADR(601)
49.	1 RZ TIMING SIG COMP, RED		TTU 1.0 HZ, COMP, RED	76	J105	CADH(601)
50	BATSE TRIG SIG SHLD, RED		BTS SHLD.RED	NC		CEU-B(551)



THE BOX/CHASSIS MATING/ENGAGING FACE IS SHOWN

TABLE 2-2-14. OSSE CONNECTOR PIN ASSIGNMENT (Table 3.2.7.2 of TRW-ICD, cont'd)

COMM	NO. J11 (2X014-040V-001)	1			
	ossz	GRO DESCRIPTION	PIN	GRO	MODULE
NO.	FUNCTION	DESCRIPTION	NO.	CONN.	HODULE
		~ ~ ~ ~ ~ ~ ~ ~ ~ ~ ~ ~ ~ ~ ~ ~ ~ ~ ~ ~			
,	TLM ACT ALG RTM DET 1 ACTIVE HTR CURRENT DET 2 ACTIVE HTR CURRENT DET 3 ACTIVE HTR CURRENT DET 4 ACTIVE HTR CURRENT THE ACT ALG RTM THE ACT ALG RTM DET 1 MAKEUP MONITOR DET 2 MAKEUP MONITOR DET 3 MAKEUP MONITOR DET 4 HAKEUP HONITOR THE ACT ALG RTM THE BILEVEL RTM DET 1 ACTIVE HTR ON/OFF DET 2 ACTIVE HTR ON/OFF DET 3 ACTIVE HTR ON/OFF THE BILEVEL RTM THE BILEVEL RTM THE BILEVEL RTM RIU-B SELECTED S/C PRIME PWR-PRIM SELECT S/C MAKEUP PWR-PRIM SELECT TIM BILEVEL RTM THE BILEVEL RTM DET 1 MAKEUP ON/OFF DET 1 MAKEUP ON/OFF DET 3 MAKEUP ON/OFF DET 4 MAKEUP ON/OFF DET 3 MAKEUP ON/OFF DET 3 MAKEUP ON/OFF DET 4 MAKEUP ON/OFF DET 5 MAKEUP ON/OFF DET 6 MAKEUP ON/OFF DET 7 MAKEUP ON/OFF DET 7 MAKEUP ON/OFF DET 8 MAKEUP ON/OFF DET 1 MAKEUP ON/OFF DET 1 MAKEUP ON/OFF DET 3 MAKEUP ON/OFF DET 4 MAKEUP ON/OFF DET 3 MAKEUP ON/OFF	TLM REF INPUT 6	50	J6	
•	DET 1 ACTIVE HTR CURRENT	TLM DATA INPUT 52	55	J6	
i	DET 2 ACTIVE HTR CURRENT	TLM DATA INPUT 53	56	J6	
Ä	DET 3 ACTIVE STR CURRENT	TLM DATA INPUT 54	57	J6	
\$	DET 4 ACTIVE HTR CURRENT	TLM DATA INPUT 55	58	J6	
6	TLM ACT ALG RTN	TLM REF INPUT 6	59	J6	
7	TIM ACT ALG RTN	TLM REP INPUT 7	69	J6	
À	DET 1 MAKEUP MONITOR	TLM DATA INPUT 56	70	J6	
9	DET 2 MAKEUP MONITOR	TLM DATA INPUT 57	71	J6	
ío	DET 3 MAKEUP MONITOR	TLM DATA INPUT 58	72	J6	
11	DET A MAKEUP MONITOR	TLM DATA INPUT 59	73	J6	
12	CE MAKEUP HTR MONITOR	TLM DATA INPUT 60	74	J6	
11	TIM ACT ALG RTN	TLM REF INPUT 7	78	J6	
14	TIM BILEVEL RIN	TLM REF INPUT O	19	J5	ZU (622)
15	DET 1 ACTIVE BTR ON/OFF	TLM DATA INPUT O	20	J5	ZU (622)
16	DET 2 ACTIVE RTR ON/OFF	TLM DATA INPUT 1	21	J5	EU (622)
17	DET 3 ACTIVE HTR ON/OFF	TLM DATA INPUT 2	22	J5	EU (622)
18	DET 4 ACTIVE RTR ON/OFF	TLM DATA INPUT 3	23	J5	EU (622)
23	TIM RILEVEL RTN	TLM REF INPUT O	28	J5	EU (622)
31	TIM BILEVEL RTN	TLM REP INPUT 5	30	J4	EU (622)
32	RIU-B SPLECTED	TLM DATA INPUT 40	31	J4	EU (622)
11	S/C PRIME PWR-PRIM SELECT	TLM DATA INPUT 41	32	J4	EU (622)
15	S/C HTR PWR-PRIM SELECT	TLM DATA INPUT 43	34	J4	EU (622)
16	S/C MAKEUP PWR-PRIM SELECT	TLM DATA INPUT 44	35	J4	EU (622)
37	TIM BILPVEL RTN	TLM REP INPUT 5	39	J4	FU (622)
385	TIM BILEVEL RTN	TLM REF INPUT 1	21	J4	EU (622)
30	PPA ON/OFF	TLM DATA INPUT 8	41	J4	EU (622)
40	PER ON/OFF	TLM DATA INPUT 9	42	J4	ZU (622)
41	CP HAKPUP ON/OFF	TLM DATA INPUT 10	43	J4	EU (622)
42	DET 1 MAKEUP ON/OFF	TLM DATA INPUT 11	44	J4	EU (622)
41	DET 2 MAKEUP ON/OFF	TLM DATA INPUT 12	45	J4	EU (622)
44	DET 3 MAKEUP ON/OFF	TLH DATA INPUT 13	46	J4	EU (622)
45	DET 4 MAKEUP ON/OFF	TLM DATA INPUT 14	47	J4	EU (622)
46	RID-A SELECTED	TLM DATA INPUT 15	48	J4	EU (622)
47	TIM RILEVEL RIN	TLM REF INPUT 1	49	J4	EU (622)
4,	CHICALD NIC	#C			



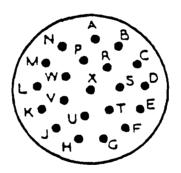
THE BOX/CHASSIS MATING/ENGAGING FACE IS SHOWN

TABLE 2-2-15. OSSE CONNECTOR PIN ASSIGNMENT (Table 3.2.7.2 of TRW-ICD, cont'd)

OBSE/GRO
INSTRUMENT INTERPACE PIN CONNECTOR ASSIGNMENTS

ICP (511) | ISU (402)

A +28V QUIET, RED INSTR PWR (RED) B +28V QUIET, RED INSTR PWR (RED) C +28V QUIET RTN, RED INSTR PWR RTN (RED) D +28V QUIET RTN, RED INSTR PWR RTN (RED) E +29V THER, RED T/C HTR PWR (RED) F +28V THER, RED T/C HTR PWR (RED) G +29V THER RTN, RED T/C HTR PWR RTN(RED) H +28V THER RTN, RED T/C HTR PWR RTN(RED) J +28V MAKEUP, RED T/C HTR PWR RTN(RED) K +28V MAKEUP, RED M/U HTR PWR (RED) L +28V MAKEUP RTN, RED M/U HTR PWR RTN(RED) H +28V MAKEUP RTN, RED M/U HTR PWR RTN(RED) M +28V QUIET, RED INSTR PWR RTN(RED) S +28V QUIET RED INSTR PWR RTN(RED) 1 +28V QUIET RED INSTR PWR RTN(RED) 1 +28V QUIET RED INSTR PWR RTN(RED) 1 +28V QUIET RED INSTR PWR RTN(RED)	CONN	NO. J12 (2A012-555V-001)	1			
A +28V QUIET, RED INSTR PWR (RED) B +28V QUIET, RED INSTR PWR (RED) C +28V QUIET RTN, RED INSTR PWR RTN (RED) D +28V QUIET RTN, RED INSTR PWR RTN (RED) E +29V THER, RED T/C HTR PWR (RED) G +29V THER RTN, RED T/C HTR PWR RTN(RED) H +28V THER RTN, RED T/C HTR PWR RTN(RED) J +28V MAKEUP, RED T/C HTR PWR RTN(RED) K +28V MAKEUP, RED M/U HTR PWR (RED) L +28V MAKEUP RTN, RED M/U HTR PWR RTN(RED) H +28V MAKEUP RTN, RED M/U HTR PWR RTN(RED) H +28V MAKEUP RTN, RED M/U HTR PWR RTN(RED) H +28V QUIET, RED INSTR PWR RTN(RED) S +28V QUIET RTN, RED INSTR PWR RTN(RED) 1 +28V QUIET RTN, RED INSTR PWR RTN(RED) 1 +28V QUIET RTN, RED INSTR PWR RTN(RED) 1 +28V QUIET RTN, RED INSTR PWR RTN(RED)	PIM	ossz	GRO	PIN	GRO	
A +28V QUIET, RED INSTR PWR (RED) B +28V QUIET, RED INSTR PWR (RED) C +28V QUIET RTN, RED INSTR PWR RTN (RED) D +28V QUIET RTN, RED INSTR PWR RTN (RED) E +28V THER, RED T/C HTR PWR (RED) G +28V THER, RED T/C HTR PWR RTN(RED) H +28V THER RTN, RED T/C HTR PWR RTN(RED) H +28V THER RTN, RED T/C HTR PWR RTN(RED) J +28V MAKEUP, RED T/C HTR PWR RTN(RED) K +28V MAKEUP, RED M/U HTR PWR (RED) L +28V MAKEUP RTN, RED M/U HTR PWR RTN(RED) H +28V MAKEUP RTN, RED M/U HTR PWR RTN(RED) H +28V MAKEUP RTN, RED M/U HTR PWR RTN(RED) H +28V QUIET, RED INSTR PWR RTN(RED) S +28V QUIET RTN, RED INSTR PWR RTN(RED)	RO.	FUNCTION	DESCRIPTION	NO.	CONN.	MODULE
### ### ### ### ### ### ### ### ### ##			******			
C +28V QUIET RTN, RED INSTR PWR RTN (RED) D +28V QUIET RTN, RED INSTR PWR RTN (RED) E +29V THER, RED T/C HTR PWR (RED) F +28V THER, RED T/C HTR PWR (RED) G +29V THER RTN, RED T/C HTR PWR RTN (RED) H +28V THER RTN, RED T/C HTR PWR RTN (RED) J +28V MAKEUP, RED M/U HTR PWR (RED) K +28V MAKEUP, RED M/U HTR PWR (RED) L +28V MAKEUP RTN, RED M/U HTR PWR RTN (RED) H +28V MAKEUP RTN, RED M/U HTR PWR RTN (RED) H +28V MAKEUP RTN, RED M/U HTR PWR RTN (RED) H +28V QUIET RED INSTR PWR RTN (RED) S +28V QUIET RTN, RED INSTR PWR RTN (RED) H +28V QUIET RTN, RED INSTR PWR RTN (RED)	A	+28V QUIET, RED	INSTR PWR (RED)			
D +28V QUIET RTN, RED INSTR PMR RTN (RED) E +28V THER, RED T/C HTR PMR (RED) F +28V THER, RED T/C HTR PMR (RED) G +29V THER RTN, RED T/C HTR PMR RTN(RED) H +28V THER RTN, RED T/C HTR PMR RTN(RED) J +28V MAKEUP, RED M/U HTR PMR (RED) K +28V MAKEUP, RED M/U HTR PMR (RED) L +28V MAKEUP RTN, RED M/U HTR PMR RTN(RED) H +28V MAKEUP RTN, RED M/U HTR PMR RTN(RED) H +28V MAKEUP RTN, RED M/U HTR PMR RTN(RED) R +28V QUIET, RED INSTR PMR (RED) S +28V QUIET RTN, RED INSTR PMR RTN(RED)	8	+28V QUIET, RED	INSTR PWR (RED)			
E +28V THER, RED T/C HTR PWR (RED) F +28V THER RED T/C HTR PWR (RED) G +29V THER RTN, RED T/C HTR PWR RTN(RED) H +28V THER RTN, RED T/C HTR PWR RTN(RED) J +28V MAKEUP, RED M/U HTR PWR (RED) K +28V MAKEUP, RED M/U HTR PWR (RED) L +28V MAKEUP, RED M/U HTR PWR RTN(RED) H +28V MAKEUP RTN, RED M/U HTR PWR RTN(RED) H +28V MAKEUP RTN, RED M/U HTR PWR RTN(RED) H +28V QUIET, RED INSTR PWR (RED) S +28V QUIET RTN, RED INSTR PWR RTN(RED) 1 HSTR PWR RTN(RED) 1 HSTR PWR RTN(RED)	C	+28V QUIET RTN, RED	INSTR PWR RTN (RED)			
### ### ### ### ### #### ### ### ### #	D	+28V QUIET RTN, RED	INSTR PWR RTH (RED)			
G +29V THER RTN, RED T/C HTR PWR RTN(RED) B +28V THER RTN, RED T/C HTR PWR RTN(RED) J +28V MAKEUP, RED M/U HTR PWR (RED) K +28V MAKEUP, RED M/U HTR PWR (RED) L +28V MAKEUP RTN, RED M/U HTR PWR RTN(RED) H +28V MAKEUP RTN, RED M/U HTR PWR RTN(RED) R +28V QUIET, RED INSTR PWR (RED) S +28V QUIET RTM, RED INSTR PWR RTN(RED)	E	+28V THER, RED	T/C HTR PWR (RED)			
## +28V THER RTN, RED	r	+28V THER, RED	T/C HTR PWR (RED)			
J +28V MAKEUP, RED	G	+29V THER RTN, RED	T/C HTR PWR RTN(RED)			
K +28V MAKEUP, RZD M/U HTR PWR (RZD) L +28V MAKEUP RTN, RED M/U HTR PWR RTN(RED) H +28V MAKEUP RTN, RED M/U HTR PWR RTN(RED) R +28V QUIET, RED INSTR PWR (RED) 5 +28V QUIET RTN, RED INSTR PWR RTN(RED)	Ħ	+28V THER RTH, RED	T/C HTR PWR RTN(RED)			
L +28V MAKEUP RTN, RED M/U HTR PWR RTN(RED) M +28V MAKEUP RTN, RED M/U HTR PWR RTN(RED) R +28V QUIET, RED INSTR PWR(RED) 8 +28V QUIET RTN, RED INSTR PWR RTN(RED)	J	+28V MAKEUP, RED	M/U HTR PWR (RED)			
M +28V MAKEUP RTN, RED M/U HTR PWR RTN(RED) R +28V QUIET, RED INSTR PWR(RED) S +28V QUIET RTN, RED INSTR PWR RTN(RED)	ĸ	+28V MAKEUP, FZD	H/U HTR PWR (RED)			
R +28V QUIET, RED INSTR PWR(RED) S +28V QUIET RTH, RED INSTR PWR RTH(RED)	L	+28V MAKEUP RTN, RED	M/U HTR PWR RTN(RED)			
S +28V QUIET RTM, RED INSTR PWR RTM(RED)	Ħ	+28V MAKEUP RTN, RED	M/U RTR PWR RTN(RED)			
	R	+28V QUIET, RED	INSTR PWR(RED)			
Y CHASSIS GND MC	5	+28V QUIET RTH, RED	INSTR PWR RTH(RED)			
to discount to	X	CHASSIS GND	RC .			



THE BOX/CHASSIS MATING/ENGAGING FACE IS SHOWN

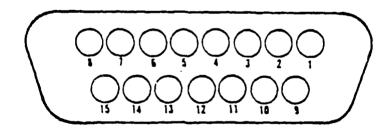
TABLE 2-2-16. OSSE CONNECTOR PIN ASSIGNMENT (Table 3.2.7.2 of TRW-ICD, cont'd)

OSSE/GRO INSTRUMENT INTERFACE PIE CONNECTOR ASSIGNMENTS

ICP (511) | IFJ

COMM NO. JI3	(2A014-037V-001)	[(2A014-032V-001)

PIN PO.	OSSE FUNCTION	Gro Description	PIN	200
	FORCITON	DESCRIPTION	NO.	REMARKS
	~ <u>~</u>	***********		~~~~
1	DET 1 HEATER POWER	THRMST OUTPUT FOR DET 1 STS HTR	1	CONN TO PIN 6
2	DET 2 HEATER POWER	THRMST OUTPUT POR DET 2 STS HTR	2	CONN TO PIE 7
3	DET 3 REATER POWER	THRMST OUTPUT FOR DET 3 STS HTR	3	COMN TO PIN 8
4	DET 4 HEATER POWER	THRMST OUTPUT POR DET 4 STS HTR	. 4	CONN TO PIN 9
5	CE HEATER POWER	THRMST OUTPUT FOR CZ STS HTR	5	CONN TO PIN 10
6	DET 1 HEATER	PWR INPUT TO DET 1 STS RTR	6	CONN TO PIN 1
7	DET 2 REATER	PWR INPUT TO DET 2 STS HTR	7	CONN TO PIN 2
8	DET 3 HEATER	PWR INPUT TO DET 3 STS RTR	8	CONN TO PIN 3
9	DET 4 HEATER	PWR INPUT TO DET 4 STS RTR	9	CONN TO PIN 4
10	CE REATER	PWR INPUT TO CE STS HTR	10	CONN TO PIN 5
11	HEATER RETURN	STS HTR PWR RTN		
12	HEATER RETURN	STS HTR PWR RTN		
13	HEATER RETURN	STS HTR PWR RTM		
14	SPARE .	WC		
15	CHASSIS GND	RC		



THE BOX/CHASSIS MATING/ENGAGING FACE IS SHOWN

2.2 OSSE COMMAND AND TELEMETRY LISTS

The OSSE Command and Telemetry lists are provided, using the OSSE COMMAND AND TELEMETRY DOCUMENT, No. 0926-001 Rev G (released 25-Mar-87), in Appendix 2.

2.3 OSSE PMT TUBE NUMBERING SYSTEM

The photomultiplier tube numbering system is shown on Figures 2.1 through 2.4. The following tubes have not been identified by BASD, since assembly and installation took place at Bicron Manufacturing and the information is not available at this time::

Detector A3 (150001-503): Phoswich Position: A27
A28
A29
A30
A31
A32
A33

All PMT's on Detectors A1, A2, and A4 are identified.

FIGURE 2-1. DETECTOR A1 PMT IDENTIFICATION

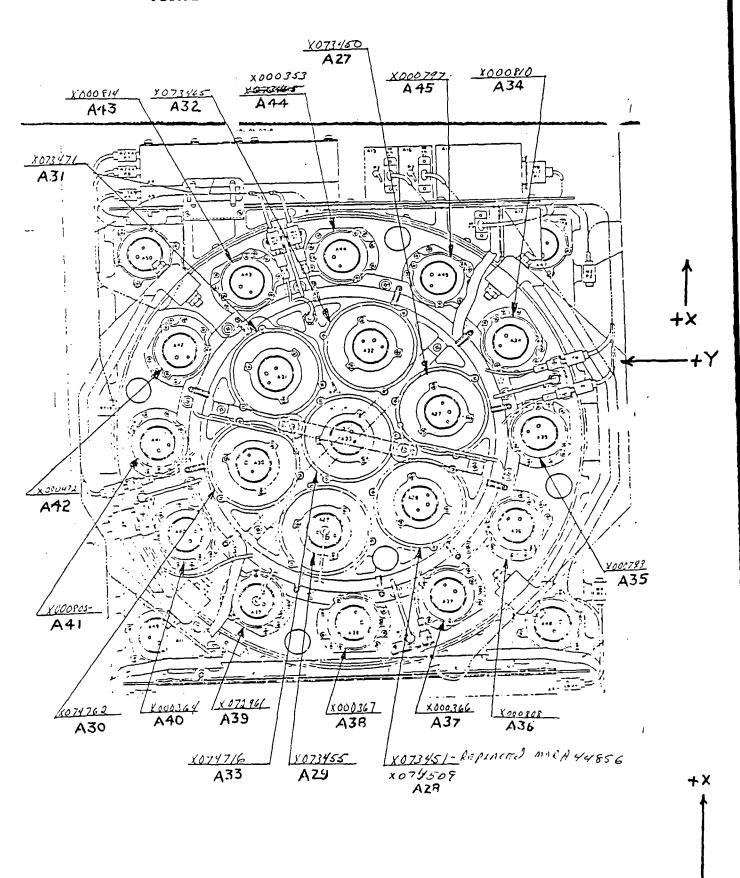


FIGURE 2-2. DETECTOR A2 PMT IDENTIFICATION

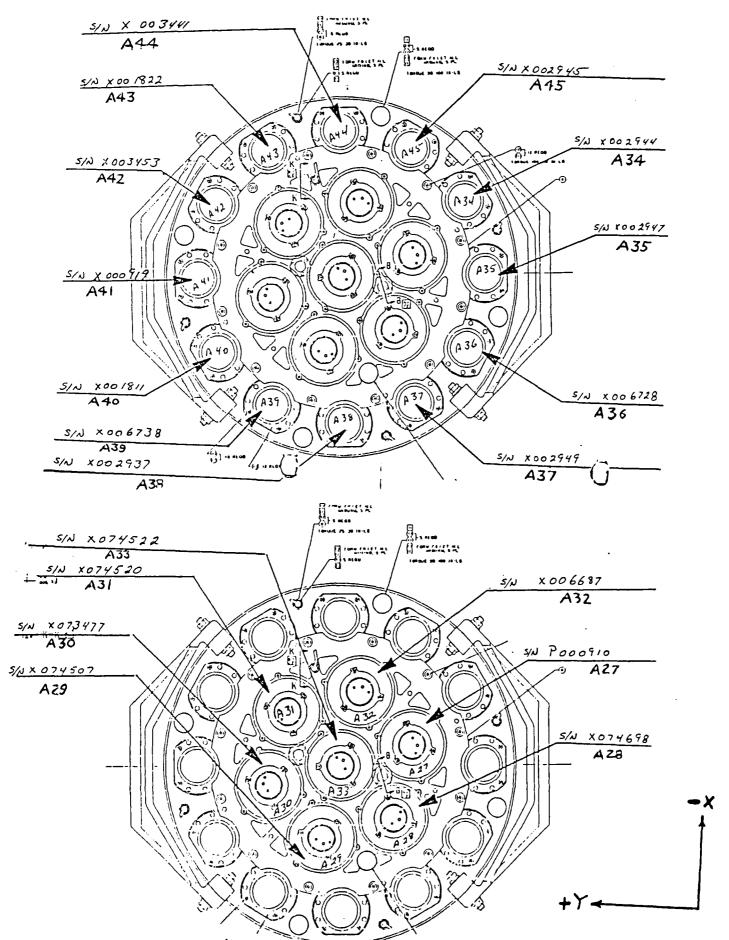
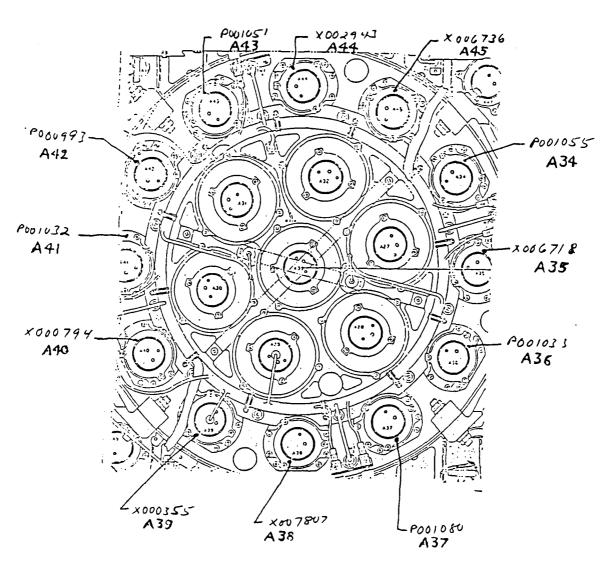


FIGURE 2-3. DETECTOR A3 PMT IDENTIFICATION



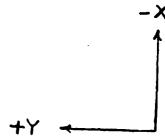
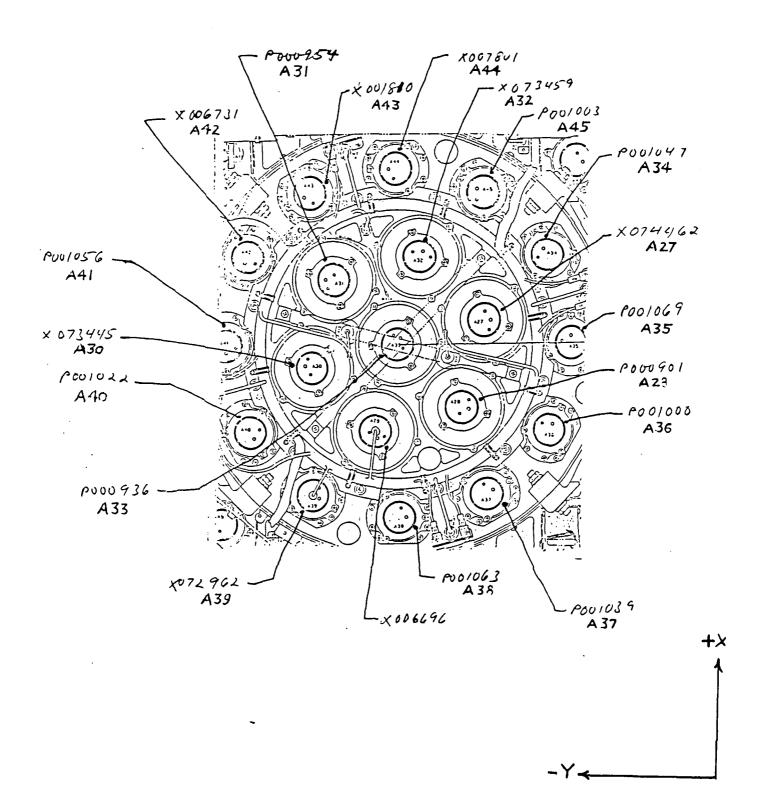


FIGURE 2-4. DETECTOR A4 PMT IDENTIFICATION



2.4 OSSE DETECTOR NUMBERING SYSTEM

The four detectors are numbered according to their position on the X-Y plane defined by the OSSE coordinate system, with X=0 and Y=0 defined as the geometric center of the instrument. The prefix 'A' is assigned to each Detector subsystem*, and the numbers 1 through 4 denote the detector by position on the structure as follows:

```
Detector A1 is located in the -X,-Y quadrant.
Detector A2 is located in the -X,+Y quadrant.
Detector A3 is located in the +X,-Y quadrant.
Detector A4 is located in the +X,+Y quadrant.
```

* The prefix 'A' is also assigned to detector-mounted electronics board identification system. For example, there are boards identified as A1, A2, A3, A4, A5, through A10. However, the two entities are so different in scale that there should be no confusion as to which item is under discussion.

There was a time when detector subsystems were referred to as DE1, DE2, DE3, and DE4. This was during the building and testing phase prior to full assembly and prior to the detectors being installed on the OSSE structure. Being redesignated 'A' from 'DE' made the detectors position-specific on the OSSE structure, and the equivalency of 'DE' and 'A' is as follows:

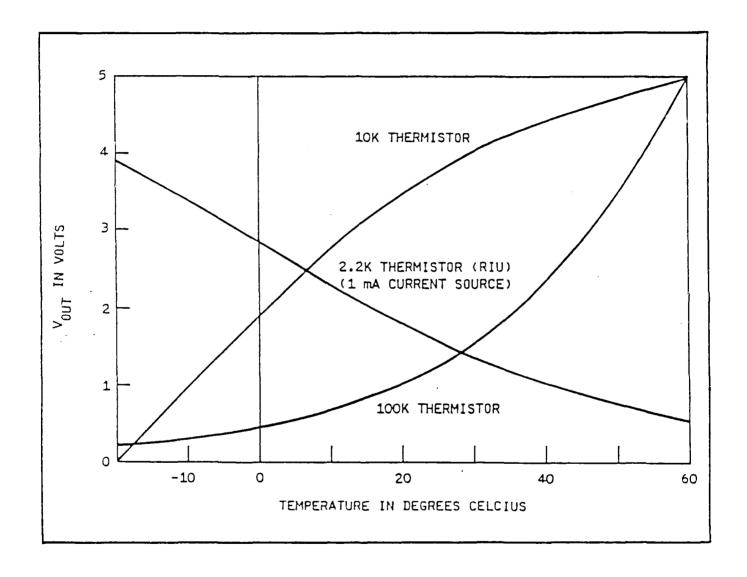
```
DE2 became Detector A1 (Part No. 150010-1)
DE1 became Detector A2 (Part No. 150010-501)
DE4 became Detector A3 (Part No. 150010-503)
DE3 became Detector A4 (Part No. 150001-505)
```

The 'DE' designator should no longer be used when referring to OSSE detectors. However, the prefix has occasionally been inadvertantly used on some documentation, after top-level integration, to denote detector postion on the structure (i.e., DE1=A1, DE2=A2, DE3=A3, DE4=A4). This would not be in keeping with the above-mentioned position relationship, but generally speaking, the 'DE' designator for unmounted detector subsystems was as indicated above, and applied to the pre-integration period of fabrication.

2.5 THERMISTOR CALIBRATION CURVES

Figure 2.5 is the thermistor calibration curve for the three types of thermistors used on OSSE. Of these, the 100K thermistor type accounts for the large majority, the 10K for only one (on the A3 detector board), and the 2.2K for those few that are read by the RIU only.

FIGURE 2-5. DETECTOR TEMPERATURE SENSORS (Fig 3-30 of EXO56-007A)



PART 3 MEASUREMENT AND TEST DATA

3.1 HOUSEKEEPING VALUES

Taken during the OSSE Instrument Calibration test period, Tables 3-1 through 3-11 show the thirty one (31) pages of OSSE status, beginning with the MENU, page O1. Reference to Appendix 2, the OSSE COMMAND AND TELEMETRY DOCUMENT No. 0926-001 Rev G (NRL) should provide an understanding of what is going on inside of OSSE.

TABLE 3-1. VIDEO MONITOR PAGES 01, 02, 03

7m27-JUI:-1	987 12:39:3	1.16 IGSE	USERS =	1 FLT	AUTO - Col	11	MENU PROI
7mTLMID: 16	PKTCT: 1	PSTAT:6D80	PKTMS:	1244 TMAFO	:4BDD FMO	DE:04	SRCCT: 33353
7mArch: TI	M IDL	Time: 8.22	2 hrs P	artitions:	3 Globals:	1609	20-MAY-87
MENU	01	BIL	EVELS 16		PE_A	NA2 3	1
PHOSWICH	02	PE_	ANA 17		PE_A	NA3 3	2
CO_60	03	RIU	_PE 18		free	3	3
free	04	AGC	SYS4 19		DE1_	2PWR 3	4
AGCSYS	05	SYS	PUL 20		VOPP	3	5
ANTICOIN	06	PHO	S_1 21		FLTA	UTO 3	6
GSH	07	PHO	S_2 22		free	3	17
free	08	PHO	S_3 23		free	3	8
RATES	09	РНО	S_4 24		free	3	39
PE_STAT	10	DRI	VECAL 25		free	4	10
POSITION	11	fre	e 26		free	4	1
MD_CAL	12	fre	e 27		C060	4	2
PCU_BLVL	13	fre	e 28		SHIE	LDS 4	4 3
SLOT	14	fre	e 29		free	4	4.4
RIU_DE	15	PE_	ANA1 30		free		45

7m27-JUL-19	87 12:54	4:20.54	IGSE USERS	= 1	FLTAUTO	- Col 11	PHOSWICE	1 Pg02
7mTLMID:16	PKTCT:	3 PSTAT	:7F80 PKTM	S:0D04	TMAFC: 4D8F	FMODE:04	TRCCT:	33787
7mArch: TLM	IDL	Time:	7.958 hrs	Partiti	ons: 3 Glo	bals: 1609	20-MAY-8	37
*HVP1\$A1	0.5	V	*HVP6\$A1	0.0	v	PINON\$B1	off	
*HVP2\$A1	0.5	v	*HVP7\$A1	0.5	ν	PIN\$A1	5227.8	mv
*HVP3\$A1	0.0	v				AGCRA\$B1	1000	
*HVP4\$A1	0.0	v	LEDON\$B1	off		AGCPS\$B1	normal	
*HVP5\$A1	0.5	v	LED\$A1	3460.7	mv			
						PHGL\$B1	high	
ELDL\$A1	78.1	mv	ELDM\$A1	80.6	mv	ELDH\$A1	80.6	mv
TLDL\$A1	96.5	mν	TLDM\$A1	100.1	mv	TLDH\$A1	98.9	mv
TUDL\$A1	4912.1	mv	TUDM\$A1	4902.3	mv	TUDH\$A1	4912.1	mv
ELDL\$R1	1006.23	cs	ELDM\$R1	960.08	CS	ELDH\$R1	0.00	cs
EUDL\$R1	79.47	cs	EUDM\$R1	0.00	CS	EUDH\$R1	0.00	cs
ATWL\$R1	936.52	cs	ATWM\$R1	960.21	CS	ATWH\$R1	0.00	c s
TUDL\$R1	0.00	C S	TUDM\$R1	0.00	CS	TUDH\$R1	0.00	cs
MLL\$R1	914.43	cs	MLM\$R1	960.21	СS	MLH\$R1	0.00	CS
DTL\$R1	1.79	z	DTM\$R1	1.25	Z	DTH\$R1	0.00	Z

7m27-JUI198	37 12:5	5:1	0.97	IGSE	USERS	= 1	FL	ΓAU	TO -	Col	11	CO 60)	Pg03
7mTLMID:16	PKTCT:	3	PSTAT	:7F80	PKTM	S:11C4	TMAF	C:4	DA 7	FMOI	DE:04			33811
7mArch: TLM	IDL		Time:	7.944	hrs	Partiti	ons:	3	Globa	1s:	1609			
CLAD\$B1	low			C6AQ	\$B1	on								
CLLDŞAL	59.8	mv		C6LD	\$A1	89.0	mv							
				C6LD	\$R1	0.	CS							
CLONE\$B1	on			VC6\$	B 1	on								
CLOVE\$B1	on			HVS3	\$B1	off								
				*HVS3	\$A1	0.0	v							

TABLE 3-2. VIDEO MONITOR PAGES 05, 06, 07

7m27-JUL-198	37 12:56	5:18.97	IGSE USERS	= 1FL	TAUTO - Col 11	AGCSYS Pg05
7mTLMID:16	PKTCT:	1 PSTAT	:7F80 PKTM	S:0644 TMAF	C:4DC9 FMODE:04	SRCCT: 33845
7mArch: TLM	IDL _	Time:	7.925 hrs	Partitions:	3 Globals: 1609	20-MAY-87
*HVP1\$A1	0.5	v	AGCP1\$B1	off	AGCT2\$S	79026C Hex
*HVP2\$A1	0.5	v ·	AGCP2\$B1	off	AGCT3\$S	7A02DD Hex
*HVP3\$A1	0.5	v	AGCP3\$B1	off	AGCT4\$S	7B0290 Hex
*HVP4\$A1	0.0	v	AGCP4\$B1	off	AGCT5\$S	7C024B Hex
*HVP5\$A1	0.5	v	AGCP5\$B1	off	AGCT6\$S	7D02EF Hex
*HVP6\$A1	0.0	v	AGCP6\$B1	off	AGCT7\$S	7E01EC Hex
*HVP7\$A1	0.0	v	AGCP7\$B1	off	ANATA\$S	2900 Hex
LEDON\$B1	off		PINON\$B1	off		
LED\$A1	3460.7	mν	PIN\$A1	5227.8 mv		
VRPH\$B2	anti		AGCRA\$B1	1000	CLAD\$B1	low
			AGCON\$B1	off		
			AGCPS\$B1	normal		

7m27-JUL-198	37 12:56	:57.47	IGSE USERS	S = 1	FLTAU	JTO - Col 11	ANTICOIN	Pg 06
7mTLMID:16	PKTCT:				IMAFC:	DDB FMODE:04	SRCCT:	33863
7mArch: TLM	IDL	Time:	7.913 hrs	Partitio	ons: 3	Globals: 1609	20-MAY-8	7
S1LD\$A1	59.8	mv	S1LD\$R1	0.00	CS	VS1LD\$B2	off	
S2LD\$A1	59.2	mv	S2LD\$R1	0.00	cs	VS2LD\$B2	off	
S3LD\$A1	59.8	mv .	S3LD\$R1	0.00	cs	VS3LD\$B2	off	
S4LD\$A1	59.8	mv	S4LD\$R1	0.00	CS.	VS4LD\$B2	off	
CPD\$A1	79.4	mv	CPD\$R1	0.00	CS	VCPD\$B1	on	
C6LD\$A1	89.0	mv	C6LD\$R1	0.	C S	VC6\$B1	on	
			SMD\$R1	0.00	C S	VSMD\$B2	off	
			SUD\$R1	0.00	C S	VSUD\$B2	off	
						VOPP\$B2	off	
HVS1\$B1	off		*HVS1\$A1	0.0	v			
HVS2\$B1	off		*HVS2\$A1	0.5	v			
HVS3\$B1	off		*HVS3\$A1	0.0	v			
						CLAD\$B1	low	
						CLLR\$B1	remote	
						CLLD\$A1	61.0	mν

7m27-JUL-19	87 13:12:	22.97 IGSE US	SERS = 1	FLTAUTO	- Col 11	GSH Pg 07
7mTLMID:16	PKTCT: 3		KTMS: 17C4	TMAFC: 4F9	F FMODE:04	SRCCT: 34315
7mArch: TLM	IDL	Time: 7.644 h	rs Partit	ions: 3 Gl	obals: 1609	20-MAY-87
SRCIDSP	103	UTC\$P	*****	r *		
MISID\$P	136	POSX\$P	•	0		
SRCCT\$P	34315	POSY\$P		0		
PKTLT\$P	255	POSZ\$F	P	0		
		GEOAZS	P	0		
SCHDR\$P	255	GEOELS	P	0		
SRCP\$P	46599	ATTZRS	\$P	0		
		ATTZDS	\$P	0		
		ATTXRS	\$P	0		
		ATTXD	SP	0		

		m. D. D. O	A WINDO WON	TTOD BACES OO	10 11		
7m27-JUL-19	87 13:13		IGSE USERS	ITOR PAGES 09 = 1 FLT	, 10, 11 AUTO - Col 11	RATES	Pg 09
7mTLMID:16		4 PSTA			:4FB8 FMODE:04	SRCCT:	
7mArch: TLM		Time:			3 Globals: 1609	20-MAY-8	3 7
FDET1\$P	0080	Hex	FDET2\$P	0080 Hex	PSTAT\$P	7F80	
FDET3\$P	0080	Hex	FDET4\$P	0080 Hex	CPMEL\$R	0000	Hex
CAUTHSP	138		BAUTH\$P	10	CPMPR\$R	0000	Hex
ELDL\$R1	998.05	C S	ELDM\$R1	906.86 cs	ELDH\$R1	0.00	cs
MLL\$R1	950.44	cs	MLM\$R1	906.86 cs	MLH\$R1	0.00	cs
DTL\$R1	1.62	Z	DTM\$R1	1.17 Z	DTH\$R1	0.00	Z
ELDL\$R2	1000.12	cs	ELDM\$R2	904.05 cs	ELDH\$R2	0.00	
MLL\$R2	961.67	cs	MLM\$R2	904.05 cs	MLH\$R2	0.00	cs
DTL\$R2	1.61	Z	DTM\$R2	1.17 %	DTH\$R2	0.00	
ELDL\$R3	989.14	CS	ELDM\$R3	895.02 cs	ELDH\$R3	0.00	
MLL\$R3	950.56	C S	MLM\$R3	895.02 cs	MLH\$R3	0.00	
DTL\$R3	1.61	Z	DTM\$R3	1.18 %	DTH\$R3	0.00	
ELDL\$R4	985.35	CS	ELDM\$R4	895.14 cs	ELDH\$R4	0.00	
MLL\$R4	935.67	CS	MLM\$R4	895.14 cs	MLH\$R4	0.00	
DTL\$R4	1.63	Z	DTM\$R4	1.17 %	DTH\$R4	0.00	Z
7m27-JUL-19	987 <u>13:</u> 1	3:48.73	IGSE USERS	S = 1 FL	TAUTO - Col 11	PE STAT	' Pg 10
7mTLMID:16	PKTCT:	1 PST	AT: 7F80 PKTN	1S:1844 TMAF	C:4FC9 FMODE:04	SRCCT:	34357
7mArch: TLN	4 IDL	Time	: 7.620 hrs	Partitions:	3 Globals: 1609	20-MAY-	87
FMODESP	0004	Hex	CAUTH\$P	138	PSTAT\$P	7F80	Hex
FSTAT\$P	0000	Hex	CMREJ\$P	0			
FERR\$P	0000	Hex	BAUTH\$P	10	CALIB\$B	on	l
•			BCREJ\$P	0	BURST\$B	on	1
FDFT1 ¢D	0080	How	MEMERCE	0	P D H A 2 C B	Or	•

7mTLMID:16	PKTCT:	1 DSTAT	:7F80	DVTM	S:1844 '	IMAFC:	/ FCQ	FMOD	F • 0 /s	SRCCT:	34357
7mArch: TLM	IDL	Time:	7.620	hrs	Partitio	ons: .	610	<u>als:</u>		20-MAY-	3 /
FMODE\$P	0004	Hex	CAUTH	(\$P	138			PSTAT	\$P	7F80	Hex
FSTAT\$P	0000	Hex	CMREJ	\$P	0						
FERR\$P	0000	Hex	BAUTH	I\$P	10			CALIB	\$B	on	
			BCREJ	I\$P	0			BURST	\$B	on	
FDET1\$P	0080	Hex	MEMER	L\$P	0			RPHA2	\$B	on	
FDET2\$P	0080	Hex						RPHA1	\$B	on	
FDET3\$P	0080	Hex	CPMEL	\$R	0000	Hex		MDCAL	\$B	on	
FDET4\$P	0080	Hex	CPMPF	R\$R	0000	Hex		MDPOS	\$B	on	
DPTBL\$P	prim		CPSAA	\\$B	no			AGC\$B		on	
DPMOD\$B	norm		HVCPN	1\$B	on			C060\$	В	on	
DPDLY\$B	no		HVCPN	1\$A	799.8	v		PULSR	\$B	off	
			*CPMR	SA.	-64.9	mv					
BURAC\$B	no		CPMT	I\$P	0100	Нех		PULSM	\$P	inactive	
SBURS\$B	no		CPMCT	Γ\$P	4			PULST	\$P	0000	Hex
CKR\$P	44849										

7m27-JUL-198	7 12.1/	29 2/	IGSE USERS	_ 1	FITA	UTO - Col 11	POSITION	Pg 11
7mTLMID:16	PKTCT:	4 PSTAT			TMAFC:			376
7mArch: TLM		Time:	7.608 hrs	Partiti		Globals: 1609	20-MAY-87	
DPTBL\$P	prim		MODE\$P	science	_	SPRI\$B	on	
DPMOD\$B	norm		PSTAT\$P	7F80	Hex	SSEC\$B	off	
DPDLY\$B	no		MDCAL\$B	on		SSUN\$B	off	
			MDPC\$\$B	on		STRAN\$B	off	
FDET1\$P	0080	Hex						
FDET2\$P	0080	Hex	CAUTH\$P	138		CMREJ\$P	0	
FDET3\$P	0080	Hex	BAUTH\$P	10		BCREJ\$P	0	
FDET4\$P	0800	Hex						
			DEMGS\$P	9999	Hex			
D1SA\$P	1627		A1M\$A	6849.7	mν	A1R\$A	6849.7 mv	
D2SA\$P	1627		A2M\$A	6743.8	mv	A2R\$A	6747.2 mv	
D3SA\$P	1612		A3M\$A	6863.4	mv	A3R\$A	6863.4 mv	
D4SA\$P	1612		A4M\$A	6801.9	mv	A4R\$A	6795.0 mv	

TABLE 3-4. VIDEO MONITOR PAGES 12, 13, 14

7m27-JUL-19	987 13:14	4:54.11	IGSE USERS	= 1	FLTAU	TO - Col 11	MD CAL_	Pg 12
7mTLMID:16	PKTCT:	1 PSTAT	:7F80 PKTM	S:09C4 1	MAFC: 4	FE9 FMODE:04	SRCCT:	34389
7mArch: TL	1 IDL	Time:	7.601 hrs	Partitio	ons: 3	Globals: 1609	20-MAY-8	7
FMODE\$P	0004	Hex	FDET1\$P	0080	Hex	FDET2\$P	0080	Hex
PSTAT\$P	7F80	Hex	FDET3\$P	0080	Hex	FDET4\$P	0080	Hex
DEMGS\$P	9999	Hex	CAUTH\$P	138		BAUTH\$P	10	
MDCRF1\$A	-7000.0	mv	ASE1\$P	0		MDCJS1\$P	0000	Hex
MDCRF2\$A	-7000.0	mv	ASE2\$P	0		MDCJS2\$P	0000	Hex
MDCRF3\$A	-7000.0	mα	ASE3\$P	. 0		MDCJS3\$P	0000	Hex
MDCRF4\$A	-7000.0	UIV	ASE4\$P	0		MDCJS4\$P	0000	Hex
HDCST1\$P	0000	Hex	Alm\$A	6849.7	mν	IP1M\$A	6849.7	mv
MDCST2\$P	0000	Hex	A2M\$A	6743.8	mv	IP2M\$A	6743.8	mv
MDCST3\$P	0000	Hex	A3M\$A	6863.4	mv	IP3M\$A	6863.4	mv
MDCST4\$P	0000	Hex	A4M\$A	6801.9	mv	IP4M\$A	6801.9	mv
D1SA\$P	1627		A1R\$A	6849.7	mα	IP1R\$A	6849.7	mv
D2SA\$P	1627		A2R\$A	6747.2	mν	IP2R\$A	6747.2	mv
D3SA\$P	1612		A3R\$A	6863.4	mv	IP3R\$A	6863.4	mv
D4SA\$P	1612		A4R\$A	6795.0	mν	IP4R\$A	6795.0	mv

7m27-JUL-198	37 13:1	5:25.44	IGSE USERS	= 1 FL'	TAUTO - Col 11	PCU BLVL Pg 13
7mTLMID:16	PKTCT:	4 PSTAT	:7F80 PKTM	S:0104 TMAF	C:4FF8 FMODE:04	SRCCT: 34404
7mArch: TLM	IDL	Time:	7.591 hrs	Partitions:	3 Globals: 1609	20-MAY-87
PCBI1\$P	7DF9	Hex	MREGA\$B	on	PWRD1\$B	on
PCBI2\$P	53FF	Hex	MREGB\$B	off	PWRD2\$B	on
PCDET\$P	FFFF	Hex	AHTR1\$B	off	PWRD3\$B	on
PCHTRSP	AABF	Hex	AHTR2\$B	off	PWRD4\$B	on
			AHTR3\$B	off		
			AHTR4\$B	off	TPWR1\$B	a
			SRIUA\$B	on	TPWR2\$B	ь
			SRIUB\$B	off	TPWR3\$B	ъ
			MTRA1\$B	a	TPWR4\$B	a
			MTRA2\$B	a		
			MTRA3\$B	a		
			MTRA4\$B	а		

7m27-JUL-198	87 13:1	5:45.08	IGSE US	SERS	= 1	FLTA	UTO -	Col 11	SLOT	Pg 14
7mTLMID:16	PKTCT:	2 PSTAT	:7F80 F	PKTMS	:1004	IMAFC:	5002	FMODE:		
7mArch: TLM	IDL	Time:	7.584 h	nrs	Partitio	ons: 3	Glob	als: 160	09 20-MAY-	87
SOPID\$P	0088	Hex	SIPIDS	\$P	0003	Hex		S2PID\$P	0006	Hex
SOSEQ\$P	0010	Hex	SISEQ	\$P	0035	Hex		S2SEQ\$P	0005	
SOTENSP	0000	Hex	SITENS	\$P	0000	Hex		S2TENSP	0003	Hex
SOMFC\$P	4FDD	Hex	SIMFC	\$P	4FA1	Hex		S2MFC\$P	4FD9	Нех
SORAC\$P	00B9	Hex	SIRAC	\$ <i>P</i>	0007	Hex		S2RAC\$P	0010	Hex
RPHA1\$B	on									
RPHA2\$B	on	I	BAUTH\$P		10					
CO60\$B	on	I	ERLOGSP		1				•	
CALIB\$B	on									
BURST\$B	on									

TABLE 3-5. VIDEO MONITOR PAGES 15, 16, 17

7m27-JUL-19	87 13:16:	06.19 IGS	E USERS	= 1	FLTA	UTO -	Co1 1	1	RIU DE	Pg 15
7mTLMID:15	PKTCT: 4	PSTAT:7F8	O PKTM	S:1F04	TMAFC:	500C	FMODE	:04	SRCCT:	34424
7mArch: TLM	IDL	Time: 7.5	80 hrs	Partiti	ons: 3	Globa	als: 1	609	20-MAY-8	37
RPRIPSB	main	RH	TRP\$B	main		1	RMAKP\$	В	main	
RAHT1\$B	on	RA	HT1\$A	0.000	a	1	RSTS1\$	Α	0.000	v
RAHT2\$B	on	RA	HT2\$A	0.000	а	1	RSTS2\$	Α	0.000	v
RAHT3\$B	on	RA	HT3\$A	0.000	а	1	RSTS3\$	Α	0.000	v
RAHT4\$B	on	RA	HT4\$A	0.000	а]	RSTS4\$	٨	0.000	v
						1	RSTSP\$	Α	0.000	v
RMHT1\$B	on	RM	HT1\$A	0.000	٧	1	R1TMP\$	A	0.00	С
RMHT2\$B	on	RM	HT2\$A	0.000	v	1	R2TMP\$	Α	0.00	С
RMHT3\$B	on	RM	HT3\$A	0.000	v	1	R3TMP\$	Α	0.00	С
RMHT4\$B	on	RM	HT4\$A	0.000	v		R4TMP\$	Α	0.00	С
PMHT5\$B	on	RM	HT5\$A	0.000	v	•	ROSTM\$	Α	0.00	С
							RSTM1\$	Α	0.00	С
							RSTM2\$	Α	0.00	С

7m27-JUL-198	37 13:17:0	09.62 IGSE	USERS =	1 FLT	CAUTO - Col	11	BILEVELS	Pg16
7mTLMID:16	PKTCT: 3	PSTAT:7F80	PKTMS:	OFO4 TMAFO	:502B FMOD	E:04	SRCCT: 3	4455
7mArch: TLM	IDL	Time: 7.560	hrs P	artitions:	3 Globals:	1609	20-MAY-87	
SPRIP\$B	main	SHT	RP\$B	redn	SMAKE	\$B	main	
TPWR1\$B	a	MTRA	A1\$B	a	AHTRI	.\$B	off	
TPWR2\$B	Ъ	MTRA	A2\$B	а	AHTR2	!\$B	off	
TPWR3\$B	ь	MTRA	43\$B	a	AHTR	\$\$B	off	
TPWR4\$B	a	MTRA	14\$B	a	AHTR	\$B	off	
MREGA\$B	on	SRI	JA\$B	on				
MREGB\$B	off	SRI	JB\$B	off				
MTRLL\$B	off							

7m27-JUL-19	87 13:13	7:29.07	IGSE USERS	= 1	FLTAU	ro - Col	11	PE ANA	Pg 17
7mTLMID:16	PKTCT:	1 PSTAT	:7F80 PKTM		TMAFC:50				
7mArch: TLM	1 IDL	Time:	7.556 hrs	Partiti	ons: 3 (Globals:	1609	20-MAY-8	37
PE5V\$A	4.969	v	MTRAC\$A	0.017	а				
PE10V\$A	10.605	v	MTRBC\$A	0.010	а				
PE20V\$A	21.273	v	*MTD1C\$A	-0,001	а				
PE5C\$A	2.876	a	*MTD2C\$A	-0.001	а				
PE10C\$A	78.2	ma	*MTD3C\$A	-0.001	а				
PE20C\$A	6.0	ma	*MTD4C\$A	-0.001	а				
PN10V\$A	-10.595	v	MTRAT\$A	17.88	С				
PN10C\$A	68.6	ma	MTRBT\$A	16.21	С				
PL10V\$A	10.457	v							
PL5V\$A	4.905	v							
PLN10\$A	-10.413	v							
PEPTM\$A	18.50	С							
HVCPM\$A	799.8	v							
QBV\$A	27.608	v							
*TBV\$A	-0.020	v							

TABLE 3-6. VIDEO MONITOR PAGES 18, 19, 20

7m27-JUL-198	37 13:17	7:50.74	IGSE USERS	= 1	FLT	AUTO - Col 11	RIU PE Pg 18
7mTLMID:16	PKTCT:	3 PSTAT	:7F80 PKTM	5:0DC4	TMAFC	:503F FMODE:04	SRCCT: 34475
7mArch: TLM	IDL	Time:	7.549 hrs	Partiti	ons:	3 Globals: 1609	20-MAY-87
RPEASB	on		RPEB\$B	on		RRIUA\$B	on
						RRIUB\$B	on
RA5C\$A	0.000	a	RB5C\$A	0.000	а	RPRIP\$B	main
RA10C\$A	0.0	ma	RB10C\$A	0.0	ma	RMAKP\$B	main
RAN10\$A	0.0	ma	RBN10\$A	0.0	ma		
RA20C\$A	0.0	ma	RB20C\$A	0.0	ma	·	
RAMIC\$A	0.0	ma	RBMIC\$A	0.0	ma		
RFMNA\$A	0.000	v	RFMNB\$A	0.000	V		
RLVCA\$A	0.000	а	RLVCB\$A	0.000	а		

7m27-JUL-19	87 13:18	3:09.69	IGSE	USERS	= 1	FLTA	UTO -	· Col	11	AGCSYS4	Pg 19
mTLMID:16	PKTCT:	4 PSTAT	:7F80	PKTM	S:1B44	TMAFC:	5048	FMO	DE:04	SRCCT:	34485
7mArch: TLM	IDL	Time:	7.544	hrs	Partitio	ons: 3	Glob	als:	1609	20-MAY-	37
*HVP1\$A4	0.0	v	AGCP	1\$B4	off			AGCT	2\$\$	79026C	Hex
*HVP2\$A4	0.0	v	AGCP	2\$B4	off			AGCT	3\$S	7A02DD	Hex
*HVP3\$A4	0.0	v	AGCP	3\$B4	off			AGCT	4\$S	7B0290	Hex
*HVP4\$A4	0.0	v	AGCP	4\$B4	off			AGCT	5\$S	7C024B	Hex
*HVP5\$A4	0.0	v	AGCP	5\$B4	off			AGCT	6\$S	7D02EF	Hex
*HVP6\$A4	0.0	v	AGCP	6\$B4	off			AGCT	7\$S	7E01EC	Hex
*HVP7\$A4	0.0	v	AGCP	7\$B4	off			TANA	A\$S	2900	Hex
LEDON\$B4	off		PINO	N\$B4	off						
LED\$A4	3469.3	mv	PIN\$	A4	5244.9	mv					
VS1LD\$B1	off		AGCR	A\$B4	1000			CLAD	\$B4	low	
			AGCC	N\$B4	off						
			AGCF	S\$B4	normal						

7m27-JUL-19	87 13:16	5:39.91	IGSE USERS	= 1_	FLTAUTO -	Col 11	SYSPUL	Pg 20
7mTLMID:16	PKTCT:	1 PSTAT	:7F80 PKTM	S:1944	TMAFC:501D	FMODE:04	SRCCT:	34441
7mArch: TLM	IDL	Time:	7.570 hrs	Partiti	ons: 3 Glob	als: 1609	20-MAY-8	37
MLL\$R1	910.03	CS	MLM\$R1	907.59	cs	MLH\$R1	0.00	CS
MLL\$R2	958.37	CS	MLM\$R2	903.69	CS	MLH\$R2	0.00	C S
MLL\$R3	949.95	cs	MLM\$R3	895.02	. CS	MLH\$R3	0.00	CS
MLL\$R4	927.98	CS	MLM\$R4	895.51	CS	MLH\$R4	0.00	CS
BAUTH\$P	10		D1POS\$P	C	1	LVL1\$P1	CFC0	Нех
PULSM\$P i	nactive		D2POS\$P	C)	LVL1\$P2	EFC7	Hex
PULWD\$P	0000	Hex	D3POS\$P	O	•	LVL1\$P3	EFC7	Hex
PULEB\$B	0000	Hex	D4POS\$P	O)	LVL1\$P4	EFC7	Hex
PULRC\$P	0000	Hex						
PULRT\$P	0000	Hex						

DTH\$R3

0.00 Z

TABLE 3-7. VIDEO MONITOR PAGES 21, 22, 23

		IMDI	16 3-7. Y	טשעד	MUNI	IUR I AGE	5 21	, 22, 2			
7m27-JUL-198					SERS					PHOS 1	Pg 21
7mTLMID:16	PKTCT:		PSTAT:7F					C:5053	FMODE:04	SRCCT:	
7mArch: TLM				537				3 Glot	als: 1609		7
*HVP1\$A1	0.5			VP6\$		0.5			PINON\$B1	off	
*HVP2\$A1	0.5	v	*H	VP7\$	A1	0.5	V		PIN\$A1	5227.8	mν
*HVP3\$A1	0.5	v							AGCRA\$B1	1000	
*HVP4\$Al	0.5	v	L	EDON	\$B1	off			AGCPS\$B1	normal	
*HVP5\$A1	0.5	v	L	ED\$A	1	3460.7	mv				
									PHGL\$B1	high	
ELDL\$A1	80.6	mν	E	LDM\$	A1	79.4	mv		ELDH\$A1	79.4	mv
TLDL\$A1	100.1	mv	T	LDM\$	A1	100.1	mν		TLDH\$A1	98.9	mν
TUDL\$A1	4914.5	mν	T	UDM\$	A1	4901.1	mν		TUDH\$A1	4912.1	mν
ELDL\$R1	998.78	cs	E	LDM\$	R1	906.49	CS		ELDH\$R1	0.00	cs
EUDL\$R1	39.92	C S	E	UDM\$	R1	0.00	C 8		EUDH\$R1	0.00	CR
ATWL\$R1	960.45	c s	Α	TWM\$	R1	906.49	CS		ATWH\$R1	0.00	cs
TUDL\$R1	0.00	cs	T	UDM\$	R1	0.00	CS		TUDH\$R1	0.00	cs
MLL\$R1	950.68	cs	М	LM\$R	.1	906.49	c s		MLH\$R1	0.00	cs
DTL\$R1	1.63			TM\$R		1.17			DTH\$R1	0.00	z
•											
7m27-JUL-19						= 1			- Col 11	PHOS 2	Pg 23
7mTLMID:16		3	PSTAT:7			S:1C04		C:5087			
7mArch: TLM	IDL		Time: 7	.506	hrs	Partit.	ions	: 3 Glc	bals: 1609	20-MAY-	87
*HVP1\$A2	0.0	v	*1	HVP6	\$A2	0.) v		PINON\$B2	off	
*HVP2\$A2	0.0	v	*1	HVP7	\$A2	0.0	v C		PIN\$A2	5234.7	mv .
*HVP3\$A2	0.0	v							AGCRA\$B2	1000	
*HVP4\$A2	0.0]	LEDOI	N\$B2	of	£		AGCPS\$B2	normal	
*HVP5\$A2	0.0			LED\$	•	3462.					
									PHGL\$B2	high	
ELDL\$A2	78.1	mv		ELDM	ŜA2	79.	4 mv		ELDH\$A2	81.8	
TLDL\$A2	97.7			TLDM			7 mv		TLDH\$A2	97.7	
TUDL\$A2	4898.7			TUDM		4901.			TUDH\$A2	4903.5	
ELDL\$R2	1007.20			ELDM		959.1			ELDH\$R2	0.00	
EUDL\$R2	73.12			EUDM			0 cs		EUDH\$R2	0.00	
ATWL\$R2	942.75			ATWM	-	959.1			ATWH\$R2	0.00	
TUDL\$R2	0.00			TUDM			0 cs		TUDH\$R2	0.00	
	933.47			MLM\$	-	959.1			MLH\$R2	0.00	
MLL\$R2				DTM\$		1.2			DTH\$R2	0.00	
DTL\$R2	1.78	5 4		טוועס.	K2	1.2	4 &		DINSKZ	0.00	4
7m27-JUL-19	987 13:2	20:3	3.01 I	GSE	USERS	S = 1	F	LTAUTO	- Col 11	PHOS 3	Pg 23
7mTLMID:16	PKTCT		PSTAT:7			1S:0744		FC:508			34554
7mArch: TL					hrs				obals: 1609		-87
*HVP1\$A3		5 v		HVP6			0 v		PINON\$B3	of	
*HVP2\$A3		5 v		HVP7			5 v		PIN\$A3	5233.0	
*HVP3\$A3		0 v		** * * *	V.1.5	٠.	•		AGCRA\$B3	1000	
*HVP4\$A3		0 V		LEDO	N\$B3	of	f		AGCPS\$B3	norma	
·		0 v		LED\$		3460.		,			_
*HVP5\$A3	0.	U V		LEDŞ)AJ	3400.	/ Htv	•	PHGL\$B3	high	h
DI DI AAA	70	1 ~		ELDM	(¢ / 2	۵٥	6 mv	•	ELDH\$A3		u 4 mv
ELDL\$A3		1 m					1 mv		TLDH\$A3		9 mv
TLDL\$A3		9 m		TLDM					TUDH\$A3	4903.	
TUDL\$A3	4906.			TUDM		4904.			ELDII\$R3		0 cs
ELDL\$R3	989.1			ELDN		896.2					ocs ocs
EUDL\$R3	64.9			EUD			00 cs		EUDH\$R3		
ATWL\$R3	927.7			ATW		896.1			ATWH\$R3		0 cs
TUDL\$R3		0 c		TUDN			00 cs		TUDH\$R3		0 cs
MLL\$R3	915.0	4 C	S	MLMS		896.	L2 C9	5	MLH\$R3		0 cs
במיז מיתי	7 6	n 🔻		I L I M C	L U '1	1 '			DEMSD4	11 (1	

DTM\$R3

DTL\$R3

1.69 Z

1.18 %

TABLE 3-8. VIDEO MONITOR PAGES 24, 25, 30

TABLE 3-8. VIDEO MONITOR PAGES 24, 25, 30						
	87 13:21:04.51	IGSE USERS			PHOS 4 Pg 24	
7mTLMID:16			S:0004 TMAFC:5091		SRCCT: 34570	
7mArch: TLM		7.491 hrs	Partitions: 3 Glo			
*HVP1\$A4	0.5 v	*HVP6\$A4	0.0 v	PINON\$B4	off	
*HVP2\$A4	0.0 v	*HVP7\$A4	0.0 v	PIN\$A4	5244.9 mv	
*HVP3\$A4	0.0 v			AGCRA\$B4	1000	
*HVP4\$A4	0.0 v	LEDON\$B4	off	AGCPS\$B4	normal	
*HVP5\$A4	0.0 v	LED\$A4	3469.3 mv			
				PHGL\$B4	high	
ELDL\$A4	79.4 mv	ELDM\$A4	79.4 mv	ELDH\$A4	79.4 mv	
TLDL\$A4	100.1 mv	TLDM\$A4	100.1 mv	TLDH\$A4	98.9 mv	
TUDL\$A4	4909.6 mv	TUDM\$A4	4904.8 mv	TUDH\$A4	4906.0 mv	
ELDL\$R4	985.84 cs	ELDM\$R4	916.99 cs	ELDH\$R4	0.00 cs	
EUDL\$R4	78.49 cs	EUDM\$R4	0.00 cs	EUDH\$R4	0.00 cs	
ATWL\$R4	908.45 cs	ATWM\$R4	916.87 cs	ATWH\$R4	0.00 cs	
TUDL\$R4	0.00 cs	TUDM\$R4	0.00 cs	TUDH\$R4	0.00 cs	
MLL\$R4	886.84 cs	MLM\$R4	916.99 cs	MLH\$R4	0.00 cs	
DTL\$R4	1.75 %	DTM\$R4	1.20 Z	DTH\$R4	0.00 Z	
7m27= TIII.=10	987 13:32:26.54	IGSE USERS	S = 1 FI.TATITO) - Col 11	DRIVECAL Pg25	
7mTLMID:16			S:1EC4 TMAFC:51E			
7mArch: TLN			Partitions: 3 Gl			
DEMGS\$P	9999 Hex	FDET1\$P	0080 Hex	FDET2\$P	0080 Hex	
DENGSOL	JJJJ Hex	A1M\$A	6849.7 mv	A2M\$A	6743.8 mv	
D1SA\$P	1627	AIR\$A	6849.7 mv	A2R\$A	6747.2 mv	
D2SA\$P	1627	P1MZR\$A	6996.7 mv	P2MZR\$A	6996.7 mv	
D3SA\$P	1612	P1MZRŞA P1RZRŞA	6996.7 mv	P2RZR\$A	6996.7 mv	
· ·		P1KZK\$A P1MXR\$A	5444.9 mv	P2KZK\$A P2MXR\$A	4276.0 mv	
D4SA\$P	1612			P2RXR\$A	4303.3 mv	
TDIMEA	6849.7 mv	P1RXR\$A	5468.9 mv	PZKAKŞA	4303.3 mV	
IP1M\$A IP1R\$A	6849.7 mv	FDET3\$P	0080 Hex	FDET4\$P	0080 Hex	
*	6743.8 mv	A3M\$A	6863.4 mv	A4M\$A	6801.9 mv	
IP2M\$A IP2R\$A	6747.2 mv	A3R\$A	6863.4 mv	A4R\$A	6795.0 mv	
IP2K\$A IP3M\$A	6863.4 mv	P3MZRSA	6996.7 mv	P4MZR\$A	6996.7 mv	
•		P3RZR\$A		P4MZR\$A P4RZR\$A	6996.7 mv	
IP3R\$A	6863.4 mv 6801.9 mv		6996.7 mv 5588.5 mv		4891.2 mv	
			5602.2 mv		4833.1 mv	
1P4K\$A	6795.0 mv	PSKAKŞA	3602.2 mv	PAKAKSA	4833.1 MV	
			_			
			S = 1 FLTAUTO			
7mTLMID:16			MS:10C4 TMAFC:50E			
7mArch: TLN			Partitions: 3 G1			
MT1TM\$A			14.52 c	P1M\$A		
MT5TM\$A		PRADC\$A		P1MXR\$A		
MT2TM\$A		MRADC\$A		P1MZR\$A		
MT6TM\$A	14.93 c	MYLTM\$A		P2M\$A	6743.8 mv	
MT3TM\$A	15.23 c	NOMTM\$A		P2MXR\$A	4276.0 mv	
MT7TM\$A	15.23 c		14.42 c	P2MZR\$A	6996.7 mv	
MT4TM\$A	15.33 c	ST2TM\$A		P3M\$A	6863.4 mv	
MT8TM\$A	15.43 c	ST3TM\$A		P3MXR\$A	5588.5 mv	
PETM\$A	17.06 c	ST4T1.CA	14.52 c	P3MZR\$A	6996.7 mv	
PEPTM\$A	18.85 c	PE5V\$A	4.969 v	P4M\$A	6801.9 mv	
CPMTM\$A	16.40 c	PE10V\$A		P4MXR\$A	4891.2 mv	
DRETM\$A	15.52 c	PE20V\$A	21.273 v	P4MZR\$A	6996.7 mv	

PN10V\$A -10.595 v

-30.7 mv

799.8 v

*CPMR\$A

HVCPMSA

PCUTM\$A

MTRAT\$A

MTRBTSA

18.85 c

17.79 c

16.21 c

TABLE 3-9. VIDEO MONITOR PAGES 31, 32, 34

		TABLE 3-9	. VIDEO MO	NITOR PAGES 31	l, 32, 34	
7m27-JUL-198	37 13:22	2:35.20	IGSE USER	S = 1 FL	TAUTO - Col 11	PE ANA2 Pg31
7mTLMID:16			:7F80 PKT		C:50CA FMODE:04	SRCCT: 34614
7mArch: TLM	IDL	Time:	7.465 hrs	Partitions:	3 Globals: 1609	20-MAY-87
PE5C\$A	2.861	а	CPUC\$A	398.8 ma	*MTD4C\$A	-0.001 a
PE10C\$A	78.2	ma	MTRAC\$A	0.016 a	MTD4F\$A	22.204 v
PE20C\$A	5.9	ma	MTRAF\$A	27.628 v	TD1F\$A	22.219 v
P1R\$A	6853.2	mv	MTRBC\$A	0.010 a	*MTD5F\$A	-0.015 v
P1RXR\$A	5468.9	mv	MTRBF\$A	27.648 v	*TD2F\$A	-0.015 v
P1RZR\$A	6996.7	mv	CEAC\$A	0.864 a	*MTD6F\$A	-0.015 v
P2R\$A	6747.2	mv	CEAV\$A	27.979 v	*TD3F\$A	-0.015 v
P2RXR\$A	4303.3	mv	CEBC\$A	0.009 a	*MTD7F\$A	-0.015 v
P2RZR\$A	6996.7	mv	CEBV\$A	27.626 v	*MTD&F\$A	-0.015 v
P3R\$A	6863.4	mv	*MTD1C\$A	-0.001 a	TD4F\$A	
P3RXR\$A	5602.2	mν		22.218 v	QBV\$A	27.608 v
P3RZR\$A	6996.7	mν	*MTD2C\$A			
P4R\$A	6795.0		MTD2F\$A			
P4RXR\$A			*MTD3C\$A			
P4RZR\$A	6996.7	mν	MTD3F\$A	22.249 v		
7m27-JUI19					LTAUTO - Col 11	PE ANA3 Pg32
7mTLMID:16	PKTCT	3 PSTAT	r:7F80 PK		FC:50D3 FMODE:0	
7mArch: TL	M IDL	Time:	7.460 hr	<u>s Partitions</u>	: 3 Globals: 160	
DET1F\$A	28.062	2 v	*AHT2C\$A	-0.013 a	MHTCF\$A	28.731 v
DET1C\$A	0.549	e a	*AHT2F\$A	-0.020 v	MUBV\$A	28.652 v
DET2F\$A	28.123	l v	*AHT3C\$A	-0.008 a		
DET2C\$A	0.557	7 a	*AHT3F\$A	-0.020 v		
DET3F\$A	28.143	l v	*AHT4C\$A	-0.014 a		
DET3C\$A	0.560) a	*AHT4F\$A	-0.020 v		
DET4F\$A	28.163	1 v	*MHT1C\$A	-0.002 a		
DET4C\$A	0.550) a	MHT1F\$A			
AGCAB\$S	4AC	O Hex	*MHT2C\$A	-0.005 a		
PL5V\$A	4.90	5 v	MHT2F\$A	28.672 v		
PL10V\$A	10.45	7 v	*MHT3C\$A	-0.003 a		
PLN10\$A	-10.41	3 v	MHT3F\$A	28.750 v		
*TBV\$A	-0.02	v 0	*MHT4C\$A			
*AHT1C\$A	-0.01	1 a	MHT4F\$A	. 28.750 v		
*AHT1F\$A	-0.02	0 v	*MHTCC\$A	-0.002 a		
7m27-JUL-1	087 13.	23.10 02	TOSE US	ERS = 1	FLTAUTO - Col 11	DE1 2PWR Pg34
7mTLMID:16				KTMS:0544 TM		
7mArch: TI		Time:			s: 3 Globals: 160	
V10\$A1	10.05		MTD1F\$			10.052 v
V103A1 V10C\$A1		.4 ma	*MTD1C\$			
V10C\$A1 V12\$A1	11.41		*MTD5F\$			
V125K1 V12C\$A1		.4 v .8 ma	- LILDJE Q	-0.013 A	V12C\$A2	
					* 1 L U V N L	* · · · · · · · · · · · · · · · · · · ·

V12C\$A1 171.8 ma V12C\$A2 170.7 ma *V20\$A1 20.887 v *AHT1F\$A -0.020 v *V20\$A2 20.904 v *AHT1C\$A -0.011 a V20C\$A2 V20C\$A1 15.2 ma 17.7 ma 5.127 v V5\$A1 V5\$A2 5.11\$v V5C\$A1 326.7 ma V5C\$A2 322.1 ma VN10\$A2 -9.764 v VN10\$A3 -9.749 v MTD2F\$A 22.220 v VN10C\$A2 429.8 ma VN10C\$A3 428.5 ma MHT1F\$A 28.750 v *MTD2C\$A -0.001 a MHT2F\$A 28.672 v *MHT1C\$A ~0.002 a *MTD6F\$A -0.015 v *MHT2C\$A -0.005 a 28.062 v DET1F\$A DET2F\$A 28.121 v DET1C\$A 0.548 a *AHT2F\$A -0.020 v DET2C\$A 0.558 a*AHT2C\$A -0.013 a

TABLE 3-10. VIDEO MONITOR PAGES 35, 36, 42

7m27-JUL-19	87 13:23	3:3 <mark>7.74</mark>	IGSE USERS	= 1 FL	TAUTO - Col 11	VOPP	Pg 35
7mTLMID:16	PKTCT:	1 PSTAT	:7F80 PKTM	S:12C4 TMAF	C:50E9 FMODE:04	SRCCT:	34645
7mArch: TLM	IDL	Time:	7.449 hrs	Partitions:	3 Globals: 1609	20-MAY-8	37
S1LD\$R1	0.00	CS	S1LD\$R3	0.00 cs	VOPP\$B2	off	
S2LD\$R1	0.00	C 8	S2LD\$R3	0.00 cs	VOPP\$B3	off	
S3LD\$R1	0.00	CS	S3LD\$R3	0.00 cs	VOPP\$B4	off	
S4LD\$R1	0.00	cs	S4LD\$R3	0.00 cs	VOPP1\$P	0000	Hex
SMD\$R1	0.00	cs	SMD\$R3	0.00 cs			
SUD\$R1	0.00	cs	SUD\$R3	0.00 cs	VOPP2\$P	0000	Hex
					VOPP3\$P	0000	Hex
S1LD\$R2	0.00	cs	S1LD\$R4	0.00 cs	VOPP4\$P	0000	Hex
S2LD\$R2	0.00	cs	S2LD\$R4	0.00 cs	VRPH\$B1	anti	
S3LD\$R2	0.00	cs	S3LD\$R4	0.00 cs			
S4LD\$R2	0.00	cs	S4LD\$R4	0.00 cs			
SMD\$R2	0.00	cs	SMD\$R4	0.00 cs			
SUD\$R2	0.00	cs	SUD\$R4	0.00 cs			

7m27-JUL-198	37 <u>13:23</u>	3 : 5	54.98	IGSE	USERS	<u>=</u> 1	FL'	TAUTO -	Col 11	FLTAUTO	Pg 36
7mTLMID:16	PKTCT:	1	PSTAT:	7F80	PKTM	S:1EC4	TMAF	C:50F1	FMODE:04	SRCCT:	34653
7mArch: TLM	IDL		Time:	7.444	4 hrs	Partit:	ons:	3 Glob	als: 1609	20-MAY-8	37
C6TMP\$A1	14.77	С		MLLS	\$R1	920.04	CS		PTMP1\$A1	14.85	С
C6TMP\$A2	14.88	С		MLLS	\$R2	950.68	cs		PTMP1\$A2	15.03	С
C6TMP\$A3	14.81	С		MLLS	\$R3	942.63	cs		PTMP1\$A3	14.77	c ·
C6TMP\$A4	14.96	С		MLLS	\$R4	919.80	cs		PTMP1\$A4	15.03	С

7m27 JUL-198	37 13:24	:24.97	IGSE USERS	= 1 FI	TAUTO - Col 11	C060 Pg 42
7mTLMID:16	PKTCT:	4 PSTAT	:7F80 PKTM	S:1604 TMAE	C:5100 FMODE:04	SRCCT: 34668
7mArch: TLM	IDL	Time:	7.434 hrs	Partitions:	: 3 Globals: 1609	20-MAY-87
C6LD\$A1	89.0	mv	C6LD\$R1	0. cs	DTL\$R1	1.73 Z
C6LD\$A2	89.0	mv	C6LD\$R2	0. cs	DTL\$R2	1.71 %
C6LD\$A3	89.0	mv	C6LD\$R3	0. cs	DTL\$R3	1.70 %
C6LD\$A4	89.0	mv	C6LD\$R4	0. cs	DTL\$P4	1.73 Z
*HVC6\$A1	0.0	v	VC6\$B1	on		
*HVC6\$A2	0.0	v	VC6\$B2	on		
*HVC6\$A3	0.0	v	VC6\$B3	on		
*HVC6\$A4	0.0	v	VC6\$B4	on		

TABLE 3-11. VIDEO MONITOR PAGE 43

7m27-JUL-198	37 13:24	4:42.40	IGSE USERS	= 1	FLTAUT	0 - Col 11	SHIELDS Pg43
7mTLMID:16	PKTCT:	4 PSTAT	:7F80 PKTM	S:02C4	TMAFC:51	.08 FMODE:04	SRCCT: 34676
7mArch: TLM	IDL	Time:	7.429 hrs	Partiti	ons: 3 G	lobals: 1609	20-MAY-87
S1LD\$R1	0.00	CS	S1LD\$R2	0.00	CS	DTL\$R1	1.61 %
S2LD\$R1	0.00	cs	S2LD\$R2	0.00	CS		
S3LD\$R1	0.00	cs	S3LD\$R2	0.00	СS	DTL\$R2	1.59 %
S4LD\$R1	0.00	cs	S4LD\$R2	0.00	CS		
SMD\$R1	0.00	cs	SMD\$R2	0.00	cs	DTL\$R3	1.59 %
SUD\$R1	0.00	cs	SUD\$R2	0.00	CS		
						DTL\$R4	1.61 %
S1LD\$R3	0.00	cs	S1LD\$R4	0.00	CS		
S2LD\$R3	0.00	cs	S2LD\$R4	0.00	cs		
S3LD\$R3	0.00	cs	S3LD\$R4	0.00	cs		
S4LD\$R3	0.00	cs	S4LD\$R4	0.00	CS		
SMD\$R3	0.00	cs	SMD\$R4	0.00	CB		
SUD\$R3	0.00	cs	SUD\$R4	0.00	cs		

3.2 DRIVE POTENTIOMETER CALIBRATION CURVES

Figures 3-1 through 3-4 are Main Pot SYSPOTLIN values for Processor Electronics, A-side (PEA). These tests were performed on 25 March 1987, during Thermal-Vacuum testing of OSSE.

Figures 3-5 through 3-8 are Redundant Pot SYSPOTLIN values for Processor Electronics, A-side (PEA). These tests were also performed on 25 March 1987, during the Thermal-Vacuum testing of OSSE.

FIGURE 3-1. SYSPOTLIN, DETECTOR A1, PROCESSOR ELECTRONICS A MAIN POT

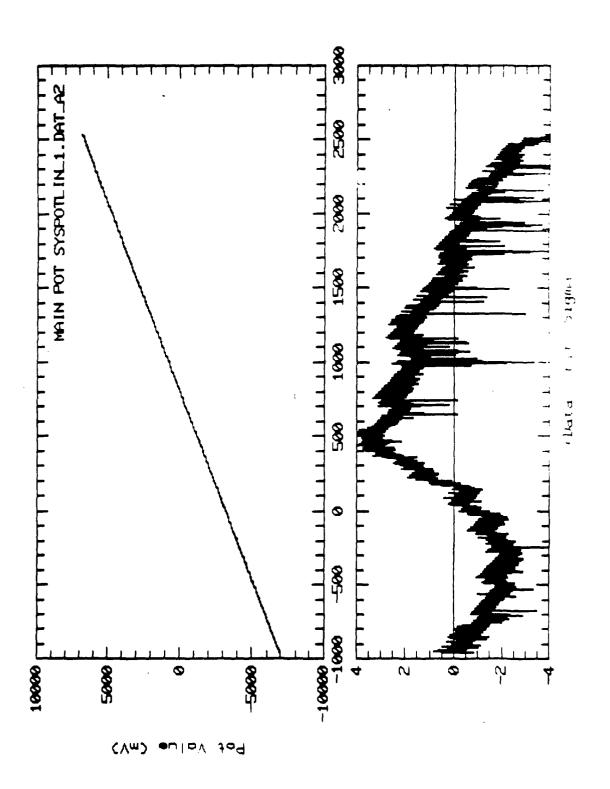


FIGURE 3-2. SYSPOTLIN, DETECTOR A2, PROCESSOR ELECTRONICS A MAIN POT

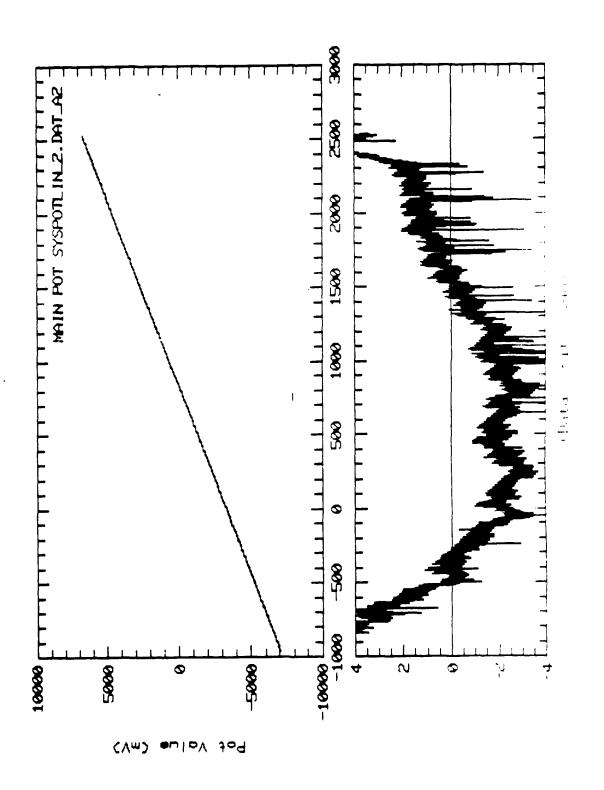


FIGURE 3-3. SYSPOTLIN, DETECTOR A3, PROCESSOR ELECTRONICS A MAIN POT

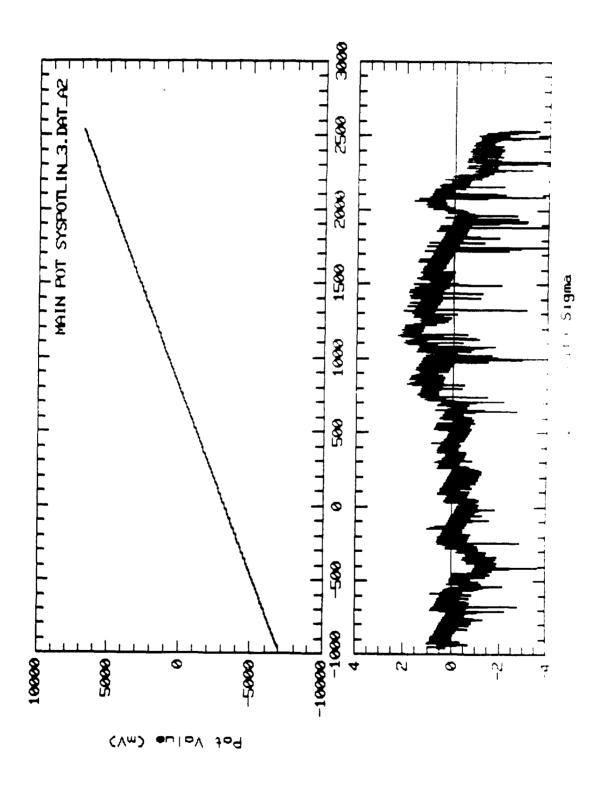


FIGURE 3-4. SYSPOTLIN, DETECTOR A4, PROCESSOR ELECTRONICS A MAIN POT

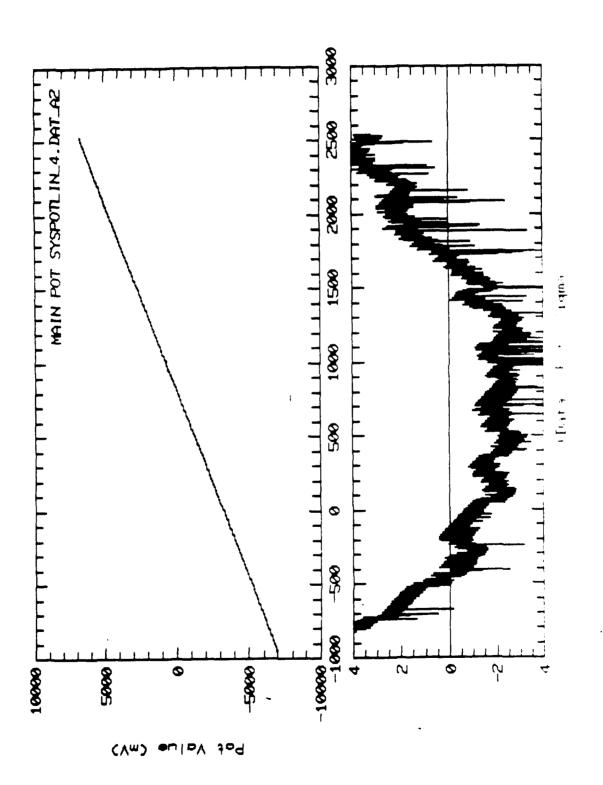


FIGURE 3-5. SYSPOTLIN, DETECTOR A1, PROCESSOR ELECTRONICS A REDUNDANT POT

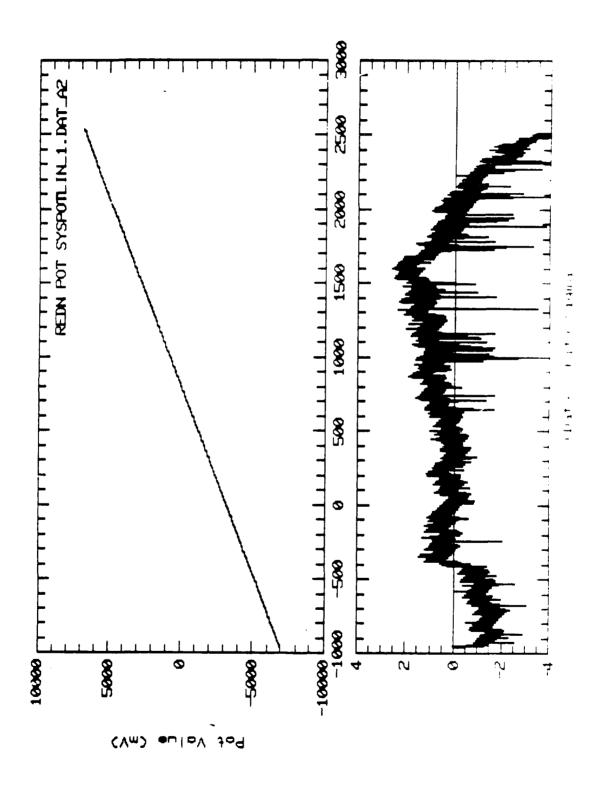


FIGURE 3-6. SYSPOTLIN, DETECTOR A2, PROCESSOR ELECTRONICS A REDUNDANT POT

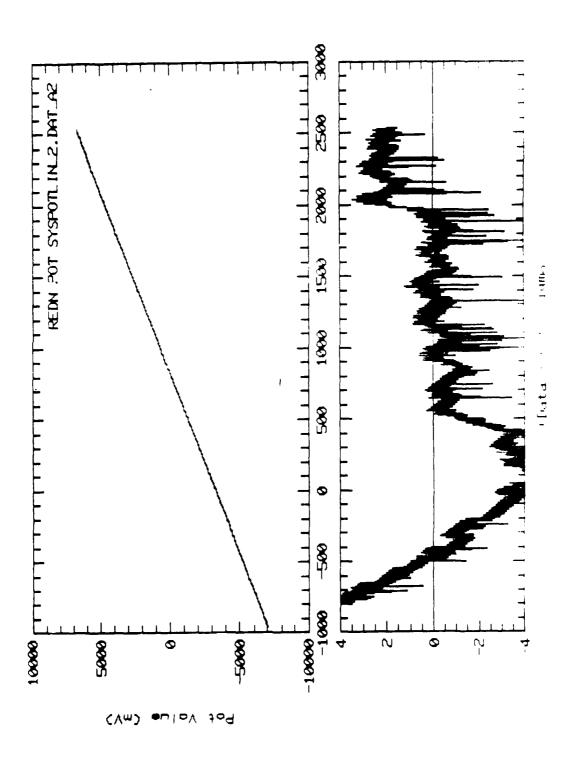


FIGURE 3-7. SYSPOTLIN, DETECTOR A3, PROCESSOR ELECTRONICS A REDUNDANT POT

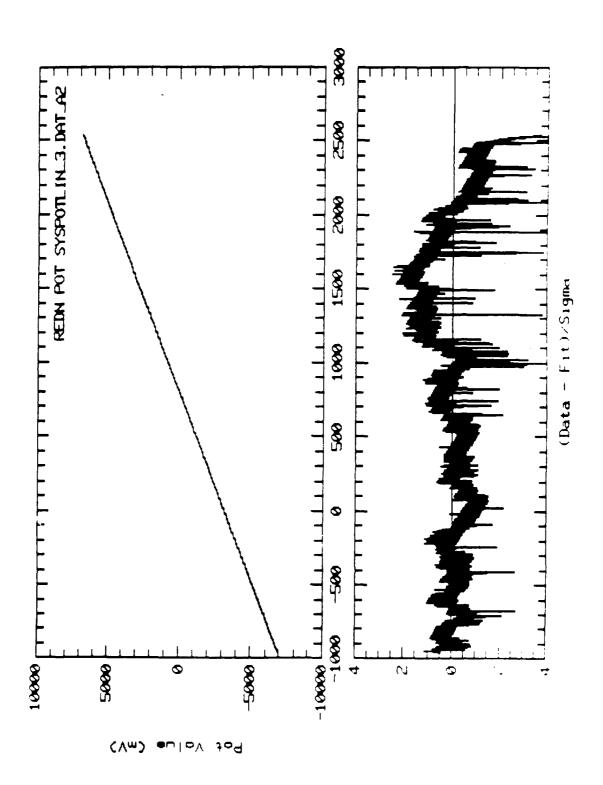
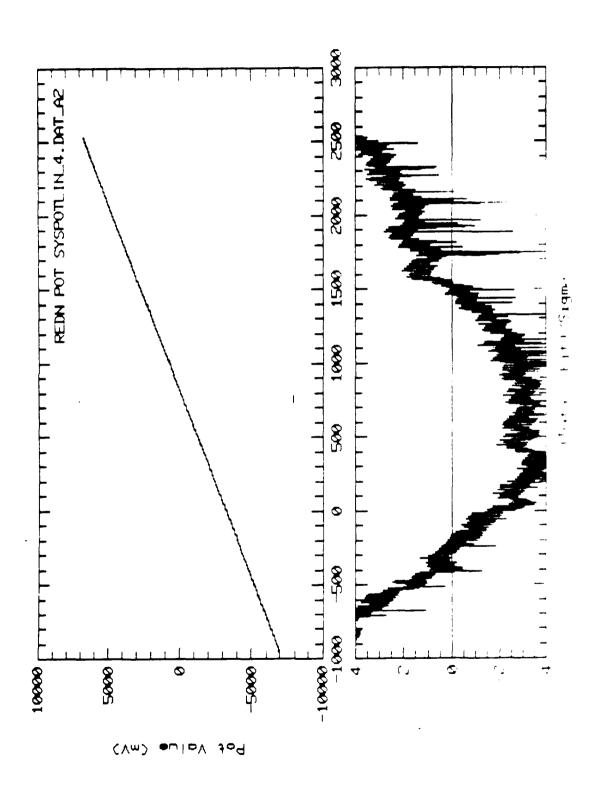


FIGURE 3-8. SYSPOTLIN, DETECTOR A4, PROCESSOR ELECTRONICS A REDUNDANT POT



3.3 OSSE POWER CONSUMPTION SUMMARY

TABLE 3-12 QUIET BUS CURRENT (AMPS) AND POWER (WATTS)

CONFIGURATION	22 VOLTS	28 VOLTS	35 VOLTS
CE A, MOTOR REG B	1.07 (23.5)	0.86 (24.1)	0.70 (24.5)
CE A, MOTOR REG B 4 DETECTORS ON (HIGH VOLTS OFF)	3.97 (87.3)	3.10 (86.8)	2.51 (87.8)
CE A, MOTOR REG B 4 DETECTORS ON (HIGH VOLTS ON)	4.42 (97.2)	3.46 (96.9)	2.77 (97.0)
CE A, MOTOR REG B 4 DETECTORS ON 4 DRIVES ON	5.14 (113.1)	4.02 (112.6)	3.25 (113.8)
CE A, MOTOR REG B 4 DETECTORS ON, 5% DRIVE DUTY CYCLE (AVERAGE POWER, CALCU	, ,	4.05 (97.7)	2.80 (97.9)
CE A, MOTOR REG B 4 DETECTORS ON, ONE SECOND MOTOR HOLD PUL ON ALL DRIVES (ESTIMA	SE	(129)	(129)

TABLE 3-13 MAKEUP BUS CURRENT (AMPS) AND POWER (WATTS)

CONFIGURATION	22 VOLTS	25 VOLTS	28 VOLTS	35 VOLTS
4 DETECTOR MAKEUP HEATERS ON	2.46 (54.1)	2.84 (71.0)	3.18 (89.0)	3.92 (137.2)
CE MAKEUP HEATER ON	0.83 (18.2)	0.92 (23.0)	1.05 (29.5)	1.32 (46.1)
4 DETECTOR AND CE MAKEUP HEATERS ON	3.27 (71.9)	3.73 (93.2)	4.17 (116.8)	5.20 (182.0)
NO MAKEUP HEATERS ON			17.4 MA (0.49)	

TABLE 3-14 THERMAL BUS CURRENT (AMPS) AND POWER (WATTS)

CONFIGURATION	21 VOLTS	28 VOLTS	35 VOLTS
4 DETECTOR ACTIVE HEATERS FULLY ON, HEATER POWER	4.05 (85.1)	3.04 (85.1)	2.43 (85.1)
4 DETECTOR ACTIVE HEATERS FULLY ON, CONTROL CIRCUIT POWER	0.45 (9.4)	0.34 (9.6)	0.28 (9.9)
4 DETECTOR ACTIVE HEATERS FULLY OF TOTAL BUS POWER	4.50 (94.5) _.	3.38 (94.7)	2.72 (95.0)

3.4 ALIGNMENT SUMMARY (MECHANICAL, PRE-CALIBRATION)

Alignment, for OSSE and most complex space systems, is easy to define as an objective, but difficult to explain as a procedure. This report attempts to define the requirements in terms of arc minute errors and uncertainties in the alignment of appropriate system components, state actual errors, then provide supporting evidence that these measured errors are within the uncertainty budget.

1.0 ALIGNMENT REQUIREMENTS

- a) The center of the field of view (FOV) for each detector shall be known to within six arc minutes (three arc minutes allotted to internal OSSE alignment uncertainty of the detector FOV to the mounting surface in the X-Z (scan) plane), and known to within eight arc minutes in the perpendicular direction (five arc minutes allotted to internal OSSE alignment uncertainty of the detector FOV to the mounting surface in the X-Z (scan) plane. Ref ICD 1135G, and SEM 926-061A.
- b) The center of a detector's FOV relative to the crystal housing must have an uncertainty less than or equal to one arc minute in the X-Z scan direction and three arc minutes in the perpendicular direction. Ref SEM 926-061A.
- c) Each detector subsystem must be positioned in the structure so that its rotaion axis is within three arc minutes of the OSSE Y axis defined by the optical reference cube (known to less than one arc minute). Ref SEM 926-031A.
- d) The center of the field of view of each collimator must be determined with an uncertainty of less than plus or minus one arc minute in the X-Z scan direction and to less than plus or minus three arc minutes in the perpendicular direction. Since determination of the gamma ray field of view is a primary objective of the post-acceptance calibration, this report considers only the geometric center of the field of view using mechanical measurement methods. Ref SEM 926-061A.
- e) The motor step count and absolute drive position must be verifiable. Ref SEM 926-061A.

1.1 Methods

Items a) through e) range from an overall uncertainty requirement for each detector's field of view with respect to the OSSE structure, to the uncertainty associated with each detector collimator. Measurements for alignment went in two separate directions:

1. From collimator FOV to detector housing, by means of an alignment cube, for each of the four units.

Test Procedure 150689, OSSE COLLIMATOR DETECTOR ALIGNMENT MEASUREMENTS, was a post-fabrication optical survey of each collimator to determine a three-sigma confidence in the plane-parallelism of the four sets of walls, the select wall in each set which corresponds closest to the mean, then compensating for wall taper, and establishing an external reference

(in the form of an optical reference cube) corresponding to the median planes between opposing mean walls for both X-facing and Y-facing wall pair-sets. It was intended to be a mechanical starting point from which (primarily) a zero step reference could be established for various assembly and calibration tests of OSSE. Since the insertion of the collimator into the detector housing was done without provision for collimator orientation adjustment, the reference cube provides an indication of where the gamma ray axis is expected to be with respect to primary instrument axes, and the zero-reference step. As OSSE undergoes source mapping during the final calibration phase, the gamma ray axes are then established with respect to the primary instrument and detector references, and the opto-mechanical measurements of DD150689 become obsolete. The optical cubes placed on the detectors may still be used as an index for rotation angle position and stability, and to cross-check the actual gamma ray field of view center with the expected center. The opto-mechanical measurements and their uncertainties are addressed in this report as part of the initial requirements.

2. From structure mounting points to each of four detector rotation axes by means of structure alignment cube referenced to the X-Y mounting surface axes.

The rotation axis of each detector was established in reference to the OSSE mounting holes. This was done as described in SER EX056-017. After the mounting holes were drilled in the handling dolly by means of a drill template (which is retained at TRW for spacecraft integration), conical-tipped tooling pins were placed over the +X-Y, -X-Y, and +X+Y mounting holes of the dolly, then surveyed with a T-3 theodolite. The dolly reference cube was mounted to the reference established by the bolt holes and the drill template cube was also mounted to the template parallel to the dolly cube while the template was attached to the dolly. The template was THE ESTIMATED UNCERTAINTY OF THE DOLLY CUBE POSITION IS then shipped to TRW. ABOUT 0.3 ARC MINUTES. The flight structure was eventually mounted on the dolly, and two alignment cubes mounted to the center structure, one being the OSSE assembly alignment cube set identically to the dolly reference cube from which all instrument pointing errors were measured during assembly, test, and calibration, WHOSE ESTIMATED UNCERTAINTY WITH RESPECT TO THE DOLLY CUBE IS 0.2 ARC MINUTES. The other was the Instrument alignment, or TRW, cube, a 45 degree Z-axis-rotated cube required by the ICD for spacecraft assembly (SER EXO56A-267A describes the placement method of this cube). The TRW cube was referenced off the OSSE assembly cube. THE UNCERTAINTY OF THE INSTALLATION OF THE TRW CUBE IS APPROXIMATELY 1 ARC MINUTE WITH RESPECT TO THE OSSE CUBE.

However, because of the long period elapsed since the installation of the TRW cube during which no checks were made on its alignment (none required for assembly purposes), this cube should be checked against the OSSE reference cube as one of the last steps prior to placement on GRO. The TRW cube is bonded and mechanically clamped in place, and movement is unlikely, but a final check would be comforting.

Final measurements of each detector FOV with respect to the mounting configuration and drive reference were made once the detectors were mounted on the structure..

1.2 Final Results

Test Procedure DD150711, FIELD OF VIEW, measured the work done in DD150689 on the collimator/detector subsystems, SER EX056-017 alignment procedure, and DD150711 drive calibration. The following tables are a summary of the errors and uncertainties of OSSE:

TABLE 3-15

ALIGNMENT ERROR BUDGET VS ALIGNMENT ACHIEVED DETECTOR FIELD OF VIEW

This table relates the DETECTOR FIELD OF VIEW to the DETECTOR ROTATION AXIS. Numbers with parenthesis are forecast per SER EXO56-017. Those numbers without parenthesis are measured or estimated on the basis of observation or calculation. All values in arc minutes.

DETECTOR 1 (-X,-Y) Alignment Item	Uncertaint Scan	y (3 sigma) Cross-Scan	Error (3 sign Scan Cr	na) ross-Scan
Collimator	(0.8)	(2.06) 1.45	0	.3 *
Collimator/ Detector Cube	(0.67) 0.67	(0.67) 0.67		
Drive Backlash	(2.43) 2.43	-		
Pot Zero/Nearest Step	(0.49) 0.49	- -		
Gravity Deform- ation	(0.20) 0.20	(0.20) 0.20		
Thermal Deform- ation	(0.11) 0.11	(0.11) 0.11		
Alignment Cube Fabrication (3 cubes)	(0.17) 0.17 (0.17) 0.17 (0.17) 0.17	(0.17) 0.17 (0.17) 0.17 (0.17) 0.17		
Alignment Cube Measurements (4 measurements)	(0.05) 0.05 (0.05) 0.05 (0.05) 0.05 (0.05) 0.05	(0.05) 0.05 (0.05) 0.05 (0.05) 0.05 (0.05) 0.05		
RSS	(2.67) RSS 2.66	(2.20) 1.64	Arithmetic 1	- 1.3

^{*} No Specification

TABLE 3-16

ALIGNMENT ERROR BUDGET VS ALIGNMENT ACHIEVED: DETECTOR ROTATION AXIS

This table relates the DETECTOR ROTATION AXIS to the OSSE Y-AXIS. Numbers with parenthesis are those forecast per SER EXO56-017. The numbers without parenthesis are those actually measured. All values in arc minutes.

DETECTOR 2 (-X,-Y)	Uncertainty	(3 sigma)	Error (3	sigma)
Alignment Item	Scan	Cross-Scan	Scan	Cross-Scan
Detector Rotation Axis (10 trans- lation measurements	- -)	(.16)	-	(2.53)

The effect of Detector Rotation Axis errors may add, or subtract, from the overall OSSE instrument pointing accuracy. The contribution depends on the detector position angle, and the sign of the error values with respect to instrument coordinate convention (Theta definitions). See Figures 1 and 5.

TABLE 3-17 ALIGNMENT ERROR BUDGET VS ALIGNMENT ACHIEVED

This table relates the DETECTOR FIELD OF VIEW to the DETECTOR ROTATION AXIS. Numbers with parenthesis are those forecast per SER EX056-017. The numbers without parenthesis are those measured or estimated on the basis of observation or calculation.

DETECTOR 2 (-X,+Y) Alignment Item	Uncertainty Scan	Cross-Scan	Error (3 s Scan	igma) Cross-Scan
Collimator	(0.8)	(2.06) 0.32	0	7.15 *
Collim.cor/ Detector Cube	(0.67) 0.67	(0.67) 0.67		
Drive Backlash	(2.43) 2.00	-		
Pot Zero/Nearest Step	(0.49) 0.49	- -	·	
Gravity Deformation	(0.20) 0.20	(0.20) 0.20		
Thermal Deformation	(0°.11) 0.11	(0.11) 0.11		
Alignment Cube Fabrication (3 cubes)	0.17 (0.17) 0.17	(0.17) 0.17 (0.17) 0.17 (0.17) 0.17		
Alignment Cube Measurements (4 measurements)	0.05 (0.05) 0.05 (0.05) 0.05	(0.05) 0.05 (0.05) 0.05 (0.05) 0.05 (0.05) 0.05		
RSS Sum	(2.67) 2.22	(2.20) 0.64		

^{*} No specification

TABLE 3-18

ALIGNMENT ERROR BUDGET VS ALIGNMENT ACHIEVED: DETECTOR ROTATION AXIS

This table relates the DETECTOR ROTATION AXIS to the OSSE Y-AXIS. Numbers with parenthesis are those forecast per SER EXO56-017. The numbers without parenthesis are those actually measured. All values in arc minutes.

DETECTOR 2 $(-X, +Y)$	Uncertainty	(3 sigma)	Error (3	sigma)
Alignment Item	Scan	Cross-Scan	Scan	Cross-Scan
Detector Rotation Axis (10 trans- lation measurements of .05, RSS'd)	-	(.16)	-	(1.35)

The effect of Detector Rotation Axis errors may add, or subtract, from the overall OSSE instrument pointing accuracy. The contribution depends on the detector position angle, and the sign of the error values with respect to instrument coordinate convention (Theta definitions). See Figures 2 and 5.

TABLE 3-19

ALIGNMENT ERROR BUDGET VS ALIGNMENT ACHIEVED

This table relates the DETECTOR FIELD OF VIEW to the DETECTOR ROTATION AXIS. Numbers with parenthesis are forecast per SER EXO56-017. Those numbers without parenthesis are measured or estimated on the basis of observation or calculation.

DETECTOR 3 (+X,-Y) Alignment Item	Uncertainty Scan	y (3 sigma) Cross-Scan	Error (3 s Scan	igma) Cross-Scan
Collimator	(0.8) 1.60	(2.06) 0.97	0	4.0 *
Collimator/ Detector Cube	(0.67) 0.67	(0.67) 0.67		
Drive Backlash	(2.43) 2.22	- -		
Pot Zero/Nearest Step	(0.49) 0.49	- -		
Gravity Deform- ation	(0.20) 0.20	(0.20) 0.20		
Thermal Deformation	(0.11) 0.11	(0.11) 0.11		
Alignment Cube Fabrication (3 cubes)	(0.17) 0.17 (0.17) 0.17 (0.17) 0.17	(0.17) 0.17 (0.17) 0.17 (0.17) 0.17		
Alignment Cube Measurements (4 measurements)	(0.05) 0.05 (0.05) 0.05 (0.05) 0.05 (0.05) 0.05	(0.05) 0.05 (0.05) 0.05 (0.05) 0.05 (0.05) 0.05		
RSS Sum	(2.67) 2.88	(2.20) 1.24		

^{*} No specification

TABLE 3-20

ALIGNMENT ERROR BUDGET VS ALIGNMENT ACHIEVED: DETECTOR ROTATION AXIS

This table relates the DETECTOR ROTATION AXIS to the OSSE Y-AXIS. Numbers with parenthesis are those forecast per SER EXO56-017. The numbers without parenthesis are those actually measured. All values in arc minutes.

DETECTOR 3 $(+X, -Y)$	Uncertainty	(3 sigma)	Error (3	sigma)
Alignment Item	Scan	Cross-Scan	Scan	Cross-Scan
Detector Rotation Axis (10 trans- lation measurements of .05, RSS'd)	-	(.16)		(2.13)

The effect of Detector Rotation Axis errors may add, or subtract, from the overall OSSE instrument pointing accuracy. The contribution depends on the detector position angle, and the sign of the error values with respect to instrument coordinate convention (Theta definitions). See Figures 3 and 5.

TABLE 3-21

ALIGNMENT ERROR BUDGET VS ALIGNMENT ACHIEVED

This table relates the DETECTOR FIELD OF VIEW to the DETECTOR ROTATION AXIS. Numbers with parenthesis are forecast per SER EXO56-017. Those numbers without parenthesis are measured or estimated on the basis of observation or calculation.

DETECTOR 4 (+X,+Y) Alignment Item	Uncertainty Scan	Cross-Scan	Scan	3 sigma) Cross-Scan
Collimator	(0.8) 0.17	(2.06) 0.35	0	4.6 *
Collimator/ Detector Cube	(0.67) 0.67	(0.67) 0.67		
Drive Backlash	(2.43) 2.55	-		
Pot Zero/Nearest Step	(0.49) 0.49	-		
Gravity Deform- ation	(0.20) 0.20	(0.20) 0.20		
Thermal Deformation	(0.11) 0.11	(0.11) 0.11		
Alignment Cube Fabrication (3 cubes)	(0.17) 0.17 (0.17) 0.17 (0.17) 0.17	(0.17) 0.17 (0.17) 0.17 (0.17) 0.17		
Alignment Cube Measurements (4 measurements)	(0.05) 0.05 (0.05) 0.05 (0.05) 0.05 (0.05) 0.05	(0.05) 0.05 (0.05) 0.05 (0.05) 0.05 (0.05) 0.05		
RSS Sum	(2.67) 2.71	(2.20) 0.85		

^{*} No specification

TABLE 3-22

ALIGNMENT ERROR BUDGET VS ALIGNMENT ACHIEVED: DETECTOR ROTATION AXIS

This table relates the DETECTOR ROTATION AXIS to the OSSE Y-AXIS. Numbers with parenthesis are those forecast per SER EXO56-017. The numbers without parenthesis are those actually measured. All values in arc minutes.

DETECTOR 4 (+X,+Y)	Uncertainty	(3 sigma)	Error (3 s	igma)
Alignment Item	Scan	Cross-Scan	Scan	Cross-Scan
Detector Rotation Axis (10 trans- lation measurements of .05, RSS'd)	-	(.16)	-	(2.53)

The effect of Detector Rotation Axis errors may add, or subtract, from the overall OSSE instrument pointing accuracy. The contribution depends on the detector position angle, and the sign of the error values with respect to instrument coordinate convention (Theta definitions). See Figures 4 and 5.

THE FOLLOWING FIGURES (3-9 through 3-12) SHOW THE FOLLOWING ALIGNMENT ERRORS FOR EACH DETECTOR (A1 THROUGH A4):

- 1 Tilt of collimator out of perpendicularity with detector rotation axis. In the OSSE coordinate system, this angle changes at different scan angles.
- 2 Misalignment of FOV long axis with respect to scan axis.
- 3 and 4 Misalignment of detector rotation axis (theta-X and Theta-Y) with respect to OSSE Y-axis.

FIGURE 3-9: DETECTOR A1 ALIGNMENT ERRORS

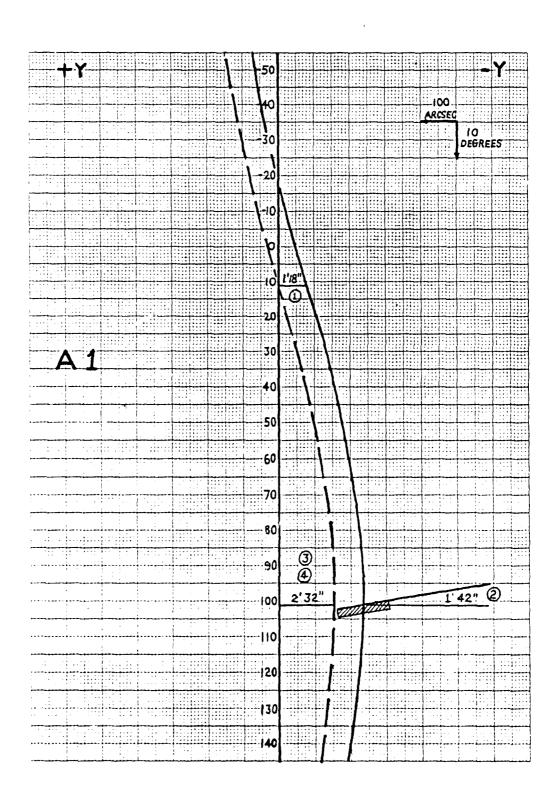


FIGURE 3-10: DETECTOR A2 ALIGNMENT ERRORS

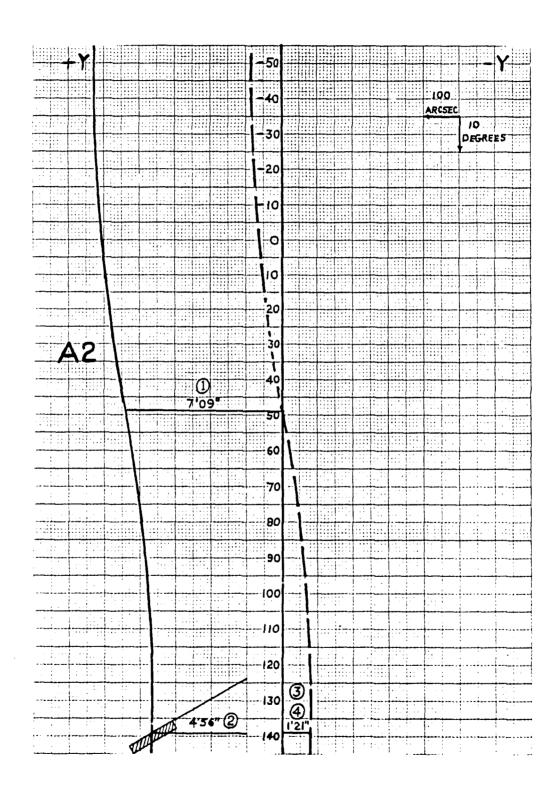


FIGURE 3-11: DETECTOR A3 ALIGNMENT ERRORS

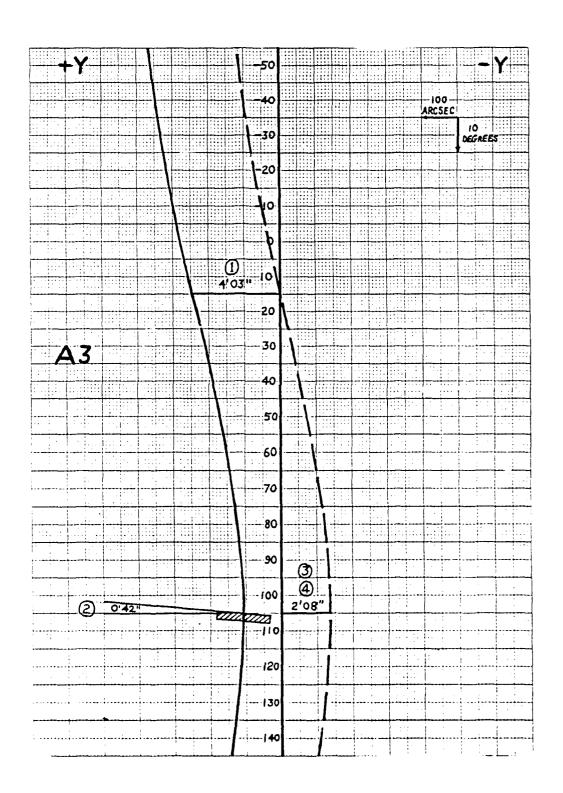
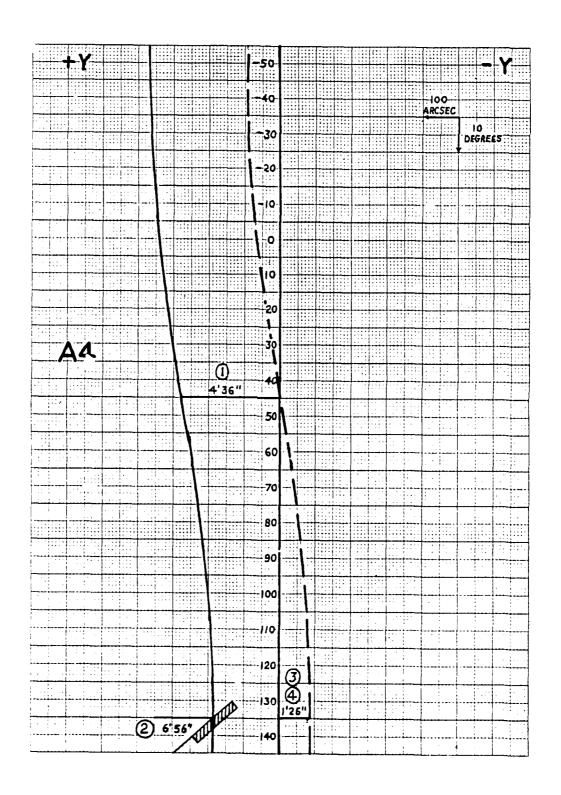


FIGURE 3-12: DETECTOR A4 ALIGNMENT ERRORS



3.0 DETECTUR FOV WITH RESPECT TO OSSE AXIS

3.1 Collimator Tilt With Respect To The Detector Rotation Axis

Result: Conical Scan

How Much: Detector 1: 1.3 arc minutes (cone in -Y hemisphere)

Detector 2: 7.15 arc minutes (cone in +Y hemisphere)

Detector 3: 4.0 arc minutes (cone in +Y hemisphere)

Detector 4: 4.6 arc minutes (cone in +Y hemisphere)

Requirement: None

Causes: a. Collimator orthogonality errors, systematic.

b. Detector housing machining tolerances.

c. Potential, though small, for distortion of the detector housings resulting from pre-loads of the shield and phoswich crystals.

d. No adjustment capability for placement of the collimator in the detector housings.

In figures 3-9 through 3-12, the conical skews are shown as the distances between the solid line sweep of the measured collimator FOV and the dotted line sweep of a 'perfect' colimator with respect to the axis of rotation.

3.2 Long/Short Axis Not Orthogonal To Scan Axis, Instrument Axis, Or Both.

Result: May reduce area overlapped with other detectors at the same scan angle.

How much: Detector 1: -2.2 arcmin (collimator rotated CW viewed from +Z)

Detector 2: -4.93 arcmin

Detector 3: 0.7 arcmin

Detector 4: -6.93 arcmin

CW

CW

Requirement: None

Causes: Detector housing and colimator machining tolerances. For

example, one arc minute of collimator rotation about the Z-axis

is equivalent to only .002" at the detector/collimator

interface radius.

In figures 3-9 through 3-12, the exaggerated rotation of the rectangular box about the scan plane represents this condition.

- 4.0 DETECTOR ROTATION AXES WITH RESPECT TO OSSE AYES
- 4.1 Detector Axis Not Coinciding With OSSE Y Axis, Rotated About X-Axis

How Much: Detector 1: -0.60 arcmin (these values are Theta X errors)

Detector 2: -1.00 arcmin Detector 3: -0.43 arcmin Detector 4: -1.01 arcmin 4.2 Detector Axis Not Coinciding With OSSE Y Axis, Rotated About Z-Axis

How Much: Detector 1: -2.46 arcmin (these values are Theta Z errors)

Detector 2: -0.83 arcmin Detector 3: -2.08 arcmin Detector 4: -1.02 arcmin

4.3 Combined Detector Axis Misalignment

Detector 1: 2.53 arcmin
Detector 2: 1.35 arcmin
Detector 3: 2.13 arcmin
Detector 4: 1.43 arcmin
Requirement: 3.00 arcmin

Result of 5.1 and 5.2: The detector oscillates sinusoidally about the Instrument Y-axis.

Causes: Assembly tolerances, variation of instrument mounting surface, placement and removal of thermal isolation blocks, etc.

In figures 3-9 through 3-12, the broken soid line represents the plane perpendicular to the detector rotation axis.

THE FOLLOWING FIGURES SHOW DETECTOR MISALIGNMENTS IN THE Y-Z PLANE (FIG 3-13) AND THE X-Z PLANE (FIG 3-14):

FIGURE 3-13: Y-Z PLANE MISALIGNMENTS

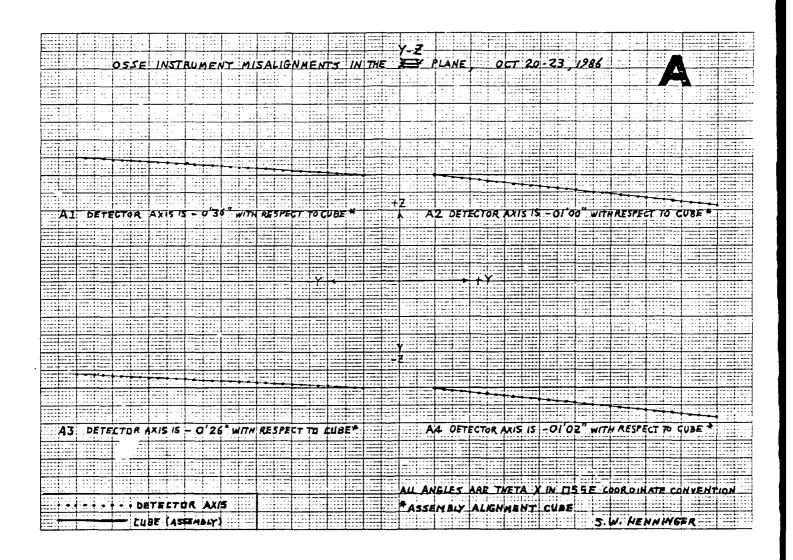
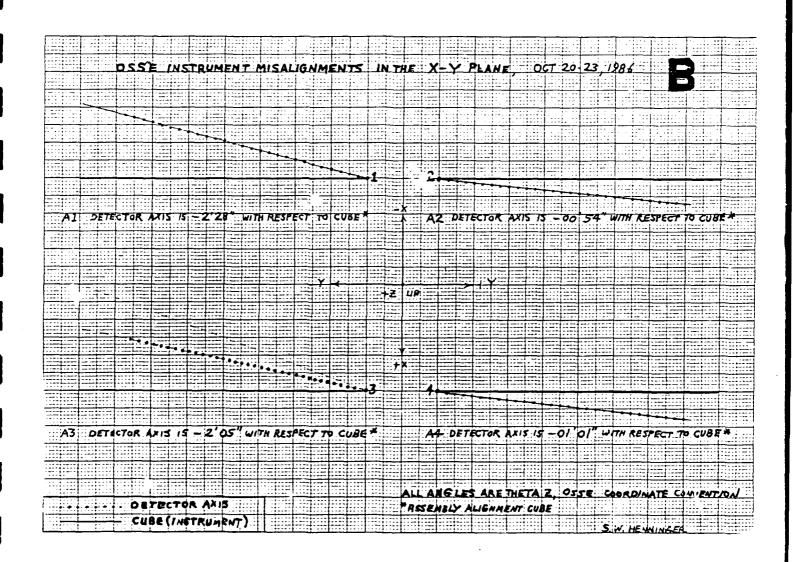


FIGURE 3-14: X-Z PLANE MISALIGNMENTS



- 4.4 Compliance Of Results To Requirements (1.0 ALIGNMENT OBJECTIVE):
- a) The center of the FOV shall be known to <= 6.0 arc minutes (3.0 arc minutes allotted to internal OSSE uncertainty of detector FOV to the mounting surface in the X-Z (scan) plane), and known to <= 8.0 arc minutes in the cross-scan plane (with 5.0 arc minutes allotted to internal OSSE alignment uncertainty of detector FOV to the mounting surface in the X-Z (scan) plane.

b) The center of the detector FOV relative to the cryatal housing must have an uncertainty <= 1.0 arc minute in the X-Z (scan) direction and three arc minutes in the perpendicualr (cross-scan) direction.

- * The collimator for this detector was measured per DD150689 on 6/24/85, one of the first fabricated (iginally designated the engineering model) and the first measured. It is possible that the early measurements had larger uncertainties due to early production methods, or due to early measuring methods resulting in greater measured variances.
- c) Each detector subsystem must be positioned in the structure so that its rotation axis <= 3.0 arc minutes of the OSSE Y axis defined by the optical reference cube (known to <= 1.0 arcminute)

```
Detector 1: 2.53 arc min (uncertainty 0.5 arc min) YES
Detector 2: 1.35 arc min "YES
Detector 3: 2.13 arc min "YES
Detector 4: 1.43 arc min "YES
```

5.0 POT LINEARITY AND STEP SIZE CALJBRATION

Test procedure 150704, Proof Mode Drive Calibration, section 6 and data sheets 2A and 2B measured step size and step uniformity for each of the four detector motor drives. The absence of a braking pulse at the time of measurement just prior to hardware/software integration (DD156416) resulted in variations of individual step sizes from one step to the next, but the overall linearity of the pots, and the average step lengths (3.333 arc min) was verified optically during these tests and confirmed later in SYSPOTLIN

ATP's associated with baseline and subsequent functionals. Individual step size was verified in SYSPOTLIN ATP's run during subsequent functionals. Once the long braking pulse was functional, step size was consistant for all drives.

SEE FIG RES 3-15 through 3-25. They illustrate pot value linearity with respect to measured angle for each drive system.

FIGURE 3-15 POT VS ANGLE DETECTOR A1

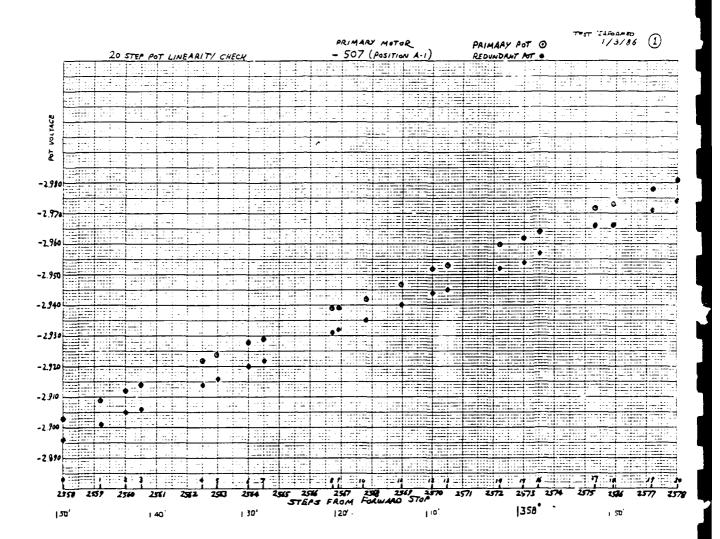


FIGURE 3-16 POT VS ANGLE DETECTOR A1

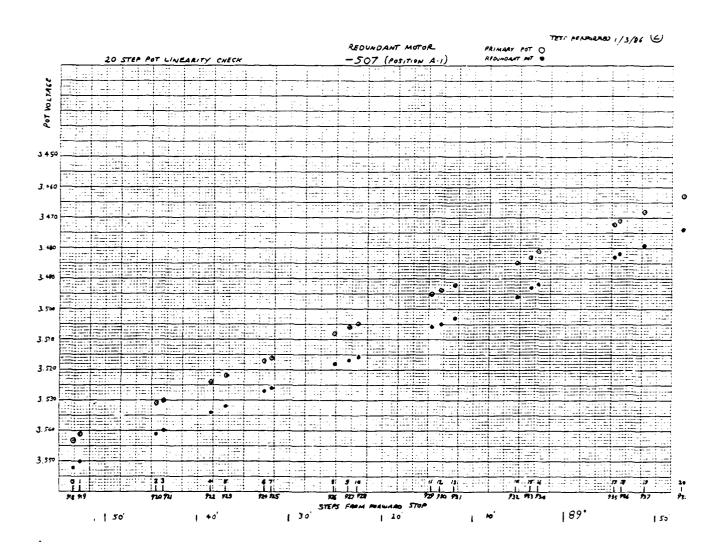


FIGURE 3-17 POT VS ANGLE DETECTOR A1

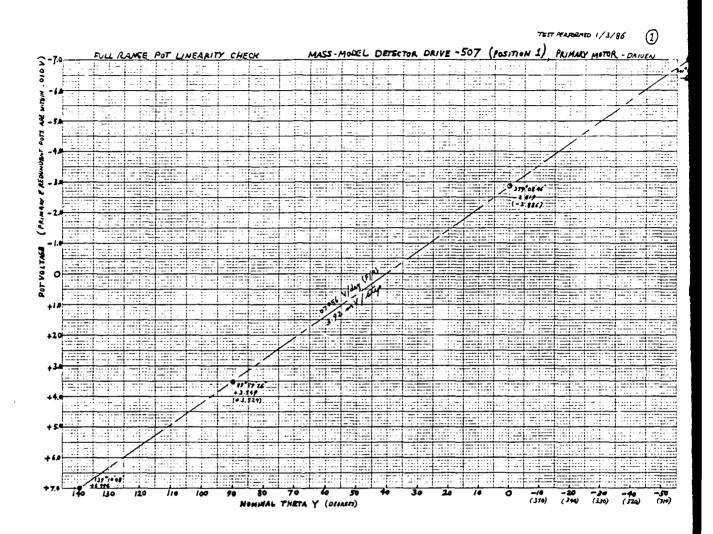


FIGURE 3-18 POT VS ANGLE DETECTOR A2

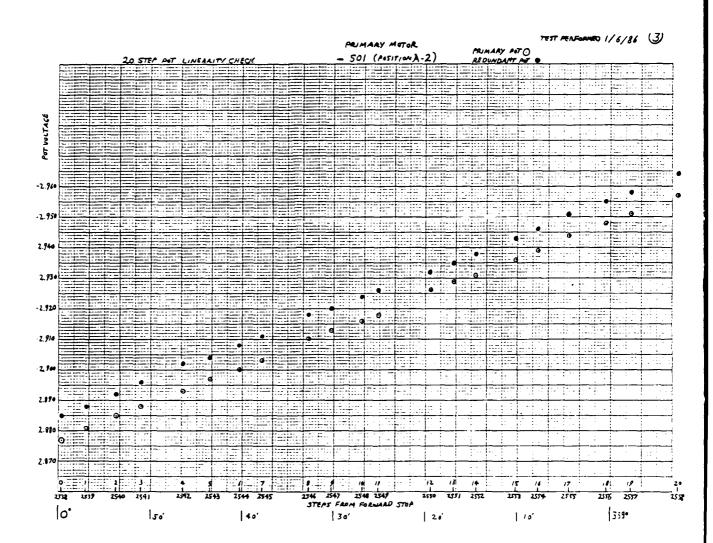


FIGURE 3-19 POT VS ANGLE DETECTOR A2

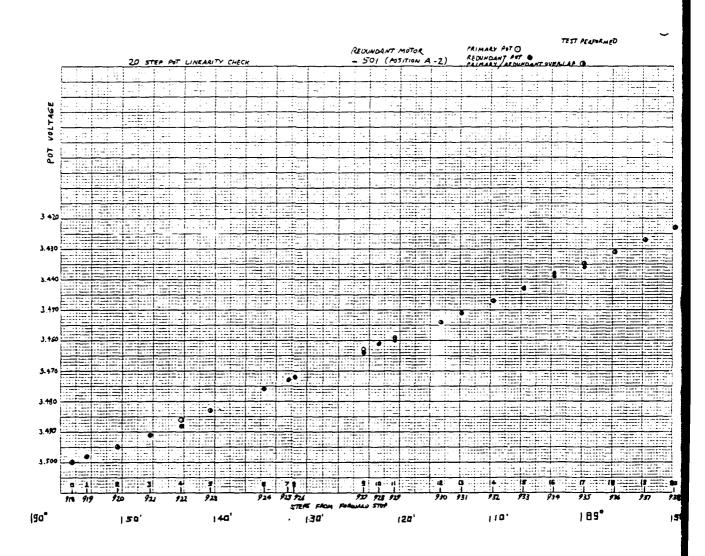


FIGURE 3-20 POT VS ANGLE DETECTOR A2



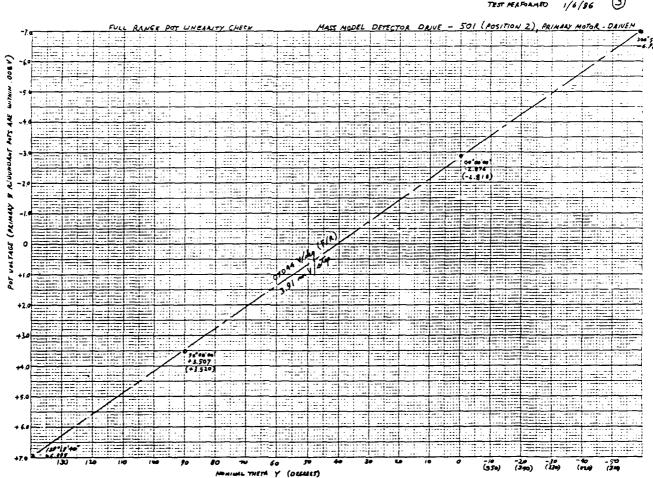


FIGURE 3-21 POT VS ANGLE DETECTOR A3

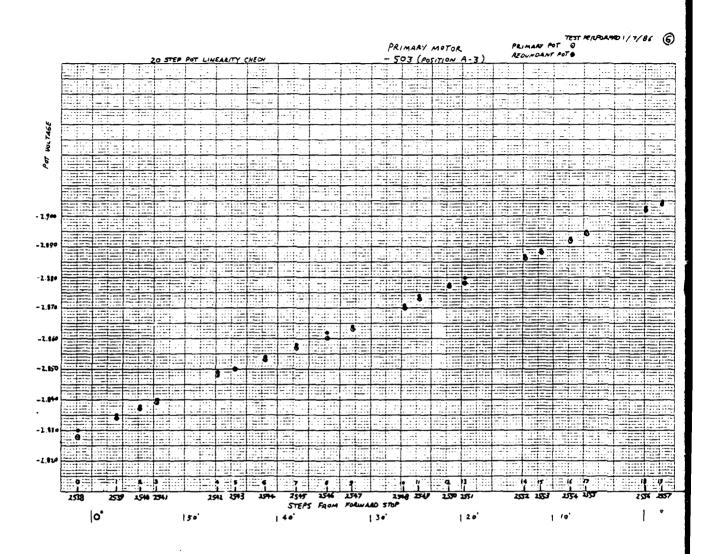


FIGURE 3-22 POT VS ANGLE DETECTOR A3

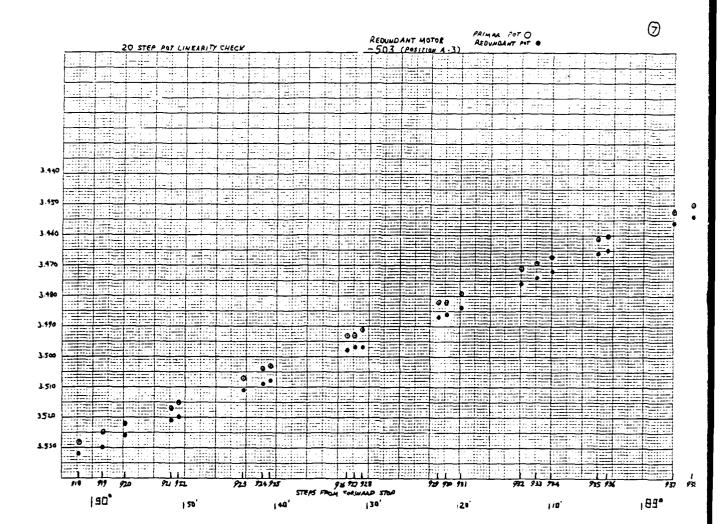


FIGURE 3-23 POT VS ANGLE DETECTOR A3

(9) 88/7/1 CAMOUNED TEST

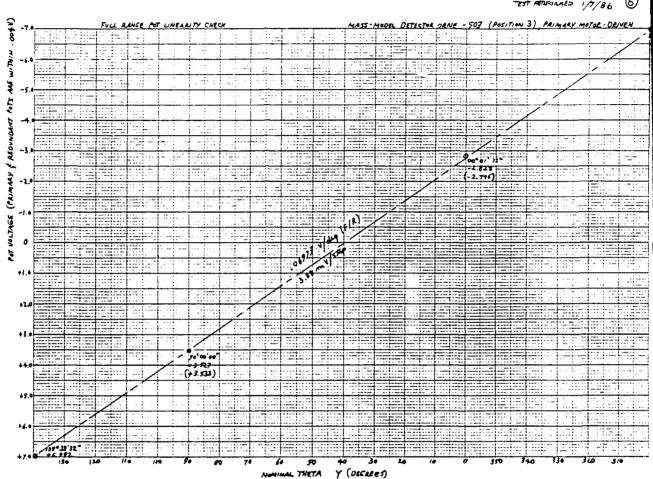


FIGURE 3-24 POT VS ANGLE DETECTOR A4

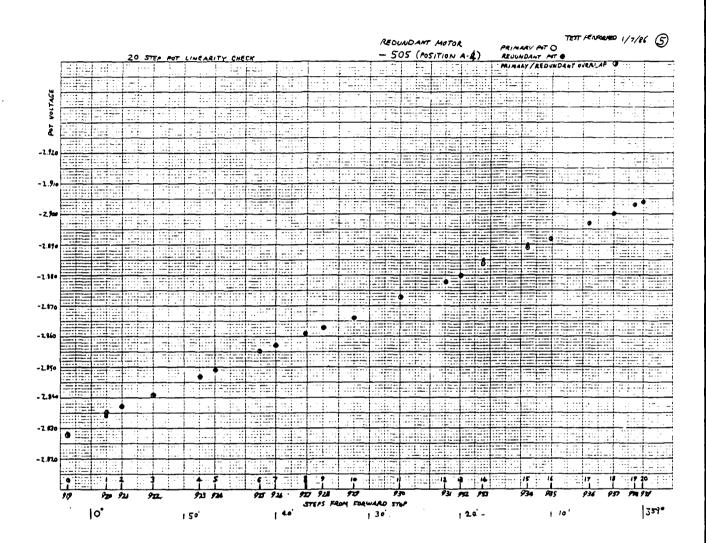
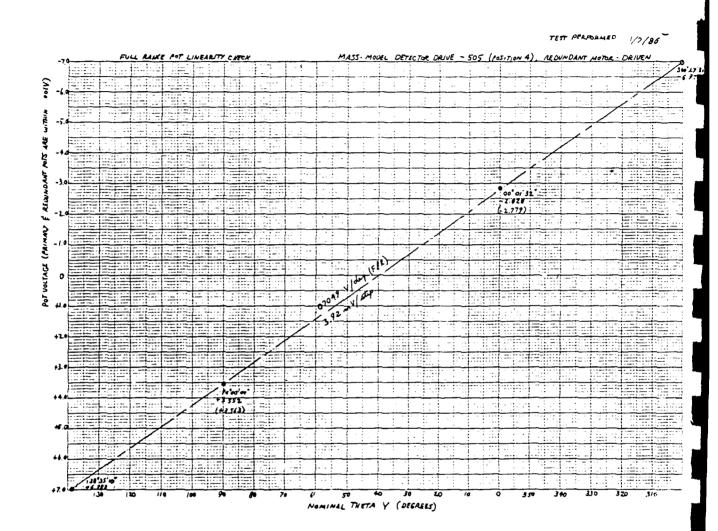


FIGURE 3-25 POT VS ANGLE DETECTOR A4



5.0 AIMS STRUCTURE SURVEYS

The OSSE Instrument was surveyed on the following occasions, using targets affixed to various points on the inboard and outboard members of the structure:

Date	Structure Config	Occasion	Mount	Results
04/ /85	No Load	Pre-Modal, Static	Pit	*
07/29/85	Mass-Model Load	Pre-Modal, Static,	Pit	
08/06/85	Static Load Test, Three Days	Static Load Test #7	Pit	
09/26/85	Mass-Model Load	Post-Modal, Static,	Pit	
10/02/85	No Load	Post-Modal, Static	Pit	
11/14/85	No Load	Transition to Dolly	Dolly	*
11/21/85	Motor Drives Only	Mounting of Motor Drives	Dolly	
11/22/85	Motor Drives and Mounting Hardware	Before Mounting Mass Models	Dolly	**
11/25/85	Mass-Model Load	After Mounting Mass Models	Dolly	** ***
10/15/86	Complete Instru- ment, Flight Hardware, On Ther- mal Iso-Blocks	Complete Instrument Configuration On Thermal Isolation Blocks	Dolly	
04/18/87	Complete Instrument, Flight Hardware, No Thermal Iso-Blocks	Complete Instrument Hard Down On Doily Pads	Dolly	***

- Surveys evaluated in SER EXOS6A 451. It said that the bare structure was not significantly bent, compressed, or stretched between April and November, 1985 a period of much handling and structural testing.
- ** Surveys evaluated in SER EXO56A 450. It said that the structure undergoes little deformation between an unloaded and a loaded state, and that detector axis rotations remain about the same. These results indicate a negligible alignment change will occur when OSSE is in zero-G in space, providing the instrument mounting interface remains stable.
- *** Surveys evaluated in Figure 11. Fewer targets were visible from the vantage points the two AIMS theodolites surveying the final configuration of OSSE on 04/18/87. The few targets that could be compared to the mass-model configuration of 11/25/85 indicated no

significant distortion of the structure, but several consistent changes appeared in the vectors between targets. These are:

- a. Vector between targets 10 and 14 -.0085 in.
- b. Vector between targets 5 and 10 -.0105 in.
- c. Vector between targets 8 and 10 -.0108 in.

An analysis was made to verify that the baseline targets located over the four +X footpads (targets 5, 8, 11, and 14 on Figure 11)had not changed significantly with respect to each other in the Y and Z component measurements. They correlated to within less than .002 inch. The conclusion drawn by these anomalies is that target 10 on the center structure was not accurately measured in the survey of 4/18/87 because it was partially obstructed with respect to one of the theodolites, and the measurement was degraded. Since the rotation axes measured in test procedure 150711 did not show a corresponding change. It is unlikely that a distortion of the center structure occurred.

d. Vector between targets 7 nd 14 +0326.

This change indicates a large movement of the upper outboard -Y structural member toward the -Y. This area of the structure is not rigidly constructed in the Y axis and account for the large movement. Since the float is in the direction of the Y-axis, no alignment change is expected for deflections of this magnitude.

Measurement uncertainties develop from the AIMS repeatability about .002^m, from the geometry of the setup (sighting angle, distance from target), and the peculiarities of different operators.

3.5 SYSTEM-LEVEL ENVIRONMENTAL TESTS

3.5.1 PROOF MODEL STRUCTURE TESTS

This report summarizes the procedures and results of performing tests on the completed OSSE structure, loaded with mass models prior to installation of, and substituting for, the detectors, Central Electronics (CE), and Charged Particle Monitor (CPM) flight subsystems. The detector drive and bearing flight subsystems were included as part of the OSSE proof model.

The purpose of these procedures was to certify the OSSE structure for flight, and the following tests were performed for this purpose: 1) Modal Survey per test procedure DD150707, 2) Static Load per test procedure DD150714, and 3) Proof Model Acoustic test per procedure DD150706.

3.5.1.1 PROOF MODEL MODAL SURVEY TEST

The OSSE Proof Model Modal Survey test was performed per test procedure DD150707 during the May-June, 1985 time period. A report on this test authored by David W. Paule, BASD/OSSE Senior Analyst, is excerpted here as a summary of this test, and begins here:

The full OSSE system is composed of a thermal shell, four gamma ray detector subsystems, a central electronics box, and the primary structure. The thermal shell, the detectors, and the central electronics box were qualified separately from the primary structure, and not included in this discussion.

The primary structure was modeled in NASTRAN, as shown in figure A. The detector subsystems were replaced by dummy masses, as well as the central electronics box and another, smaller (drive electronics) box. The dummy masses in reality were large bars of steel. The bearings and stub axels were real flight units. The flight gearboxes were included in the test to have the proper mass and because they were already installed.

The OSSE structure was mounted in the BASD Modal Survey Pit. To correct for minor irregularities in the pit floor, short aluminum blocks were used as spacers. They were stiff enough so that they had a negligible effect on the results.

A series of data files was generated from the final pre-test NASTRAN modes run. These files described the expected motion of each of the first eight modeshapes. The files were sent to the data acquisition computer at the Modal Survey Pit laboratory, to aid in the real-time evaluation of the testing.

The accelerometer locations, shown in Figure 3, had been picked earlier based on the expected mode-shapes and the known mass distribution. Note that the dummy detector masses had accelerometers located across the diameter from each other, to pick up any rotation present, and to avoid mixing rotation and translation responses.

The test sequence was to adjust the input level of the random vibration to the minimum necessary to get a good response. Generally this worked out to about 10 pounds of force. The number of data channels available led to running each input location twice, and moving the accelerometers and

reverifying the data acquisition setup.

The initial input location was the top center back of the center pedestal assembly. The initial results and input were limited to the Y direction, and that included the first two modes. Sufficient data was available to indicate that a better input location should be found. Several locations were tested by using an instrumented hammer to strike the structure and monitoring the accelerometer response from several locations around OSSE. The shaker was moved to node 517 as a result of this, and oriented to shake in the Y and subsequently the X direction.

The first, second, and fifth modes were found in this pass. The initially predicted modes and test modes and final NASTRAN modes are shown in Table 1.

The next input location was back at the top center, oriented in the X direction. The third and fourth modes were not sufficiently distinct from each other using this location, but the sixth and seventh modes were obtained.

The use of the instrument hammer led to fixing the shaker to a large massive block of steel and hanging it from a crane so that a Z vibration could be input on the centerline between the two lower forward detector gearboxes. This brought out the fourth mode, and when the shaker was relocated to the center back of OSSE, we got the third. For these, the data was collected over a bandwidth only ten Hertz wide, for better definition. The final data needed was obtained by using the instrumented hammer to strike the dummy detectors in a tangential direction, to find the frequencies of rotation. These are shown in Table 2.

DESCRIPTION OF THE MODEL REVISION

The (NASTRAN) revision process was performed using a computer program called MODALA.FOR over a week and a half period, and composed of about a dozen iterations.

The OSSE instrument uses angular contact bearings to support the detectors, and the flight bearings were used on the modal survey test. They were modeled as spring elements, such that each of the six components at each of the eight bearing locations had a single spring element. Angular contact spring stiffnesses are a function, among other things, of the preload applied. The bearings had been analyzed earlier with the BASD propriatary program BRGSTR, and representative spring rates were used in the model. Since the bearing preload is subject to manufacturing tolerances, the preload, and hence the stiffness, varies somewhat from spring to spring. The strain energy output, and knowledge of the actual frequencies involved, greatly aided the spring rate revision.

The first revisions changed the spring stiffnesses of the springs which represented the rotational stiffnesses of the gearboxes and removed most of the moment flexibility which had been at the joints of some of the elements.

Succeeding revisions lowered the stiffnesses of the aft diagonal strut and the back plate. These are the two portions of the structure which most contribute to the lateral stiffness. The modulus of the forward diagonal plate was increased. The plates of the center structure are revited

together using standard extruded angles at the joints. These angles are not designed to dump axial load into the structure, because they have essentially no end fixity, and so an improvement in the model was to greatly reduce their effective area.

In the real structure, many of the bars end in a simple bathtub fitting. Typically, one to three bolts go through the plate end of the fitting to make the connection. There are no splice plates across the flanges or web of the bar (all the bars are C channels) to carry moment loads. As a result, most of the bars had been modeled as being pin ended at the bolted end. The bolts, of course, were assembled with a considerable preload.

At the very low loads induced during the modal survey test, it was found that the joints actually behaved as if they were capable of carrying moment. The load path was simply a result of the direct contact pressure between the end of the bar and the mating surface. The plate end flexibility, while it had to be accounted for, had not as great an effect as had been expected, due to the effective bar cross-section acting at the mating surface.

The NASTRAN model was made with most of these joints having a short section of bar at the joint. That is, most of the bar would be one continuous member, and it would end with a second short member. This is shown in figure 4, at the lower edge of the side support assemblies, where short stubs are visible. The lower ends of these are the outer interface points, which were originally modeled with moment flexibility, and which had moment stiffness added, but the stiffness reduced compared to the bar stiffness in the surrounding structure.

It should be remembered that the preload of the bolts at the joints must be sufficient to at least maintain the fixity of the joint to the desired joint load, if this type of connection occurs.

Other changes included reducing all of the modulii of elasticity by about two percent and reducing the stiffness of the vertical members of the side support structure al little bit. A final change was to reduce the effective thickness of an area where the inboard detector trunnions mount to the side wall panels with a partial bolt ring.

These changes brought the frequencies of the first six modes of the NASTRAN model to within four percent of the test modes. The normalized cross orthogonality check is ablut twelve percent or less within that set of frequencies, except for the fourth mode, which is about twenty-one percent, as shown in Table 3.

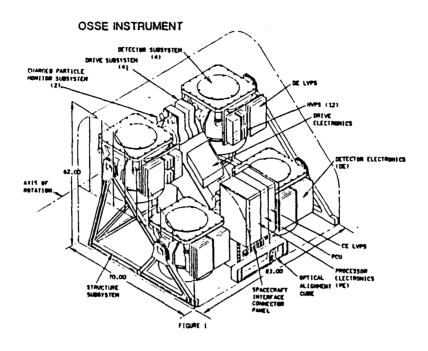
CONCLUSIONS

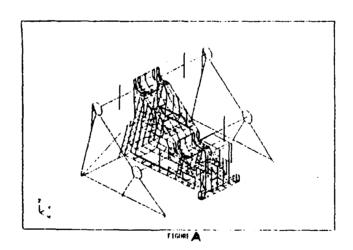
The structural modeling effort needs to be planned from the beginning with an eye towards the changes that will be needed as a result of the modal survey test. Bars should have short end segments so that the effective fixity can be adjusted, and the manner that the joints are modeled should be scrutinized closely.

The use of the strain energy option is quite handy as an aid in moving around the structural model when deciding what to change and how.

A firm grasp of the real structure and how it is modeled is essential. Where possible, real weights rather than estimated weights should be in the model.

FIGURE 3-26 OSSE PROOF MODEL MODAL SURVEY





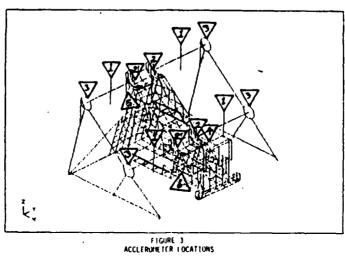


TABLE 3-23 OSSE PROOF MODEL MODAL SURVEY

TABLE 1

INITIAL NASTRAN PREDICTION	TEST RESULT	FINAL NASTRAN FREQUENCIES	SHAPE
27.4	26.98	27.43	CANTILEVER, ±Y
34.3	38.54	37.69	2ND Y MODE
38.5	44.54	44.58	LWR DETECTOR MOTION PARALLEL TO SLANTED SURFACE
40.5	45.03	45.34	LWR DETECTOR MOTION PERPEN- DICULAR TO SLANTED SURFACE
53.5 (60.3, 62.9)	61.70	61.38	ROTATION ABOUT Z AXIS
65.1	77.89	75.08	X UPPER

TABLE 2
DUMMY DETECTOR ROTATIONAL FREQUENCIES

PREDICTED	TEST
11.5 hz	14.9
	12.2
	16.7
	14.0

TABLE 3

MODE	MODE FREQUENCY TEST	NORMALIZED CROSS ORTHOGONALITY CHECK, PERCENT	NASTRAN FREQUENCY COMPARISON, PERCENT
1	26.98	12.0	1.7
2	38.54	10.0	-2.2
3	44.54	4.3	0.1
4	45.03	21.1	0.7
5	61.70	9.3	-0.5
6	27.89	5.9	-3.6

3.5.1.2 PROOF MODEL STATIC LOAD TEST

The OSSE Proof Model Structure was static-load tested in accordance with the procedure described in DD150714. Originally, six separate static-load test configurations were planned. Two tests, #7 and #14, were actually run, both in August, 1985. The tests were done at the conclusion of the modal survey test described in 3.5.1.1, with the structure and the same flight (motor drives, detector bearings and axle stubs) and non-flight items (dummy masses for CE, Drive Electronics, and Detectors) in place. The site of these tests was the BASD modal survey pit, with the structure bolted to ten stiff aluminum blocks machined to compensate for the irregularities of the pit floor.

The structure was surveyed by the AIMS system, which measured the position of targets placed on the outboard and center structure members. This was done both before and after mounting the dummy masses, and data reduction determined that the movement of the rotation axes (depression of the structure) was < .008 in the -Z direction, and negligibly in all other directions from Zero to One G. (Ref SER EXO56A-450).

Strain gages (25 total) were installed on the structure, 18 single gages on the -Y outboard structure member, three Rosette gages on the center pedestal, two Rosettes on each side of the front support, and two axial strain gages, also on the front support. See FIGURE 3-27-1.

The two static load tests selected, #7 and #14 combined, demonstrated the strength of all portions of the OSSE structure. (See memorandum from Stephen J. Brodeur, Acting Head, Structural Loads and Analysis Section, GSFC). TABLE 3-24 (A and B) summarize the applied forces, and FIGURE 3-27-2 shows the typical setup, in this case, of Test #7.

For each of the two tests, the specified loads for the test were applied incrementally and simultaneously, then relaxed, so that an AIMS 'quick-look' of selected targets could verify the magnitude and nature of structural deformation under load, whether failures of any sort were developing, and whether the structure was returning to its original set upon relaxation. Strain gage data aided in this evaluation as well. Each time the forces were relaxed, a visual inspection of the structure was made for crack formation.

The successful completion of the static load certification tests for the OSSE structure, upon examination at the conclusion of the 100 percent application of the loads specified for tests # 7 and #14, was satisfied by 1) the absence of any cracks or other evidence of metal failure in any structural member or of any bolts, rivets, nuts, locking elements, etc, verified by visual inspection, 2) the absence of any significant permanent deformation of the structure, particularly that which might change detector axial rotation, verified by the AIMS surveys taken before, during, and after static load test series, and 3) the absence of any degradation of the mechanical performance, specifically, of the detector drive subsystems, verified by functional tests.

All three criteria were met upon completion of the static load test series. Refer to SER EXO56-451, describing OSSE structural movements resulting from assembly, handling, and testing between April and November, 1985. The test data sheets from test procedure DD150714, strain gage readouts, and AIMS survey results have been retained for permanent record.

TABLE 3-24 OSSE PROOF MODEL STATIC LOAD TEST

:			/2	, ,				
CYLINDER F.D.	R I.D.	25%	50 %	60%	60% 70%	308	30%	100 %
Cylinder # 1	2040 165	419	1243	1492	1740	6861	1221	±75 2486
POSITION "B"	PRLSSUKE PSIS	175	35∅	42¢	490	560	630	700
Cylinder #2 H. BEF-2	2010 105	1372	2744	3293	3842	4390	4939	± 165 5488
"] : NOV 1500	PR255UKE P5.9	40X	800	096	1120	1280	1440	1600
Cylinder "3 13-19	20AD 1195	1168	2935	2755	4109	76917	5783	5870
POSITION: "E"	121551112E 7519	770	440	540	679	715	805	895
Cylinder #1 H.SA	163 165	678 678	1355	1626	1897	2168 1168	2439	27 10
POSITION: "H"	PRESSURE PS.G	41 <i>Ø</i>	820	980	1150	1310	1470	1630
Cylinder "5 H-SA	40AD 1.015	1222	2445	2933	3422	11662	1400	4889
POS, 110N. G.	P1255URS.	740	1480	01110	2060	2360	7660	2950
Cylinder 6 B-17		2001	4003	1803	5604	6404	5071	8005
	PR155URE 75.19	3005	019	730	850	970	0121 0601	1210

0556 STM . LOADS 7657 7

FIGURE 3-27-1 OSSE PROOF MODEL STATIC LOAD TEST

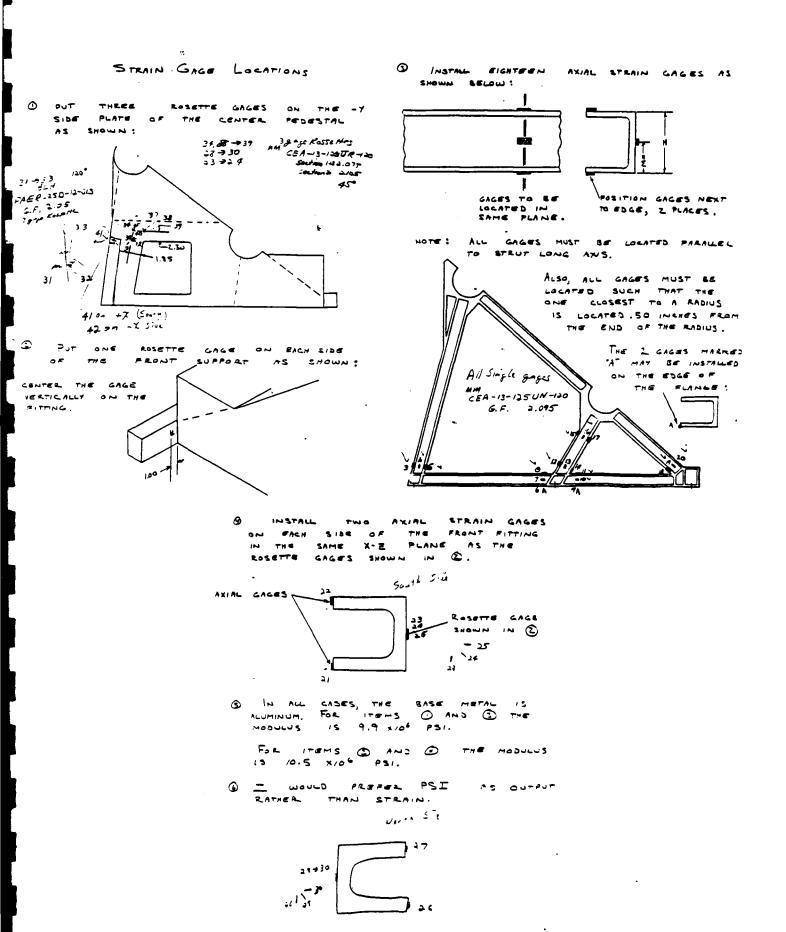
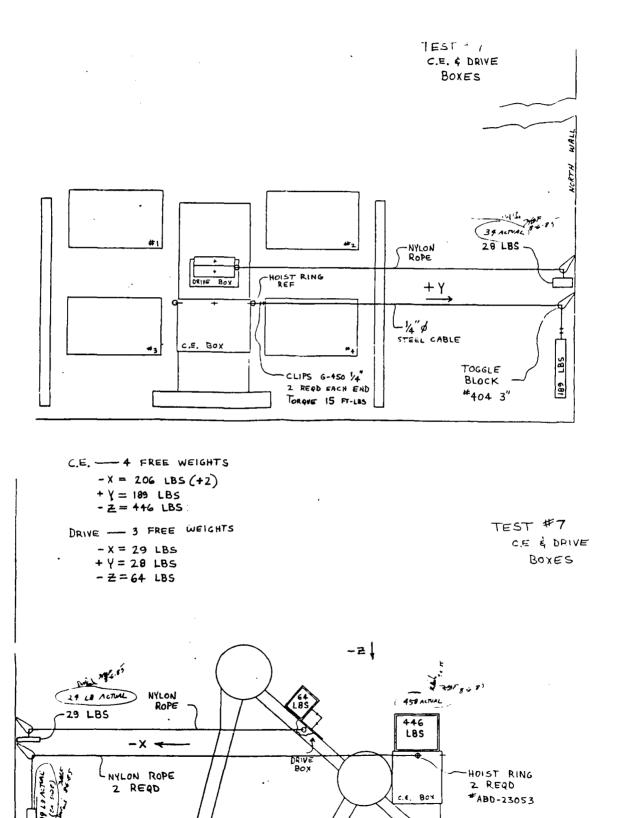


FIGURE 3-27-2 OSSE PROOF MODEL STATIC LOAD TEST



I WEIGHT EACH SIDE OF C.E. BOX

3.5.1.3 PROOF MODEL ACOUSTIC TEST

The Proof Model Structure Acoustic test was performed in September, 1985, at the conclusion of the static-load test series.

The OSSE structure, loaded with the Detector, Central Electronics and Drive Electronics dummy mass simulators, was lifted out of the modal survey pit with the use of the OSSE lifting sling (ref DD150664, Instrument Handling Procedure) after the lifting sling was load-certified. The OSSE Proof Model Structure was placed on the OSSE handling dolly and secured by non-flight bolts at the ten footpads.

The OSSE structure, with simulated loads, was shipped on the handling dolly by truck to the Martin-Marietta acoustic test facility in Littleton, CO. The test procedure in effect was DD150706. A detailed summary of the OSSE flight instrument acoustic test procedure, section 3.5.5, describes the performance of the flight unit acoustic test. This report may, except for dates and certain specifics such as pre- and post-functionals, be indicative of the activity that characterized the OSSE proof model acoustic test, except that test instrumentation was far less comprehensive, and certain aspects of handling, while the requirements were specified for the proof model structure, were not nearly so stringent for this acoustic test as they were for the flight instrument, obviously because of the inherent sensitivity of the detector subsystems, as well as the added value of the completed instrument.

The accelerometers used were the same as for the modal survey, and their positions are shown in FIGURE 3-28-1. Table 3-25 shows the OSSE Qual-Acoustic Excitation Profile, duration 1 minute. Figure 3-28-2 shows the 1/3 octave band frequencies of the actual one minute run.

Examination of the OSSE structure revealed no physical evidence of damage of any sort. A post-acoustic drive functional revealed that the drives all functioned normally. No damage occurred to any OSSE-related equipment, flight and non-flight, during shipment between the BASD and Martin test facilities, nor were there any mishaps of any sort in shipment and handling.

FIGURE 3-28-1 OSSE PROOF MODEL ACCELEROMETER LOCATIONS

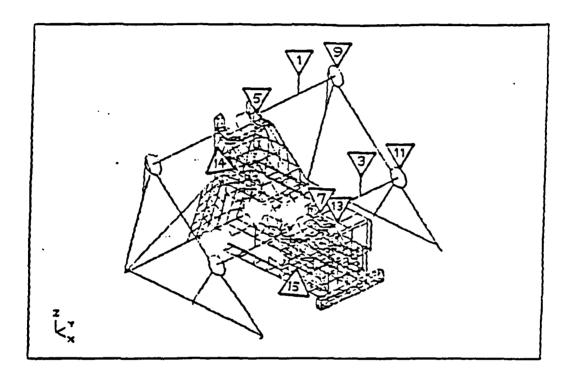


TABLE 3-25 OSSE QUAL-ACOUSTIC EXCITATION PROFILE

DURATION

1 MINUTE
Sound Pressure Level
(dB re. 20 micro N/m2)
125
128
130.5
131.5
132
132
132
132
132
132
132
130.5
128.5
127
125
123
121.5
119.5
118
116
114.5
112.5
111
109
107.5

Tolerances: Sound Pressure Level -- 1/3 Octave Band <u>*</u> 3dB -- Overall <u>*</u> 1.5dB

Some third-octave points above $500~{\rm Hz}$ may be out of spec. These will be minimized to the best facility capability.

106

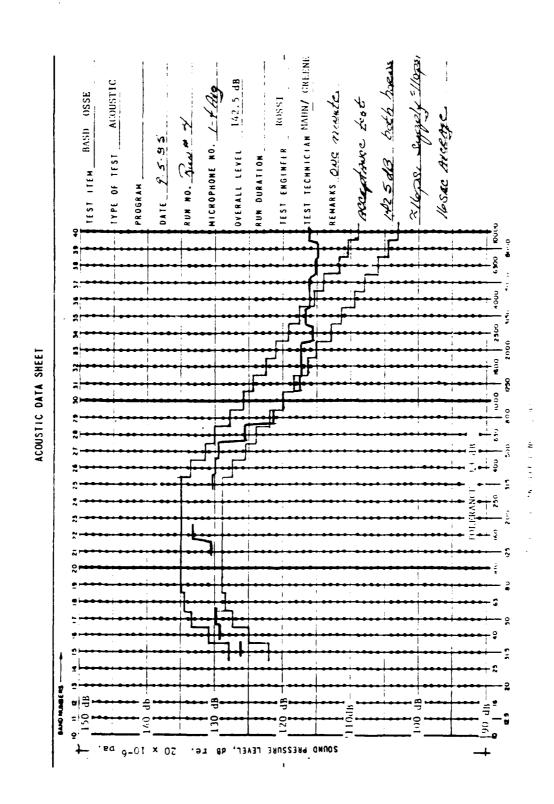
4.0 QUALITY ASSURANCE PROVISIONS

10000

OVERALL ACOUSTIC

These provisions are derived from the OSSE Performance Assurance Implementation Plan (E \mathbf{I} 056-001).

FIGURE 3-28-2 OSSE PROOF MODEL ONE MINUTE ACOUSTIC TEST



3.5.2 MASS PROPERTIES SUMMARY, WEIGHT AND C.G.

This report summarizes the procedure and results of measuring the weight and center of gravity (on the X-Y plane) of the completed OSSE instrument. The test was performed per procedure DD150717, and completed by 10/10/86.

1. WEIGHT

OSSE was measured as an instrument/dolly system, with the mass properties of the dolly known and factored out by calculation. Two currently calibrated BLH Electronics load cells were placed in the three-point mounting system supporting the instrument/dolly. The third leg was a dummy prop, so one exchange of position of the prop and one load cell was required to obtain all three measurements. The sum of the three readings, plus absent flight hardware and anticipated design growth, and minus the dolly weight and non-flight (red tag) items constitute the weight determination of OSSE, which stood at:

3997 lbs (at completion of test, see Memo 2188-M-86.830 by H.V. Royer, 10/15/87)

This figure was revised toward the end of acceptance testing and calibration, due to the down-scaling of anticipated flight hardware growth, to:

3980 (+/-5) lbs.

2. CENTER OF GRAVITY ON THE X-Y PLANE

OSSE Center of Gravity on the X-Y plane was calculated using the individual readings of the load cells, and their geometrical placement on the X-Y plane with respect to a specific mounting bolt hole center, located at the +X,-Y corner of the instrument, and defined as X=0, Y=0. From this reference point, the X and Y vectors to the CG point are:

CG of instrument along X axis is -31.666 in.

CG of instrument along Y axis is 38.038 in.

The reference point per TRW-ICD is located on the X-axis mechanical centerline (Y=0), and at a reference point forward of the instrument inteface panel (X=0). From this reference point, the T, Y, and Z (calculated) vectors to the CG point are:

ACTUAL CENTER OF GRAVITY

CALCULATED CENTER OF GRAVITY

X = -36.04 in.

X = -36.09 in.

Y = + 0.03 in.

Y = -0.03 in.

Z = N/A in.

Z = 29.29 in.

The calculated moment of inertia of a rotating detector is less than 10.9 Slug Ft². The calculated instrument inertia is:

ACTUAL INERTIA

CALCULATED INERTIA

N/A

 $Ixx = 592.0 Slug Ft^2$

N/A

 $Iyy = 361.0 Slug Ft^2$

N/A

Izz = 685.0 Slug Ft²

3.5.3 OPERATION REPORT: BASELINE FUNCTIONAL TEST

This section summarizes the results of the Baseline Functional Test of the OSSE instrument which was performed at BASD from December 2, 1986 through January 13, 1987. The purpose of the Baseline Functional test was to verify that OSSE complied with its performance specifications stated in the Development Specification (EXO56-O12D) and the interface Control Document (IF3-1135G). This test also established the performance baseline for subsequent EMI, Thermal Vacuum, and Acoustic tests.

Following is a description of each of the tests that were performed during Baseline testing and a summary of the results and significant anomalies found.

- 1) A full set of ATP's were run on the OSSE instrument to verify the functional performance of major subsystems.
- a) SYSPEFUNC- This ATP verifies the functionality of hardware and software within the Processor Electronics and its interfaces to the Detectors, Drive Electronics, CPM, PCU, and the spacecraft. This ATP was run for both PEA and PEB.
- b) SYSDEVER- This ATP verifies the functionality of the Detector in a nominal configuration and collects spectra for all the data collection modes of the Detector. The HITS test cable os not required to be connected to run his ATP. This ATP was run for each of the four detectors.
- c) SYSDEFUNC- This ATP tests the commandability and functionality of all hardware in the Detector Electronics. It requires that the HITS test cable be connected to each detector's test connector. This ATP was run for each of the four detectors.
- d) SYSPCUVER- This ATP tests the commandability and functionality of the Power Control Unit and its interfaces to the PE, Detectors, and Spacecraft. This ATP was run for RIUA/PEA and RIUB/PEB combinations.
- e) SYSDIFLIN- This ATP tests the differential linearity of all signal chains within the Detector Electronics, including the phoswich shield, CPD, and Co60 amplifier chains. This ATP does a brief collection for each of these channels but does not verify the differential linearity performance specifications since the collections are not long enough statistically. This ATP was run for each of the four detectors.
- f) SYSINTLIN- This ATP tests and verifies the performance specification

- for the integral linearity of all signal chains within the Detector Electronics. This ATP was run for each of the four detectors.
- g) SYSPWRUP- This ATP allows a power up configuration to be defined and briefly checks the status of the instrument after configuration. Items that can be selected for configuration are the RIU interface, PE, Detectors, and Drive subsystem. This ATP was run prior to the other ATP's to place OSSE into a known configuration.
- h) SYSDRIVER- This ATP verifies the functionality of the Drive system including calibration, limit switches, potentiometer readouts, and positioning. This ATP was run for both PEA and PEB.
- i) SYSPOTLIN- This ATP steps the drives through their total range of motion and reads the potentiometer at each specified position. A step size of two was used during Baseline testing. This ATP was run for both PEA and PEB.
- j) SYSPULSAR- This ATP tests the functionality of the Pulsar screening process in the Processor Electronics. This ATP was run for both PEA ansd PEB.
- 2) The RIU electrical interface to the spacecraft was verified using an oscilloscope, logic analyzer, and digital voltmeter. The following items were checked for both RIU interfaces: serial command and telemetry signals, discrete commands, synchronization signals and clocks, RIU analog and bilevel telemetry, and grounding.
- 3) Single and dual parameter collections were made with Th 228 and Cu-C radioactive sources to verify instrument performance at different energies. Resolution, pulse shape figure of merit, and detector gain were calculated from peak fits of these collections.
- 4) Background collections were made at different detector angles to verify no magnetic susceptibility or gain change with position.
- 5) Motor drive calibration strategy tables were developed for each of the four drive subsystems. Separate tables needed to be developed for each of the two Processor Electronics.
- 6) The Co60 tagging efficiency was measured for each of the four detector subsystems.
- 7) Tests were performed to verify the opposing detector veto in and out circuitry in each of the detectors as well as the veto matrix contained in the Processor Electronics.
- 8) Both Charged Pariticle Monitors (CPM) were tested for functionality and gain match.
- 9) To verify the differential linearity specification, 16 hour DIFLIN collections were made on the low range/low gain, low range/high gain, and medium ranges.
- 10) Noise tests were performed on all PMT's by collecting a pulsar spectrum

with the PMT high voltage on and comparing it to the same spectrum except with the high voltage off.

- 11) Miscellaneous functional tests were performed on the Makeup, Active, and Shuttle heaters and their respective control circuits.
- 12) Operational tests of the flight software processes and formats were performed.
- 13) An orbital functional simulation (OMOST) test was performed which verified some other instrument operational modes in a flight like configuration.

The following list briefly describes the instrument related anomalies discovered during Baseline functional testing.

- 1) During a transfer from the main to redundant motors on Detector 1, the transfer was incomplete.
- 2) Occasional spurious CPU resets were seen throughout baseline testing.
- 3) Various software problems discovered which are now fixed with uploaded patches to the flight software.
- 4) Problem with 4 thermistors connected in parallel instead of 2 for control of the CE Makeup heater.
- 5) Occasional extra step found during runs of SYSPOTLIN caused by a hardware/software misunderstanding of the motor step control circuit in the PE.
- 6) Aperture size/control coupling problem found with the LED/PIN A system on Detector 3. This unit was subsequently found to be unstable during instrument EMI testing.

All of the above anomalies have been addressed in MDR's, and since resolved.

3.5.4 OPERATION REPORT: OSSE FLIGHT INSTRUMENT THERMAL-VACUUM TEST

3.5.4.1 TEST OBJECTIVE

The purpose of this report is to summarize the performing of the thermal-vacuum test of the OSSE Flight Instrument per BASD Test Procedure, DD150716, wherein the stated objectives are, first, to demonstrate the survivability of OSSE in the 5 to 35 degree C range for three (3) thermal cycles over a minimum of 28 days under vacuum, and second, to validate the steady-state thermal model while demonstrating detector operating temperature controlability in the worst hot and cold orbital environments (5-35 degrees C).

3.5.4.2 FACT SUMMARY:

Chamber: 'BRUTUS', 20 foot dia. x 18 foot high.

BASD thermal-vacuum chamber.

Date OSSE installed in chamber: 2/21/87

Pump-down period: 3/05/87 - 3/06/87

Thermal cycling period: Ambient: 3/06 87 - 3/09/87 3/09/87 - 3/10/87 Amb to Hot: Hot #1: 3/10/87 - 3/11/87 Hot to Hot Orbit: 3/12/87 Hot Orbit: 3/12/87 - 3/13/87 3/13/87 - 3/16/87(Test Suspension Due to RIU Failure: Thermal Balance: 3/16/87 - 3/17/87 To Cold Orbit: 3/17/87 - 3/18/87 Cold Orbit: 3/18/87 - 3/20/87 To Cold: 3/21/87 Cold #1: 3/22/87 - 3/23/87 To Hot: 3/23/87 - 3/24/87 3/25/87 - 3/26/87 Hot #2: To Cold: 3/27/87 - 3/28/87 Cold #2: 3/29/87 To Hot: 3/29/87 - 3/30/87 Hot #3: 3/30/87 - 3/31/87 3/31/87 - 4/01/87 To Cold: Cold #3: 4/01/87 - 4/03/87

To Ambient Temp: 4/01/87 - 4/02/87

Return to Atmosphere: 4/03/87

Post Thermal Vac Functional: 4/04/87 - 4/05/87

Date OSSE removed from Chamber: 4/07/87

Staffing: Twenty-

Twenty-four hour OSSE test and Brutus operating personnel coverage during vacuum conditions

between 3/05/87 and 4/02/87.

3.5.4.3 RESULTS VS. TEST OBJECTIVE

In actuality, three hot cycles and three cold cycles were completed as specified by this procedure. In addition, there were hot orbit (16 degrees C), cold orbit (10 degrees C), and thermal balance (20 degrees C) periods during twenty eight (28) complete days under vacuum. Validation of the thermal model is beyond the scope of this operation report. Refer to SER EXO56A-478.

3.5.4.4 CHRONOLOGY OF TEST MILESTONES:

Prior to the pump-down of the vacuum chamber on 3/05/87, preparations included the following:

- Crane and Lifting Hardware Load Certification
 The 'Brutus' thermal-vacuum chamber at BASD is top-loading for large test items such as the OSSE Instrument. The chamber lid weighs in excess of eight (8) tons, and its placement on and removal from the chamber using the overhead crane was adequate as a certifiable load test for the crane and associated lifting hardware required to lift OSSE and its dolly, about 5500 pounds.
- BRUTUS Chamber Interior Arrangements
 The interior of the vacuum chamber was configured to accommodate
 OSSE such that the dolly was isolated from the chamber mounting plate using
 four (4) thermal isolation blocks (ten thermal isolation blocks were mounted
 between the OSSE structure and the dolly, one under each footpad, intended
 as a resistive thermal path closely simulating GRO thermal communication).
 Scaffolding forming catwalks around OSSE permitted good access and fairly

safe footing. No injuries occurred within the chamber during installation, setup, and removal.

A rack was attached to the chamber lid using a measured chain so it was suspended over OSSE at a pre-determined height. This rack held the two radioactive sources for the 1-3 and 2-4 detector pairs.

Thermocouple instrumentation leads were connected to conventional chamber inside panel connections. Heater cables for inside and outside the chamber were made using hardware compatible with the existing bulkhead connector interface. OSSE cabling from UUT to IGSE units within the control room included a chamber interface bulkhead built for OSSE and adaptable to standard chamber ports such as those on Brutus..

-Exterior Arrangements

OSSE test and Brutus operating personnel resided inside the Control Room along with all operating GSE (with the exception of the VAX computer system, located in another area) during the execution of this test. Cabling was propped over the pit between the chamber and the Control Room using boards and ties.

-Instrument Preparation

The OSSE UUT was configured as described in BASD Drawing 150000. The Instrument is made up of a thermally isolated dolly-mounted Structure supporting all of the Central Electronics, Detector, Drive, Charged Particle Monitor, and Thermal Shield Subsystems.

Heaters, LN2 cooling coils, and insulation blankets were incorporated in the handling dolly design to steer thermal transition, stabilize thermal plateaus, and to simulate spacecraft heat flow. Thermocouples attached to dolly, structure, and thermal shield provided data for the interpretation of heat flow and thermal balancing of the UUT.

2/21/87 OSSE Installed in the Chamber The movements were without incident or major complication.

2/22/87 - 3/4/87 OSSE Set-up & Functionals
Some final tests were required to finish the EMI procedure which preceded
thermal-vacuum. Pre-pump functionals including SYSDEVER, SYSDRIVER, SYSPEFUNC,
SYSPULSAR, SYSPCUVER, SYSDEFUNC ATP's, as well as background and gain & energy
resolution tests were performed in the manner that such tests will be executed
during hot, cold, hot orbit, and cold orbit periods under thermal-vacuum
conditions. The EMC/EMI Test Report, APPENDIX 3 of this document, describes
these tests in detail.

Note was made of the apparent failure of the A3 AGC system, where LED\$A3 had approximately 150 mv oscillation throughout the test, even before radiation. A broken wire was found and repaired, and LED\$A3 corrected. Ref MDR A61634.

Other broken wire incidents were corrected: (TAWS# SYS-057, SYS-058).

3/05/87 - 3/06/87 Chamber is Pumped-Down.

After 21 hours, the chamber reached the -6 torr range, and the UUT under the thermal shield was still in the -4 torr range. Decided not to apply power for anther 8 hours. After 29 hours, power was applied, and ambient thermal-vac tests begun.

3/06/87 - 3/09/87 Ambient Thermal-Vac Tests Performed. The tests included the six standard ATP's, the G&E resolution, Gain stability, and Initial HV Turn-on tests.

3/09/87 - 3/10/87 Transition to Hot.

Detector missed-step test was performed during this period.

3/10/87 - 3/11/87 Hot Cycle #1. The six standard ATP's and the G&E resolution tests were performed.

3/12/87 Transition to Hot Orbit SYSPOTLIN ATP was performed during this period.

3/12/87 - 3/13/87 Hot Orbit
The six standard ATP's, the G&E resolution, and the Gain Stability tests were performed during this period.

3/13/87 - 3/16/87 RIU Failure Period.

The RIU failed in a serious way, troubleshooting began on 12 March 11:30, and since nothing could be done for a couple days, the thermal environment inside th chamber was safed by jetisonning the LN2 and bringing all systems to ambient temperature.

3/16/87 - 3/17/87 Hot Thermal Balance Period Hot Orbit Thermal Balance was monitored during this period.

3/17/87 - 3/18/87 Transition to Cold Orbit Ran SYSDRIVER, G&E tests during this period.

3/18/87 - 3/20,87 Cold Orbit Thermal Balance Period Ran the six standard ATP's, G&E resolution tests during this period.

3/21/87 Transition to Cold Ran SYSPOTLIN ATP during this period.

3/22/87 - 3/23/87 Cold Cycle #1
Ran the six standard ATP's, G&E resolution tests during this period.

3/23/87 - 3/24/87 Transition to Hot Ran SYSPOTLIN ATP during this period.

3/25/87 - 3/26/87 Hot Cycle #2
Ran the six standard ATP's, G&E resolution tests during this period.

3/27/87 - 3/28/87 Transition to Cold Ran O.M.O.S.T., SYSPOTLIN ATP during this period.

3/29/87 Cold Cycle #2
Ran the six standard ATP's, G&E resolution tests during this period.

3/29/87 - 3/30/87 Transition to Hot Ran missed-step test during this period.

3/30/87 - 3/31/87 Hot Cycle #3

Ran SYSPCUVER, SYSDEVER, G&E resolution test.

3/31/87 - 4/01/87 Transition to Cold Ran mis-step test, took active heater data, ran shuttle and makeup heater tests.

4/01/87 - 4/03/87 Cold Cycle #3 Ran the six standard ATP;s, G&E resolution, active, shuttle, and make-up heater tests, some more 0.M.O.S.T.

4/03/87 Transition to Ambient Temperature Ran G&E resolution test.

4/03/87 Return to Atmosphere
Ran the six standard ATP's at ambient temperature and pressure.

3.5.4.5 TEST ANOMALIES

The anomalies noted during thermal-vacuum testing are broken down into the following categories:

- 1) ATP Data Anomalies. Six (6) ATP's comprise the test routine at the temperature extremes. They are:
 - a) SYSDEVER, (ref MDR A61659)
 - 1) AGCONSBX Reads OFF, Expected ON.
 - 2) ATP Limits Too Narrow.
 - 3) ATP Limits Incorrect.
 - 4) CALIB\$B Reads OFF, Expected ON.

Resolution: Continue to process through calibration.

- b) SYSDRIVER, (ref MDR A61660)
 - 1) ATP Potentiometer Limits Incorrect.

Resolution: Continue to process through calibration.

- c) SYSPEFUNC, (ref MDR A61661)
 - 1) ATP Temperature Limits Incorrect.
 - 2) ATP Rate Limits Incorrect.

Resolution: Continue to process through calibration.

- d) SYSPULSAR, (ref MDR A61662)
 - 1) ATP Rate Limits Incorrect.
 - 2) EBE Epoch Test. Chi 2/Def Errors.
 - 3) ATP Does Not Load Configuration First Time; Does Second Time.

Resolution: Continue to process through calibration.

- e) SYSPCUVER, (ref MDR A61663)
 - 1) ATP CE Makeup Heater Current Limits Incorrect.
 - 2) Motor Power Regulator Select Bilevels (MTRAx\$B) Not Validated Correctly.

Resolution: Continue to process through calibration.

f) SYSDEFUNC, (ref MDR A61664)

- 1) ATP Limits Too Tight Co60 Spectral Memory Counts Out of Tolerance For 200+/-20. Should Be 200+/-30.
- 2) DVM Returns Zero Value For Good Reading, Occasionally Reads Bad Non-Zero Values.
- 3) ATP CAL(PIN) Peak Limits Too Narrow.

4) ATP Limits Too Narrow.

5) ATP Deadtime Percentage Limits Too Narrow.

6) ATP RPHA2 High Range Shape Peak Limits Too Narrow.

7) ATP Co60 Section Rates Too Narrow.

8) LED/PIN Module Does Not Function Correctly All The Time.
Manual Tests Always Work OK. Limits Too Narrow On FWHM Range.

Resolution: Continue to process through calibration.

- 2) ATP Operations Anomalies:
 - a) 3/06/87, SYSPEFUNC ATP died after trying to load @SYSPEFUNC_DEADMAN file. ERR:40C40070, file not found (Ref TAWS# SYS-062).

Resolution: Testing continued, ATP mod required, no defect to UUT or test configuration.

b) 3/06/87, SYSPWRUP ATP error after trying to load QMDCPEIF File.ERR:40C40070, file not found (Ref TAWS# SYS-063).

Resolution: Same as a).

c) 3/15/87, SYSDRIVER ATP died after trying to load *SYSDRIVER_ SECONDARY_TABLE configuration table (Ref TAWS# SYS-064).

Resolution: Transferred to MDR A61648. Probable flight or ground support software anomaly.

d) 3/18/87, SYSPCUVER ATP stopped running while running each side of RIU (Ref TAWS# SYS-066).

Resolution: The IEEE process crashed on a bus conflict while on autoscan. Autoscan was not used thenceforth. No hardware defect.

e) 3/26/87, SYSPCUVER ATP dies as soon as it starts, or after calibrating detectors (Ref TAWS# SYS-071 and TAWS# SYS-072).

Resolution: Transferred To MDR A61625. No hardware defect, or stress on UUT.

f) 3/30/87, SYSPCUVER ATP, not enough time given after Cal process was started, and ATP went on to next processes before drives were calibrated and moved the required 1000 steps. Happened on RIUA, PEA (Ref TAWS# SYS-077).

Resolution: Transferred to MDR A61638

3. OSSE Flight Hardware Performance Anomalies:

a) Detector 4 AGC"B" exhibits a shift in gain (Ref MDR A61665).

Resolution: Not yet. problem continues to be under study.

b) An ASE was noted in the calibration of DE2 And DE1. Appears to be a change in the motor calibration points (Ref MDR A61666).

Resolution: Continue to process through calibration.

c) SYSDRIVER ATP reports that X-limit switch on DE1 does not turn on. (Ref TAWS# SYS-065)

Resolution: Apparently a hardware problem with limit switch not activating. Examined after thermal vacuum. An incompletely-seated connector was the problem, and modification to the mating hardware solved it.

d) Data from SYSPULSAR ATP, PEA is bad. Pulsar configuration not being verified (Ref TAWS# SYS-070).

Resolution: Transferred to MDR A61650. Software problem, no hardware defect.

e) DE3 high voltage did not drop to zero within 8 PKTS of changing to TLMID=10. They did eventually go to zero (Ref TAWS# SYS-074).

Resolution: Transferred to MDR A61651. Interrim disposition: Continue to process.

f) DE4 motor drive turned off during missed-step test. TLM indicates a positioning error (Ref TAWS# SYS-079).

Resolution: Transferred to MDR A61640. Defective electronic connection.

g) DE3 did not recalibrate after missed-step test. Main and redundant pots do not match (Ref TAWS# SYS-080).

Resolution: Transferred to MDR A61640.

Same problem as described in f).

h) Pulsar events from unqualified detectors are sometimes getting through the screening process (Ref TAWS# SYS-082).

Resolution: Transferred to MDR A61655.

4) Thermal Vacuum Chamber and OSSE GSE Anomalies:

a) 3/09/87, apparent leak in dolly LN2 cooling system.

Resolution: No flight hardware defect. Apparent leak did not repeat or affect T-V test. No further action required.

b) 3/13/87 - 3/16/87, loss of instrument TLM during ATP testing

troubleshooting, with instrument disconnected, indicated that the power supplies in the OPM 23 had gone into thermal shutdown due to cooling fan failure.

Resolution: GSE LVPS was cause of problem - thermal overload Shut Down RIU. No overstress of flight hardware.

c) RIU simulator remote link went down while running SYSPOTLIN ATP during transition to hot temperature (Ref TAWS# SYS-068).

Resolution: Problem due to the remote link going down. Commands (eg MDREL) were not getting to OSSE.

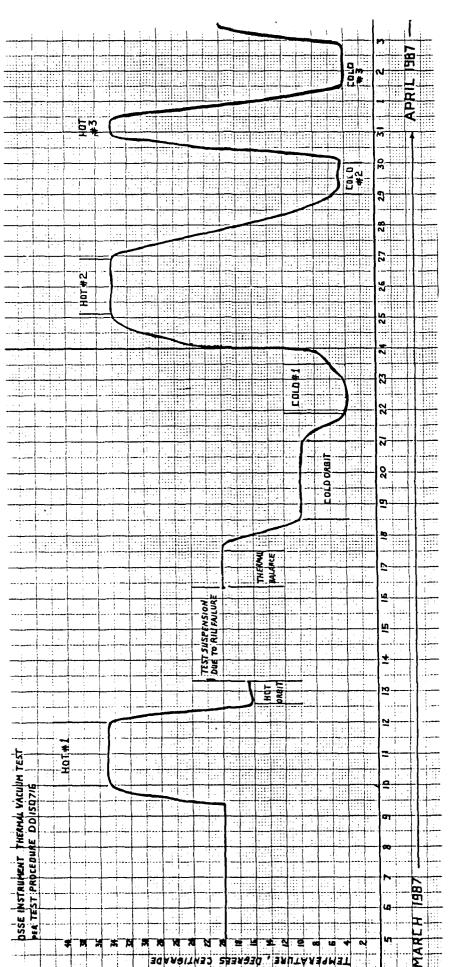
d) 3/28/87, while running 0.M.O.S.T. test, pot readings were not updating properly (A3M\$A) (Ref TAWS# SYS-073).

Resolution: Operator error. Using Motor Reg A when Motor Reg B should have been used. No defect.

e) 3/28/87, 0.M.O.S.T. start-up file OMOSTPEA.PRO would not turn on unless discrete command >SSEC ON was sent (Ref TAWS# SYS-075).

Resolution: Operator error. No defect.

FIGURE 3-29 OSSE INSTRUMENT THERMAL VACUUM TEST - As Run 3/5/87 - 4/3/87



3.5.5 OSSE FLIGHT INSTRUMENT ACOUSTIC TEST

I. Fact Summary: Contractor: Martin Marietta Corp, Littleton, CO.

Shipping Dates: 5/6/87 and 5/11/87.

Transport Mode: United Van Lines tractor-drawn trailer,

climate controlled, air-ride suspension.

Speed limit max: 40mph.

Motion Shock, Max: 2.8G out to Martin, 2.7G return.

Distance, RT: Approximately 100 miles.

Setup at Martin: 5/7/87.

Actual Test Run: 5/8/87 at 14:12 hours.

Test Run Duration: <66 seconds.

Equalization Runs: 26 seconds over two runs.

Anomalies Noted: Broken ground wire on thermal shroud. (before acoustic) Thermal blanket buttons separated from

thermal shroud.

Anomalies Noted: Accel. tri-block #9 separated from

(after acoustic) Instrument.

Accel. #2 became unglued, but not

separated, from Instrument.

Event Anomalies: None. No handling mishaps during (during shipment) moving, loading, or shipment.

This report covers the period between the completion of the pre-acoustic functional test (May 4, 1987) and the beginning of the post-acoustic functional test (May 13, 1987). The companion report submitted by Martin showing the

The accelerometers were mounted prior to the completion of the pre-functional per Test Procedure 158809, Rev B, with the following exception: Accel #1 was mounted on the -X-Y inboardbearing housing instead of the -X+Y unit due to mounting inteference. Actual accelerometer locations were photographed prior to departure from BASD.

May 4, 1987

OSSE was wheeled out of Room 5180 (DE Lab) upon completion of functional testing. The Thermal Shroud was lowered by crane and the Instrument covered with ESD-certified bagging material down to the dolly top surface. OSSE was then manually rolled along a swept exterior paved route of about 250 feet between BASD high-bay facilities, en-route to the loading dock. OSSE was kept in the intermediate high-bay staging area in M&PA until the commencement of loading on May 6.

May 5, 1987 No activity.

May 6, 1987

The trailer van was aligned to the BASD dock in such a manner that little ramping was required to bridge the gap from dock to trailer. OSSE was rolled to the dock, safety beams were set up inside the van to prevent the Instrument from rolling out of control down the slight (2 degree) incline of the trailer from back to front.

NOTE: The use of cross beams inside the trailer to stop a runaway roll might be potentially hazardous to persons between the beams and the

wheeled cargo, unless adequate up-side restraint, such as a winch or run-out safety line, is in effect. For this operation, such lines were in use, but even with the up-side restraints, misunderstanding or carelessness could result in leg injuries.

OSSE was manually rolled over the plates and irregularities of the threshold very slowly and carefully, positioned centrally in the trailer, and strapped in place. Cushions were placed around the dolly to absorb side-loads.

Shock recording instrumentation was used to monitor OSSE's movement during the trip. The average acceleration spike was below 1G for any of the three axes monitored for both legs of the trip. The maximum load spike seen by any axis was 2.8G outbound to Martin, and 2.7G inbound from Martin. Refer to the attached charts (Figures 2A-2K, 3A-3D).

The trip to Martin was slightly over two hours, for an average speed of 20 mph. The trailer van was escorted by a lead and a following vehicle at all times. Three-way communication between vehicles by-and-large was coherent and useful, particularly regarding problems with the shock recording instrumentation and road conditions ahead.

The off-loading operation at Martin was the reverse of the loading operation at BASD. The trailer was front-end high at Martin's dock, so the rollout was downhill. The same restraining procedures, and trailer bed-to-dock bridging was used.

Weather conditions at both BASD and Martin, and in-transit, were perfect.

After unloading, OSSE was stored for the night inside Martin's acoustic chamber. Elapsed time dock-to-dock was 6 hours. Personnel involved with the shipping operation included BASD QA (1), Production (2), Test (4), Instrumentation Monitor (1), Shipping (1), and United Van Lines Rep (1), Driver/Loaders (4).

May 7, 1987

Preparation of OSSE for acoustic test began early with the removal of the Thermal Shield. Activities included the following:

- 1. Recording crystal vacuum pressure.
- 2. Installing two microphones within the Instrument cavity per DD158809.
- 3. Stringing out accelerometer and microphone cables for outside access and hookup.
- 4. Re-attaching Thermal Shield to Instrument.
- 5. Buttoning-up Thermal Blanket. Installing stiffener (which resulted in breaking off two standoffs).
- 6. Positioning OSSE in Acoustic chamber, orienting it the same as the proof model tested in September, 1986.
- 7. Covering OSSE, lowering chamber, locking up for the night.

May 8, 1987

Martin personnel hooked up accelerometer and microphone cables to respective control and data apparatus. A record of Martin-furnished equipment, by model, serial number, and cal-due dates, is attached to the end of this report.

The acoustic setup check (per DD158809 sect. 6.1) consisted of two equal-

ization runs at full level for a combined total of 26 seconds. A third run would have exceeded the maximum exposure time of 30 seconds and was therefore not done. However, the final adjustments to refine the octave-band for the actual 60 second test were made by calculation, and in any event the required adjustments were minor.

The 60 second qualification run was done at 14:12 hours. The actual elapsed time was less than 66 seconds. A printout of the 1 minute qual test spectrum is attached to the end of this report. The Martin report will discuss this data more comprehensively.

OSSE was covered and secured in the chamber for the weekend.

May 9 and May 10, 1987 No activity.

May 11, 195,

OSSE was examined in-place inside the acoustic test chamber, with the thermal shield on. The only anomaly noted was two thermal blanket buttons missing, apparently because their snap rings popped out of the grooves during the acoustic test.

Martin agreed to permit BASD to keep Martin microphones on OSSE until they could be removed at BASD and returned to Martin by mail. This was done by May 14th. This permission saved OSSE one thermal shield removal and replacement cycle, allowed more careful examination of the interior condition of OSSE without being rushed, and allowed photographic record of the microphone placement and accelerometer condition.

All cables were disconnected from OSSE by the time the van arrived at 10 am. OSSE was loaded onto the van without incident. The inclination of the trailer bed (up from rear to front) made winch-pulling of the Instrument over the dock ramps, and up into the center of the trailer, a necessity.

All GSE, and the transport shork monitoring system, were on-board and secured to the satisfaction of BASD PEQA by 12:00 noon. The van was escorted by front and rear BASD cars, and the three vehicles were in radio communication. The trip lasted two hours, and a third hour was needed to repair a malfunction in the shock monitoring equipment just after departing the Martin compound. Otherwise, the journey was eventless.

The weather conditions during loading were perfect, and during transport, occasionally stormy with lightning and light showers.

OSSE was pulled out of the van and onto the BASD dock with the help of a fork-lift used as a tractor. OSSE was moved manually immediately into the M&P-A high-bay to its new situation for post-acoustic functional testing, and calibration.

Weather conditions during the unloading at BASD were cloudy, no rain, and stable. Participants in the return of OSSE from Martin were the same as for the outgoing trip, minus several United Van lines personn 1.

The performance of the United Van Lines representative and driver/loader personnel is to be commended for being outstanding in proficiency,

patience, and courtesy throughout the entire moving operation.

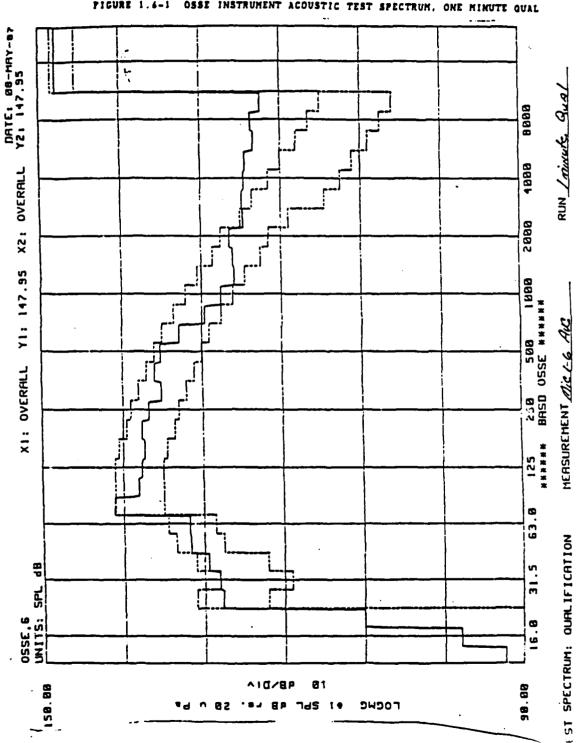
May 12, 1987

The thermal shield was removed from OSSE. The Instrument was examined and photographed. Accelerometers located at position #9, a tri-axial mount, were found detached from the electronics stack on detector A2. The accelerometer located at position #2 was found detached from the central electronics box +Z face (AIL #81).

Other anomalies included: Torn kapton on thermal shroud where it covers the central electronics box (AIL #78), and peeling black paint on A4 detector and A1 electronics box (AIL #79, not necessarily related to the acoustic test).

FIGURE 3-30 ACOUSTIC TEST SPECTRUM, ONE MINUTE QUAL

Page 58 FIGURE 1.4-1 OSSE INSTRUMENT ACOUSTIC TEST SPECTRUM, ONE MINUTE QUAL ٦,



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3.5.6 UPERATION REPORT: OSSE POST-ACOUSTIC FUNCTIONAL TEST

This section summarizes the results of the Pre and Post-Acoustic Functional Tests of the OSSE instrument which were performed at BASD from from April 27, 1987 through May 28, 1987. The purpose of the Acoustic Functional Tests were to verify that no electrical failures occurred as a result of vibration experienced during the Acoustic test. The Pre-Acoustic test provided a reference to which the Post-Acoustic data was compared. Test procedure DD150710 was in effect.

Following is a description of each of the tests that were performed during Pre and Post-Acoustic functional testing and a summary of the results and significant anomalies found.

- 1) A full set of ATP's were run on the OSSE instrument during the Pre-Acoustic test to provide a reference point in the event of a failure. The same tests were performed during the Post-Acoustic test and the data was then compared to the Pre-Acoustic test data.
- a) SYSPEFUNC- This ATP verifies the functionality of hardware and software within the Processor Electronics and its interfaces to the Detectors, Drive Electronics, CPM, PCU, and the Spacecraft. This ATP was run for both PEA and PEB.
- b) SYSDEVER- This ATP verifies the functionality of the Detector in a nominal configuration and collects spectra for all the data collection modes of the detector. The HITS test cable is not required to be connected to run this ATP. This ATP was run for each of the four detectors.
- c) SYSDEFUNC- This ATP tests the commandability and functionality of all hardware in the Detector Electronics. It requires that the HITS test cable be connected to each detector's test connector. This ATP was run for each of the four detectors.
- d) SYSPCUVER- This ATP tests the commandability and functionality of the Power Control Unit and its interfaces to the PE, Detectors, and Spacecraft. This ATP was run for RIUA/PEA and RIUB/PEB combinations.
- e) SYSPWRUP- This ATP allows a power up configuration to be defined and briefly checks the status of the instrument after configuration. Items that can be selected for configuration are the RIU interface, PE, Detectors, and Drive subsystem. This ATP was run prior to most of the other ATP's to place OSSE into a known configuration.
- f) SYSDRIVER- This ATP verifies the functionality of the Drive system including calibration, limit switches, potentionmeter readouts, and positioning. This ATP was run for both PEA and PEB.
- g) SYSPOTLIN- This ATP steps the drives through their total range of motion and reads the potentiometer at each specified position. A step size of eighteen was used during Acoustic testing. This ATP was run for both PEA and PEB.
- h) SYSPULSAR- This ATP tests the functionality of the Pulsar screening

process in the Processor Electronics. This ATP was run for both PEA and PEB.

- 2) Single and dual parameter collections were made with a Th 228 radioactive source to verify instrument performance at different energies. Gain and stability were measured during this test.
- 3) A special CPD test was performed before and after the Acoustic test as a result of an anomaly with the Detector 2 CPD gain found during the Thermal Vacuum test. This test measured the gain of each of the CPD's by collecting a CPD spectrum with a Th 228 source placed in the center of the CPD.
- 4) Before sending the instrument to the Acoustic test at Martin Marietta, all four detectors were calibrated and positioned to the +Z axis where the launch lock was set. The purpose of this was to see how much the detectors moved during the shipping and Acoustic test. The first test performed in the Post-Acoustic functional was to measure the detector positions.
- 5) A long (32 hour) missed step test was performed as a part of the Post-Acoustic test to verify the missed step error rate was within specification. This test involved calibrating the detectors and positioning them to the +Z axis before the start of the test. The detector positions were measured with a theodolite for comparison to the final detector positions. The test was then started using a 49% drive duty cycle that ran for 32 hours to accumulate 2.0 million steps on each drive. At the completion of the test, the detector were commanded to the +Z axis where their positions were again measured with a theodolite. No missed step errors were found during this test.

No instrument related anomalies were discovered during Acoustic functional testing.

3.5.7 EMC/ EMI TEST SUMMARY

THE ELECTROMAGNETIC COMPATIBILITY/ELECTROMAGNETIC INTERFERENCE (EMC/EMI) TEST REPORT FOR THE OSSE INSTRUMENT is included in this report as Appendix 3.

OSSE LESSONS LEARNED

4.0 OBJECTIVE

This discussion will consider a few of the many thousands of decisions that were made during design, fabrication, and test of the Oriented Scintillation Spectrometer Experiment (OSSE) instrument. While it is inevitable that some decisions were made that perhaps turned out not to be the best course of action, the cumulative result of all program actions produced a Gamma Ray Observatory experiment that has been performing to expectations during months of ground test and calibration. This exceedingly complex yet reliable experiment will provide significant advances to the field of gamma ray astronomy as a result of the contributions of the many people at NRL, GSFC, BASD and others who participated in this program.

The following list is a summary of technical program activities at BASD that encountered more than the expected level of difficulty, and should be evaluated when tradeoffs are performed on future programs. Some suggestions and alternatives are included, but of course detailed tradeoffs have not been made and specific applications may have different requirements and require different approaches. The methods actually used on DSSE did achieve an acceptable but perhaps not optimal result. It is hoped that consideration of these items will lead to improved capabilities in space hardware.

The final section considers actions which were particularly successful and would be recommended for incorporation into future program planning.

The list has been grouped into electrical and mechanical categories.

4.1 Electrical Improvements

- Use PC board-mountable connectors instead of hardwiring connectors to the board. The hardwiring resulted in extensive hand labor in cramped spaces which could be reduced.
- 2. Use a motherboard approach to the DE interconnections. The board commonality savings achieved were offset by the DE cabling complexity.
- 3. Use shaft angle encoders instead of potentiometers for drive angle readout. While initially more expensive and complex, the encoders probably would have significantly reduced the need for test and calibration, and provided higher pointing accuracy.
- Feedback of detector position information to the drive control would have simplified drive testing and added to the certainty of the positioning.

- 5. Part procurement and screening delays, especially among nonstandard parts caused schedule and planning problems during all phases of the program. A list of "parts to avoid" because of reliability or availability problems and reduced use of non-Preferred Parts List (PPL) parts in the design may aid future programs.
- 6. Bleeder strings were not optimally matched to the delivered PMT characteristics and were difficult to modify after assembly. Improved performance in this area would probably require additional efforts in component selection and test.
- 7. Performance and reliability studies of connector cleaning and lubrication effects would produce definitive, demonstrated recommendations. The relatively large number of connectors and repeated mate-demate cycles such as on an instrument as OSSE may produce reliability concerns even with relatively low failure rates.
- 8. A PCU engineering model would have assisted verification of the complex wiring and early discovery of current monitor EMI susceptibility had it been part of the program. Insufficient extra packaging volume caused difficulty in assembly and test and in incorporating the changes necessitated by the growth of requirements.
- Selection of a different CPU chip would have allowed for more effective processor architecture.

4.2 Mechanical Improvements

- A rigid self-supporting interface specified for the OSSE side
 of the spacecraft mounting interface would have simplified
 lifting and handling, tooling, assembly, test interfaces, and
 alignment determinations.
- 2. Pressurization of crystal chambers instead of using guard vacuum would have simplified the design and assembly, and made leakage easy to detect and safer for the hardware.
- 3. A flight qualified pumpout manifold would have reduced the detector pumpout schedule.
- 4. A LED/PIN assembly that used more of the available volume would have reduced signal crosstalk, assembly, and rework difficulties that resulted from its small size.
- 5. Proper loading of PMTs was difficult and may be easier with a different mechanical design.
- 6. Studs and locking nuts would be preferable to the existing bolts and nutplates used to attach DE modules. The present method is difficult to assemble and would require substantial repairs if a locking nutplate galls during assembly or repair.

- 7. Central Electronics cables had too much excess length, and access to connectors on the back was difficult. Some DE cables did not have enough excess length for easy handling during assembly. Cable routing and supports should be incorporated early in the mechanical layout.
- 8. Development of collimator fabrication methods was risky and expensive. Although the resulting collimators were excellent, another method may have produced adequate collimators at less risk to the program.
- Bearing seals incorporated in the outboard bearing housing design would prevent entry of contamination without the need to install and remove non-flight shields.

4.3 Special Successes

Two particularly successful areas standout among the many which contributed to the overall success of OSSE and should certainly be considered for future programs.

1. Bench checkout units (BCU)

Bench checkout units for the processor and detector electronics paid for themselves many times during testing of flight boards through substitution. The thorough and comprehensive testing in actual operating conditions undoubtedly prevented many problems from arising only after the individual subsystems were integrated. In addition, they provided the "Engineering Model" function of training production and test personnel on the special requirements of the OSSE boards, and they allowed development of test procedures, software and tooling without hazard or schedule impact to flight boards. They have also been very valuable for assessment, simulation, and troubleshooting of the subtle timing effects discovered during the detailed data analysis by NRL. The ability of the BCUs to continue to support this type of activity through the remainder of ground test and after launch may prove to be their most important contribution yet to the understanding of the data received from orbit.

2. Science Team Support

Beginning during the OSSE thermal vacuum test, NRL provided nearly continuous science team support to the test and calibration effort which resulted in significantly improved understanding of both mission requirements and instrument operation by NRL and BASD. The thermal vacuum performance tests and calibration provided answers to the questions raised by the detailed data analysis being done during those times. There is a much higher level of confidence in the data generated by OSSE since it has been analyzed from engineering and science viewpoints. This cooperation was essential for explaining some performance aspects, and sufficiently beneficial to the test program overall that it should be considered on future projects.